

PIC16F872 Data Sheet

28-Pin, 8-Bit CMOS Flash Microcontroller with 10-Bit A/D

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PIC16F872

28-Pin, 8-Bit CMOS FLASH Microcontroller with 10-bit A/D

High Performance RISC CPU:

- · Only 35 single word instructions to learn
- All single cycle instructions except for program branches, which are two-cycle
- Operating speed: DC 20 MHz clock input DC - 200 ns instruction cycle
- 2K x 14 words of FLASH Program Memory
- 128 bytes of Data Memory (RAM)
- 64 bytes of EEPROM Data Memory
- Pinout compatible to the PIC16C72A
- · Interrupt capability (up to 10 sources)
- Eight level deep hardware stack
- Direct, Indirect and Relative Addressing modes

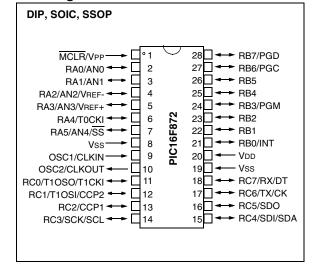
Peripheral Features:

- High Sink/Source Current: 25 mA
- Timer0: 8-bit timer/counter with 8-bit prescaler
- Timer1: 16-bit timer/counter with prescaler, can be incremented during SLEEP via external crystal/clock
- Timer2: 8-bit timer/counter with 8-bit period register, prescaler and postscaler
- One Capture, Compare, PWM module
 - Capture is 16-bit, max. resolution is 12.5 ns
 - Compare is 16-bit, max. resolution is 200 ns
 - PWM max. resolution is 10-bit
- 10-bit, 5-channel Analog-to-Digital converter (A/D)
- Synchronous Serial Port (SSP) with SPI[™] (Master mode) and I²C[™] (Master/Slave)
- Brown-out detection circuitry for Brown-out Reset (BOR)

CMOS Technology:

- Low power, high speed CMOS FLASH/EEPROM technology
- Wide operating voltage range: 2.0V to 5.5V
- Fully static design
- Commercial, Industrial and Extended temperature ranges
- Low power consumption:
 - < 2 mA typical @ 5V, 4 MHz
 - 20 µA typical @ 3V, 32 kHz
 - < 1 µA typical standby current

Pin Diagram



Special Microcontroller Features:

- Power-on Reset (POR), Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)
- Watchdog Timer (WDT) with its own on-chip RC oscillator for reliable operation
- Programmable code protection
- Power saving SLEEP mode
- · Selectable oscillator options
- In-Circuit Serial Programming[™] (ICSP[™]) via two pins
- Single 5V In-Circuit Serial Programming capability
- · In-Circuit Debugging via two pins
- Processor read/write access to program memory

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1.0 DEVICE OVERVIEW

This document contains device specific information about the PIC16F872 microcontroller. Additional information may be found in the PICmicro[™] Mid-Range Reference Manual (DS33023), which may be obtained from your local Microchip Sales Representative or downloaded from the Microchip website. The Reference Manual should be considered a complementary document to this data sheet, and is highly recommended reading for a better understanding of the device architecture and operation of the peripheral modules.

The block diagram of the PIC16F872 architecture is shown in Figure 1-1. A pinout description is provided in Table 1-2.

TABLE 1-1:	KEY FEATURES OF THE PIC16F872

Operating Frequency	DC - 20 MHz
RESETS (and Delays)	POR, BOR (PWRT, OST)
FLASH Program Memory (14-bit words)	2K
Data Memory (bytes)	128
EEPROM Data Memory (bytes)	64
Interrupts	10
I/O Ports	Ports A, B, C
Timers	3
Capture/Compare/PWM module	1
Serial Communications	MSSP
10-bit Analog-to-Digital Module	5 input channels
Instruction Set	35 Instructions
Packaging	28-lead PDIP
	28-lead SOIC
	28-lead SSOP

PIC16F872



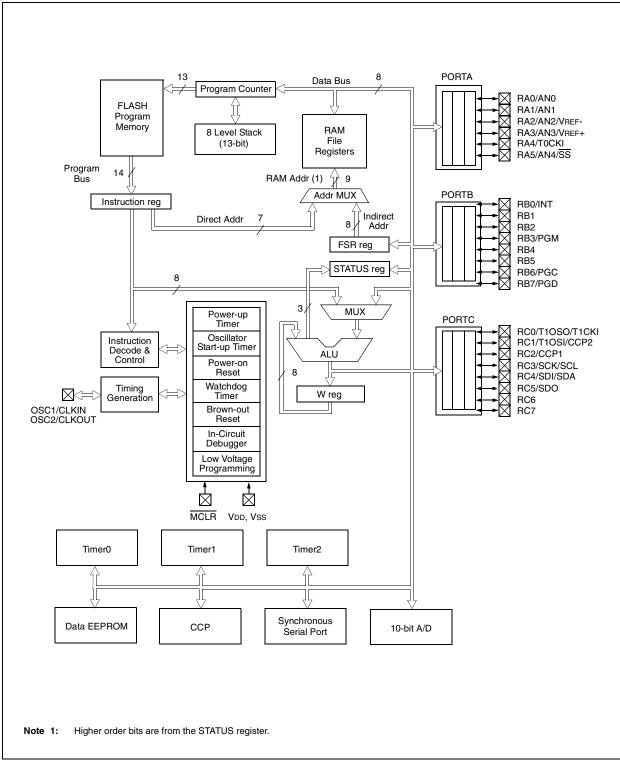


TABLE 1-2:	PIC16F872 PINOUT DESCRIPTION
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Pin Name	Pin#	I/O/P Type	Buffer Type	Description
OSC1/CLKI OSC1	9	I	ST/CMOS	Oscillator crystal or external clock input. Oscillator crystal input or external clock source input. ST buffer when configured in RC mode. Otherwise CMOS.
CLKI				External clock source input. Always associated with pin function OSC1 (see OSC2/CLKO pin).
OSC2/CLKO OSC2 CLKO	10	0	_	Oscillator crystal or clock output. Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. In RC mode, OSC2 pin outputs CLKO, which has 1/4 the
CLKO				frequency of OSC1 and denotes the instruction cycle rate.
MCLR/VPP MCLR	1	I/P	ST	Master Clear (input) or programming voltage (output). Master Clear (Reset) input. This pin is an active low RESET to the device.
VPP				Programming voltage input.
				PORTA is a bi-directional I/O port.
RA0/AN0 RA0 AN0	2	I/O	TTL	Digital I/O. Analog input 0.
RA1/AN1 RA1 AN1	3	I/O	TTL	Digital I/O. Analog input 1.
RA2/AN2/VREF- RA2 AN2 VREF-	4	I/O	TTL	Digital I/O. Analog input 2. Negative analog reference voltage.
RA3/AN3/VREF+ RA3 AN3 VREF+	5	I/O	TTL	Digital I/O. Analog input 3. Positive analog reference voltage.
RA4/T0CKI RA4 T0CKI	6	I/O	ST	Digital I/O; open drain when configured as output. Timer0 clock input.
RA5/SS/AN4 RA5 SS AN4	7	I/O	TTL	Digital I/O. Slave Select for the Synchronous Serial Port. Analog input 4.
Legend: I = input — = Not	used	O = outpu TTL = TT		I/O = input/output P = power ST = Schmitt Trigger input

— = Not used ITL = TTL input ST = Schmitt Trigger input
 Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.
 2: This buffer is a Schmitt Trigger input when used in Serial Programming mode.

Pin Name	Pin# I/O/P Buffer Description				
				PORTB is a bi-directional I/O port. PORTB can be software	
				programmed for internal weak pull-up on all inputs.	
RB0/INT	21	I/O	TTL/ST ⁽¹⁾		
RB0				Digital I/O.	
INT				External interrupt pin.	
RB1	22	I/O	TTL	Digital I/O.	
RB2	23	I/O	TTL	Digital I/O.	
RB3/PGM	24	I/O	TTL		
RB3				Digital I/O.	
PGM				Low voltage ICSP programming enable pin.	
RB4	25	I/O	TTL	Digital I/O.	
RB5	26	I/O	TTL	Digital I/O.	
RB6/PGC	27	I/O	TTL/ST ⁽²⁾		
RB6				Digital I/O.	
PGC				In-Circuit Debugger and ICSP programming clock.	
RB7/PGD	28	I/O	TTL/ST ⁽²⁾		
RB7 PGD				Digital I/O. In-Circuit Debugger and ICSP programming data.	
FGD					
			o 	PORTC is a bi-directional I/O port.	
RC0/T1OSO/T1CKI	11	I/O	ST	Divite 1/0	
RC0 T1OSO				Digital I/O. Timer1 oscillator output.	
T1CKI				Timer1 clock input.	
RC1/T1OSI	12	I/O	ST		
RC1		., 0	01	Digital I/O.	
T1OSI				Timer1 oscillator input.	
RC2/CCP1	13	I/O	ST		
RC2				Digital I/O.	
CCP1				Capture1 input/Compare1 output/PWM1 output.	
RC3/SCK/SCL	14	I/O	ST		
RC3				Digital I/O.	
SCK				Synchronous serial clock input/output for SPI mode. Synchronous serial clock input/output for I ² C mode.	
SCL	4 -	1/2	O T	Synchronous senal clock input/output for I=C mode.	
RC4/SDI/SDA RC4	15	I/O	ST		
SDI				Digital I/O. SPI Data In pin (SPI mode).	
SDA				SPI Data I/O pin (I ² C mode).	
RC5/SDO	16	I/O	ST		
RC5				Digital I/O.	
SDO				SPI Data Out pin (SPI mode).	
RC6	17	I/O	ST	Digital I/O.	
RC7	18	I/O	ST	Digital I/O.	
Vss	8, 19	P		Ground reference for logic and I/O pins.	
VDD	20	P	<u> </u>	Positive supply for logic and I/O pins.	
	-	O = outp	I	I/O = input/output $P = power$	

Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.2: This buffer is a Schmitt Trigger input when used in Serial Programming mode.

2.0 MEMORY ORGANIZATION

There are three memory blocks in the PIC16F872. The Program Memory and Data Memory have separate buses so that concurrent access can occur. Data memory is covered in this section; the EEPROM data memory and FLASH program memory blocks are detailed in Section 3.0.

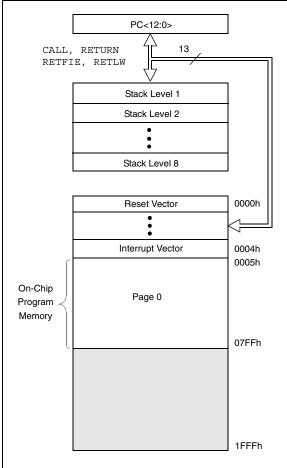
Additional information on device memory may be found in the PICmicro[™] Mid-Range Reference Manual (DS33023).

2.1 Program Memory Organization

The PIC16F872 has a 13-bit program counter capable of addressing an 8K word x 14 bit program memory space. The PIC16F872 device actually has 2K words of FLASH program memory. Accessing a location above the physically implemented address will cause a wraparound.

The RESET vector is at 0000h and the interrupt vector is at 0004h.

FIGURE 2-1: PIC16F872 PROGRAM MEMORY MAP AND STACK



2.2 Data Memory Organization

The data memory is partitioned into multiple banks which contain the General Purpose Registers and the Special Function Registers. Bits RP1 (STATUS<6>) and RP0 (STATUS<5>) are the bank select bits.

RP1:RP0	Bank
00	0
01	1
10	2
11	3

Each bank extends up to 7Fh (128 bytes). The lower locations of each bank are reserved for the Special Function Registers. Above the Special Function Registers are General Purpose Registers, implemented as static RAM. All implemented banks contain Special Function Registers. Some frequently used Special Function Registers from one bank may be mirrored in another bank for code reduction and quicker access.

Note:	EEPROM Data Memory description can be
	found in Section 4.0 of this data sheet.

2.2.1 GENERAL PURPOSE REGISTER FILE

The register file can be accessed either directly, or indirectly through the File Select Register (FSR).

FIGURE 2-2: PIC16F872 REGISTER FILE MAP

	Address		Address		Address	Add
Indirect addr.(*)	00h	Indirect addr.(*)	80h	Indirect addr.(*)	100h	Indirect addr.(*) 18
TMR0	01h	OPTION_REG	81h	TMR0	101h	OPTION_REG 18
PCL	02h	PCL	82h	PCL	102h	PCL 18
STATUS	03h	STATUS	83h	STATUS	103h	STATUS 18
FSR	04h	FSR	84h	FSR	104h	FSR 18
PORTA	05h	TRISA	85h		105h	18
PORTB	06h	TRISB	86h	PORTB	106h	TRISB 18
PORTC	07h	TRISC	87h		107h	18
	08h		88h		108h	18
	09h		89h		109h	18
PCLATH	0Ah	PCLATH	8Ah	PCLATH	10Ah	PCLATH 18
INTCON	0Bh	INTCON	8Bh	INTCON	10Bh	INTCON 18
PIR1	0Ch	PIE1	8Ch	EEDATA	10Ch	EECON1 18
PIR2	0Dh	PIE2	8Dh	EEADR	10Dh	EECON2 18
TMR1L	0Eh	PCON	8Eh	EEDATH	10Eh	Reserved ⁽¹⁾ 18
TMR1H	0Fh		8Fh	EEADRH	10Fh	Reserved ⁽¹⁾ 18
T1CON	10h		90h		110h	19
TMR2	11h	SSPCON2	91h			
T2CON	12h	PR2	92h			
SSPBUF	13h	SSPADD	93h			
SSPCON	14h	SSPSTAT	94h			
CCPR1L	15h		95h			
CCPR1H	16h		96h			
CCP1CON	17h		97h			
	18h		98h			
	19h		99h			
	1Ah		9Ah			
	1Bh		9Bh			
	1Ch		9Ch			
	1Dh		9Dh			
ADRESH	1Eh	ADRESL	9Eh			
ADCON0	1Fh	ADCON1	9Fh		120h	1/
	20h	General Purpose Register	A0h	accesses 20h-7Fh	12011	accesses A0h - BFh
General Purpose Register		32 Bytes	BFh C0h			1E 10
96 Bytes					16Fh	16
2			EFh F0h		170h	10
	7Fh	accesses 70h-7Fh	FFh	accesses 70h-7Fh	17Fh	70h-7Fh
Bank 0		Bank 1		Bank 2		Bank 3
 Unimplement * Not a physical 		memory locations	s, read as	'0'.		

2.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM. A list of these registers is given in Table 2-1. The Special Function Registers can be classified into two sets: core (CPU) and peripheral. Those registers associated with the core functions are described in detail in this section. Those related to the operation of the peripheral features are described in detail in the peripheral feature section.

TABLE 2-1:	SPECIAL FUNCTION REGISTER SUMMARY
------------	-----------------------------------

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Details on page:
Bank 0											
00h ⁽²⁾	INDF		g this locations is the second s		tents of FSR	to address	data memo	ry		0000 0000	21, 93
01h	TMR0	Timer0 M	odule Regist	ter						xxxx xxxx	35, 93
02h ⁽²⁾	PCL	Program (Counter (PC) Least Sign	ificant Byte					0000 0000	20, 93
03h ⁽²⁾	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	0001 1xxx	12, 93
04h ⁽²⁾	FSR	Indirect D	ata Memory	Address Po	inter		•			xxxx xxxx	21, 93
05h	PORTA	_	_	PORTA Da	ta Latch whe	en written: P	ORTA pins	when read		0x 0000	29, 93
06h	PORTB	PORTB D	ata Latch w	hen written:	PORTB pins	when read				xxxx xxxx	31, 93
07h	PORTC	PORTC D	ata Latch w	hen written:	PORTC pin	s when read				xxxx xxxx	33, 93
08h	—	Unimplem	nented							—	
09h	—	Unimplem	nented							—	—
0Ah ^(1,2)	PCLATH	—	—	_	Write Buffe	er for the up	per 5 bits of	the Program	m Counter	0 0000	20, 93
0Bh ⁽²⁾	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000 000x	14, 93
0Ch	PIR1	(3)	ADIF	(3)	(3)	SSPIF	CCP1IF	TMR2IF	TMR1IF	r0rr 0000	16, 93
0Dh	PIR2	_	(3)		EEIF	BCLIF	_	_	(3)	-r-0 0r	18, 93
0Eh	TMR1L	Holding R	Holding Register for the Least Significant Byte of the 16-bit TMR1 Register								40, 94
0Fh	TMR1H	Holding R	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register							xxxx xxxx	40, 94
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR1ON	00 0000	39, 94
11h	TMR2	Timer2 M	odule Regist	ter						0000 0000	43, 94
12h	T2CON	—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	43, 94
13h	SSPBUF	Synchron	ous Serial P	ort Receive	Buffer/Trans	mit Register				XXXX XXXX	55, 94
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	53, 94
15h	CCPR1L			/M Register	, ,					xxxx xxxx	45, 94
16h	CCPR1H	Capture/C	Compare/PW	/M Register	I (MSB)			-	_	XXXX XXXX	45, 94
17h	CCP1CON	—		CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	45, 94
18h	—	Unimplem	nented							—	—
19h	—	Unimplem								—	
1Ah	—	Unimplem	nented							—	
1Bh	—	Unimplem								—	—
1Ch	—	Unimplem								—	_
1Dh	—	Unimplem								—	—
1Eh	ADRESH		It Register H		r		T			XXXX XXXX	84, 94
1Fh	ADCON0	ADCS1	ADCS0	CHS2	CHS1	CHS0	GO/ DONE	—	ADON	0000 00-0	79, 94

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations are unimplemented, read as '0'.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for the PC<12:8> whose contents are transferred to the upper byte of the program counter.

2: These registers can be addressed from any bank.

3: These bits are reserved; always maintain these bits clear.

TABLE 2-1:	SPECIAL FUNCTION REGISTER SUMMARY	(CONTINUED)
-------------------	-----------------------------------	-------------

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Details on page:
Bank 1											
80h ⁽²⁾	INDF		Addressing this location uses contents of FSR to address data memory (not a physical register)							0000 0000	21, 93
81h	OPTION_REG	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	13, 94
82h ⁽²⁾	PCL	Program	Program Counter (PC) Least Significant Byte							0000 0000	20, 93
83h ⁽²⁾	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	0001 1xxx	12, 93
84h ⁽²⁾	FSR	Indirect da	ata memory a	address poi	nter		•			xxxx xxxx	21, 93
85h	TRISA	—	— PORTA Data Direction Register							11 1111	29, 94
86h	TRISB	PORTB D	ata Direction	n Register						1111 1111	31, 94
87h	TRISC	PORTC D	Data Direction	n Register						1111 1111	33, 94
88h	—	Unimplem	nented							—	
89h	—	Unimplemented							—		
8Ah ^(1,2)	PCLATH	—	— — Write Buffer for the upper 5 bits of the Program Counter				0 0000	20, 93			
8Bh ⁽²⁾	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000 000x	14, 93
8Ch	PIE1	(3)	ADIE	(3)	(3)	SSPIE	CCP1IE	TMR2IE	TMR1IE	r0rr 0000	15, 94
8Dh	PIE2	—	(3)	_	EEIE	BCLIE	_	-	(3)	-r-0 0r	17, 94
8Eh	PCON	_	_	_	—	—	_	POR	BOR	dd	19, 94
8Fh	—	Unimplem	nented							—	
90h	—	Unimplem	nented							—	
91h	SSPCON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	54, 94
92h	PR2		eriod Registe							1111 1111	43, 94
93h	SSPADD	Synchron	ous Serial P	ort (I ² C moc	le) Address	Register				0000 0000	58, 94
94h	SSPSTAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000 0000	52, 94
95h	—	Unimplem	nented							—	
96h	—	Unimplem	nented							—	_
97h	—	Unimplem	nented							—	_
95h	—	Unimplem	nented								_
95h	—	Unimplem	nented								_
9Ah	—	Unimplem								—	—
9Bh	—	Unimplem								-	—
9Ch	—	Unimplem									
9Dh			Unimplemented							—	—
9Eh	ADRESL		A/D Result Register Low Byte							XXXX XXXX	84, 94
9Fh	ADCON1	ADFM	—	—	—	PCFG3	PCFG2	PCFG1	PCFG0	0 0000	80, 94

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations are unimplemented, read as '0'.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for the PC<12:8> whose contents are transferred to the upper byte of the program counter.

2: These registers can be addressed from any bank.

3: These bits are reserved; always maintain these bits clear.

TABLE 2-1:	SPECIAL FUNCTION REGISTER SUMMARY	(CONTINUED))
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Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Details on page:
Bank 2											
100h ⁽²⁾	INDF		g this locations is the second s		tents of FSR	to address	data memo	ry		0000 0000	21, 93
101h	TMR0	Timer0 Mo	ner0 Module Register							xxxx xxxx	35, 93
102h ⁽²⁾	PCL	Program (Counter (PC) Least Sign	nificant Byte					0000 0000	20, 93
103h ⁽²⁾	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	0001 1xxx	12, 93
104h ⁽²⁾	FSR	Indirect Da	ndirect Data Memory Address Pointer							xxxx xxxx	21, 93
105h	_	Unimplem								_	_
106h	PORTB	DRTB PORTB Data Latch when written: PORTB pins when read							xxxx xxxx	31, 93	
107h	—	Unimplem	nented							_	_
108h	—	Unimplem	nented							_	_
109h		Unimplem	nented							—	_
10Ah ^(1,2)	PCLATH	_	— — Write Buffer for the upper 5 bits of the Program Counter					0 0000	20, 93		
10Bh ⁽²⁾	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000 000x	14, 93
10Ch	EEDATA	EEPROM Data Register Low Byte								xxxx xxxx	23, 94
10Dh	EEADR	EEPROM Address Register Low Byte							xxxx xxxx	23, 94	
10Eh	EEDATH	EEPROM Data Register High Byte						xxxx xxxx	23, 94		
10Fh	EEADRH	— — EEPROM Address Register High Byte							xxxx xxxx	23, 94	
Bank 3	•										
180h ⁽²⁾	INDF		g this locations is the second s		tents of FSR	to address	data memo	ry		0000 0000	21, 93
181h	OPTION_REG	RBPU	INTEDG	TOCS	T0SE	PSA	PS2	PS1	PS0	1111 1111	13, 94
182h ⁽²⁾	PCL	Program (Counter (PC) Least Sig	nificant Byte	9	•		•	0000 0000	20, 93
183h ⁽²⁾	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	0001 1xxx	12, 93
184h ⁽²⁾	FSR	Indirect Da	ata Memory	Address Po	ointer					xxxx xxxx	21, 93
185h	_	Unimplem	nented							_	
186h	TRISB	PORTB D	ata Directio	n Register						1111 1111	31, 94
187h	—	Unimplem	nented	-						_	—
188h		Unimplem	nented							—	_
189h	—	— Unimplemented							—	—	
18Ah ^(1,2)	PCLATH	_	_	_	Write Buff	er for the up	per 5 bits of	the Program	m Counter	0 0000	20, 93
18Bh ⁽²⁾	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000 000x	14, 93
18Ch	EECON1	EEPGD	—			WRERR	WREN	WR	RD	x x000	24, 94
18Dh	EECON2	EEPROM	Control Re	gister2 (not a	a physical re	gister)					23, 94
18Eh	Reserved; maintain clear								0000 0000	—	
18Fh	Reserved; maintain clear								0000 0000	_	

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations are unimplemented, read as '0'.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for the PC<12:8> whose contents are transferred to the upper byte of the program counter.

2: These registers can be addressed from any bank.

3: These bits are reserved; always maintain these bits clear.

2.2.2.1 STATUS Register

The STATUS register contains the arithmetic status of the ALU, the RESET status and the bank select bits for data memory.

The STATUS register can be the destination for any instruction, as with any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the TO and PD bits are not writable, therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, CLRF STATUS will clear the upper three bits and set the Z bit. This leaves the STATUS register as $000u \ u1uu$ (where u = unchanged).

It is recommended, therefore, that only BCF, BSF, SWAPF and MOVWF instructions are used to alter the STATUS register, because these instructions do not affect the Z, C or DC bits from the STATUS register. For other instructions not affecting any status bits, see the "Instruction Set Summary."

Note:	The C and DC bits operate as a borrow							
	and digit borrow bit, respectively, in sub-							
	traction. See the SUBLW and SUBWF							
	instructions for examples.							

REGISTER 2-1: STATUS REGISTER (ADDRESS: 03h, 83h, 103h, 183h)

	R/W-0	R/W-0	R/W-0	R-1	R-1	R/W-x	R/W-x	R/W-x				
	IRP	RP1	RP0	TO	PD	Z	DC	С				
	bit 7							bit 0				
bit 7	IRP: Register Bank Select bit (used for indirect addressing)											
	1 = Bank 2, 3 (100h - 1FFh) 0 = Bank 0, 1 (00h - FFh)											
bit 6:5	RP1:RP0:	RP1:RP0: Register Bank Select bits (used for direct addressing)										
		3 (180h - 1F	,									
		2 (100h - 17 1 (80h - FFI	,									
		0 (00h - 7Fi	,									
	Each bank	is 128 bytes	S									
bit 4		TO: Time-out bit										
	 1 = After power-up, CLRWDT instruction, or SLEEP instruction 0 = A WDT time-out occurred 											
bit 3	PD: Power	r-down bit										
		ower-up or t ecution of the			on							
bit 2	Z: Zero bit											
		sult of an ari sult of an ari		•	on is zero on is not zero	D						
bit 1	DC: Digit o	arry/borrow	bit (ADDWF, 2	ADDLW, SUE	BLW, SUBWF I	instructions)						
	(for borrow	the polarity	is reversed)									
		/-out from th ry-out from t			e result occu ne result	rred						
bit 0	C : Carry/b	orrow bit (AI	DWF, ADDLW	, SUBLW, SI	JBWF instru	ctions)						
					the result or of the result of							
	Note:	Note: For borrow the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (RRF, RLF) instructions, this bit is loaded with either the high or low order bit of the source register.										
	Legend:											
	R = Reada	able bit	W = W	ritable bit	U = Unin	nplemented	bit, read as '	0'				

'1' = Bit is set

- n = Value at POR

x = Bit is unknown

'0' = Bit is cleared

2.2.2.2 OPTION_REG Register

The OPTION_REG Register is a readable and writable register, which contains various control bits to configure the TMR0 prescaler/WDT postscaler (single assignable register known also as the prescaler), the External INT Interrupt, TMR0 and the weak pull-ups on PORTB.

Note: To achieve a 1:1 prescaler assignment for the TMR0 register, assign the prescaler to the Watchdog Timer.

REGISTER 2-2: OPTION_REG REGISTER (ADDRESS 81h, 181h)

	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1				
	RBPU	INTEDG	TOCS	T0SE	PSA	PS2	PS1	PS0				
	bit 7							bit C				
bit 7		ORTB Pull-up B pull-ups ar										
		B pull-ups ar		y individual	port latch va	lues						
bit 6	INTEDG:	Interrupt Edg	e Select bit									
		upt on rising e upt on falling (•	•								
bit 5	T0CS : TM	IR0 Clock So	urce Select	bit								
		 1 = Transition on RA4/T0CKI pin 0 = Internal instruction cycle clock (CLKOUT) 										
bit 4	T0SE: TMR0 Source Edge Select bit											
	 1 = Increment on high-to-low transition on RA4/T0CKI pin 0 = Increment on low-to-high transition on RA4/T0CKI pin 											
bit 3	PSA: Prescaler Assignment bit											
		aler is assign aler is assign			Э							
bit 2-0	PS2:PS0:	Prescaler Ra	ate Select bi	ts								
	Bit Value	TMR0 Rate	WDT Rate									
	000 001	1:2 1:4	1:1 1:2									
	010 011	1:8 1:16	1:4 1:8									
	100	1:32	1:16									
	101 110	1:64	1:32 1:64									
	111	1 : 128 1 : 256	1 : 128									
	Legend:											
	R = Reada	able bit	W = W	ritable bit	U = Unim	nolemented	bit, read as	0'				
	-n = Value			it is set		s cleared	x = Bit is u					

ation of the device

2.2.2.3 INTCON Register

The INTCON Register is a readable and writable register, which contains various enable and flag bits for the TMR0 register overflow, RB Port change and External RB0/INT pin interrupts.

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 2-3: INTCON REGISTER (ADDRESS: 0Bh, 8Bh, 10Bh, 18Bh)

	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x		
	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF		
	bit 7							bit 0		
bit 7		I Interrupt E								
		s all unmasl s all interru	ked interrupt pts	S						
bit 6	PEIE: Perip	heral Interr	upt Enable b	bit						
			ked peripher eral interrup	•						
bit 5	TMR0IE: TMR0 Overflow Interrupt Enable bit									
	 1 = Enables the TMR0 interrupt 0 = Disables the TMR0 interrupt 									
bit 4	INTE: RB0/INT External Interrupt Enable bit									
	 1 = Enables the RB0/INT external interrupt 0 = Disables the RB0/INT external interrupt 									
bit 3	RBIE: RB R	Port Change	Interrupt Er	nable bit						
			rt change in ort change in							
bit 2	TMR0IF: T	MR0 Overflo	ow Interrupt	Flag bit						
			overflowed not overflow		ared in soft	ware)				
bit 1	INTF: RB0/	INT Externa	al Interrupt F	lag bit						
			nal interrupt nal interrupt	•		red in softwa	are)			
bit 0	RBIF: RB F	Port Change	Interrupt Fl	ag bit						
	the bit.		RB7:RB4 pii DRTB will en software).							
	0 = None o	f the RB7:R	B4 pins hav	e changed s	tate					
	Legend:									
	R = Reada	ble bit	W = W	ritable bit	U = Unim	plemented	bit, read as	'0'		
	- n = Value	at POR	'1' = B	t is set	'0' = Bit is	s cleared	x = Bit is u	nknown		

PIE1 Register 2.2.2.4

The PIE1 register contains the individual enable bits for the peripheral interrupts.

Note:	Bit PEIE (INTCON<6>) must be set to
	enable any peripheral interrupt.

PIE1 REGISTER (ADDRESS: 8Ch) **REGISTER 2-4:**

		•									
	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
	reserved	ADIE	reserved	reserved	SSPIE	CCP1IE	TMR2IE	TMR1IE			
	bit 7							bit 0			
bit 7	Reserved:	Always ma	intain these	bits clear							
bit 6	ADIE: A/D (ADIE: A/D Converter Interrupt Enable bit									
	 1 = Enables the A/D converter interrupt 0 = Disables the A/D converter interrupt 										
bit 5-4											
		Reserved: Always maintain these bits clear									
bit 3	-	SSPIE: Synchronous Serial Port Interrupt Enable bit									
	1 = Enables										
h: h 0	0 = Disables the SSP interrupt CCP1IE : CCP1 Interrupt Enable bit										
bit 2			•	t							
	1 = Enables 0 = Disable										
bit 1	TMR2IE: TM	MR2 to PR2	2 Match Inte	rrupt Enable	bit						
	1 = Enables	s the TMR2	to PR2 mat	ch interrupt							
	0 = Disable	s the TMR2	to PR2 ma	tch interrupt							
bit 0	TMR1IE: T	MR1 Overfle	ow Interrupt	Enable bit							
	1 = Enables	s the TMR1	overflow int	errupt							
	0 = Disable	s the TMR1	overflow in	terrupt							
	Legend:										
	R = Readab	ole bit	W = W	ritable bit	U = Unin	nplemented	bit, read as	ʻ0'			
	- n = Value	at POR	'1' = B	it is set	'0' = Bit i	s cleared	x = Bit is u	nknown			

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2.2.2.5 PIR1 Register

The PIR1 register contains the individual flag bits for the peripheral interrupts.

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt bits are clear prior to enabling an interrupt.

REGISTER 2-5: PIR1 REGISTER (ADDRESS: 0Ch)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
reserved	ADIF	reserved	reserved	SSPIF	CCP1IF	TMR2IF	TMR1IF
bit 7							bit 0

- bit 7 Reserved: Always maintain these bits clear
- bit 6 ADIF: A/D Converter Interrupt Flag bit
 - 1 = An A/D conversion completed
 - 0 = The A/D conversion is not complete
- bit 5-4 Reserved: Always maintain these bits clear
- bit 3 SSPIF: Synchronous Serial Port (SSP) Interrupt Flag
 - 1 = The SSP interrupt condition has occurred, and must be cleared in software before returning from the Interrupt Service Routine. The conditions that will set this bit are:
 - SPI
 - A transmission/reception has taken place
 - I²C Slave
 - A transmission/reception has taken place
 - I²C Master
 - A transmission/reception has taken place
 - The initiated START condition was completed by the SSP module
 - The initiated STOP condition was completed by the SSP module
 - The initiated Restart condition was completed by the SSP module
 - The initiated Acknowledge condition was completed by the SSP module
 - A START condition occurred while the SSP module was idle (multi-master system)
 - A STOP condition occurred while the SSP module was idle (multi-master system)
 - 0 = No SSP interrupt condition has occurred
- bit 2 CCP1IF: CCP1 Interrupt Flag bit

Capture mode:

- 1 = A TMR1 register capture occurred (must be cleared in software)
- 0 = No TMR1 register capture occurred

Compare mode:

- 1 = A TMR1 register compare match occurred (must be cleared in software)
- 0 = No TMR1 register compare match occurred
- PWM mode: Unused in this mode
- bit 1 **TMR2IF**: TMR2 to PR2 Match Interrupt Flag bit
 - 1 = TMR2 to PR2 match occurred (must be cleared in software)
 - 0 = No TMR2 to PR2 match occurred

bit 0 TMR1IF: TMR1 Overflow Interrupt Flag bit

- 1 = TMR1 register overflowed (must be cleared in software)
- 0 = TMR1 register did not overflow

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

x = Bit is unknown

2.2.2.6 PIE2 Register

The PIE2 register contains the individual enable bits for the CCP2 peripheral interrupt, the SSP bus collision interrupt, and the EEPROM write operation interrupt.

- n = Value at POR

REGISTER 2-6:	PIE2 REG	ISTER (AD	DRESS: 8	Dh)				
	U-0	R/W-0	U-0	R/W-0	R/W-0	U-0	U-0	R/W-0
		reserved		EEIE	BCLIE	—	—	reserved
	bit 7							bit 0
bit 7	Unimplem	ented: Read	as '0'					
bit 6	Reserved:	Always mai	ntain this bit	clear				
bit 5	Unimplem	ented: Read	d as '0'					
bit 4	EEIE: EEP	ROM Write	Operation In	terrupt Enal	ole bit			
		EEPROM w						
bit 3	BCLIE: Bu	s Collision Ir	nterrupt Ena	ble bit				
		bus collisior bus collisio						
bit 2-1	Unimplem	ented: Read	d as '0'					
bit 0	Reserved: Always maintain this bit clear							
	Legend:							
	R = Reada	ble bit	W = W	ritable bit	U = Unim	plemented b	oit, read as '	0'

'1' = Bit is set

'0' = Bit is cleared

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2.2.2.7 PIR2 Register

bit 3

The PIR2 register contains the flag bits for the CCP2 interrupt, the SSP bus collision interrupt and the EEPROM write operation interrupt.

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 2-7: PIR2 REGISTER (ADDRESS: 0Dh)

U-0	R/W-0	U-0	R/W-0	R/W-0	U-0	U-0	R/W-0
—	reserved	—	EEIF	BCLIF	—	-	reserved
bit 7							bit 0

- bit 7 Unimplemented: Read as '0'
- bit 6 Reserved: Always maintain this bit clear
- bit 5 Unimplemented: Read as '0'
- bit 4 **EEIF**: EEPROM Write Operation Interrupt Flag bit
 - 1 = The write operation completed (must be cleared in software)
 - 0 = The write operation is not complete or has not been started
 - **BCLIF**: Bus Collision Interrupt Flag bit 1 = A bus collision has occurred in the SSP, when configured for I²C Master mode 0 = No bus collision has occurred
- bit 2-1 Unimplemented: Read as '0'
- bit 0 Reserved: Always maintain this bit clear

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

2.2.2.8 PCON Register

bit 1

The Power Control (PCON) Register contains flag bits to allow differentiation between a Power-on Reset (POR), a Brown-out Reset (BOR), a Watchdog Reset (WDT) and an external MCLR Reset.

Note:	BOR is unknown on POR. It must be set by
	the user and checked on subsequent
	RESETS to see if BOR is clear, indicating
	a brown-out has occurred. The BOR status
	bit is a don't care and is not predictable if
	the brown-out circuit is disabled (by clear-
	ing the BODEN bit in the Configuration
	Word).

REGISTER 2-8: PCON REGISTER (ADDRESS: 8Eh)

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-1
—	_	_	—	—	_	POR	BOR
bit 7							bit 0

bit 7-2 Unimplemented: Read as '0'

POR: Power-on Reset Status bit

1 = No Power-on Reset occurred

0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs)

bit 0 BOR: Brown-out Reset Status bit

1 = No Brown-out Reset occurred

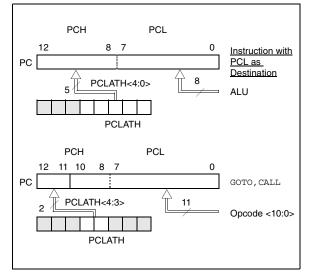
0 = A Brown-out Reset occurred (must be set in software after a Brown-out Reset occurs)

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

2.3 PCL and PCLATH

The program counter (PC) is 13-bits wide. The low byte comes from the PCL register, which is a readable and writable register. The upper bits (PC<12:8>) are not readable, but are indirectly writable through the PCLATH register. On any RESET, the upper bits of the PC will be cleared. Figure 2-3 shows the two situations for the loading of the PC. The upper example in the figure shows how the PC is loaded on a write to PCL (PCLATH<4:0> \rightarrow PCH). The lower example in the figure shows how the PC is loaded during a CALL or GOTO instruction (PCLATH<4:3> \rightarrow PCH).

FIGURE 2-3: LOADING OF PC IN DIFFERENT SITUATIONS



2.3.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When doing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256 byte block). Refer to the Application Note, *"Implementing a Table Read"* (AN556).

2.3.2 STACK

The PIC16FXXX family has an 8-level deep x 13-bit wide hardware stack. The stack space is not part of either program or data space and the stack pointer is not readable or writable. The PC is PUSHed onto the stack when a CALL instruction is executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a PUSH or POP operation.

The stack operates as a circular buffer. This means that after the stack has been PUSHed eight times, the ninth push overwrites the value that was stored from the first push. The tenth push overwrites the second push (and so on).

Note 1: There are no status bits to indicate stack overflow or stack underflow conditions.

2: There are no instructions/mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, RETURN, RETLW and RETFIE instructions, or the vectoring to an interrupt address.

2.4 Program Memory Paging

All PIC16FXXX devices are capable of addressing a continuous 8K word block of program memory. The CALL and GOTO instructions provide only 11 bits of address to allow branching within any 2K program memory page. When doing a CALL or GOTO instruction, the upper 2 bits of the address are provided by PCLATH<4:3>. Since the PIC16F872 has only 2K words of program memory or one page, additional code is not required to ensure that the correct page is selected before a CALL or GOTO instruction is executed. The PCLATH<4:3> bits should always be maintained as zeros. If a return from a CALL instruction (or interrupt) is executed, the entire 13-bit PC is popped off the stack. Therefore. manipulation of the PCLATH<4:3> bits are not required for the return instructions (which POPs the address from the stack).

Note: The contents of the PCLATH register are unchanged after a RETURN or RETFIE instruction is executed. The user must rewrite the contents of the PCLATH register for any subsequent subroutine calls or GOTO instructions.

2.5 Indirect Addressing, INDF and FSR Registers

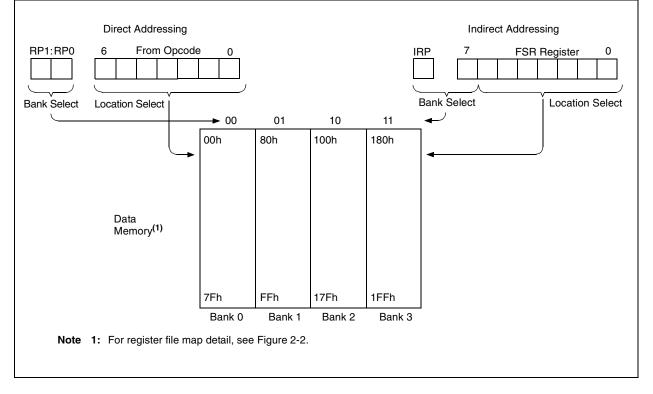
The INDF register is not a physical register. Addressing the INDF register will cause indirect addressing.

Indirect addressing is possible by using the INDF register. Any instruction using the INDF register actually accesses the register pointed to by the File Select Register, FSR. Reading the INDF register itself indirectly (FSR = '0'), will read 00h. Writing to the INDF register indirectly results in a no operation (although status bits may be affected). An effective 9-bit address is obtained by concatenating the 8-bit FSR register and the IRP bit (STATUS<7>), as shown in Figure 2-4. A simple program to clear RAM locations 20h-2Fh using indirect addressing is shown in Example 2-1.

EXAMPLE 2-1: INDIRECT ADDRESSING

	MOVLW	0x20	;initialize pointer
	MOVWF	FSR	;to RAM
NEXT	CLRF	INDF	clear INDF register;
	INCF	FSR,F	;inc pointer
	BTFSS	FSR,4	;all done?
	GOTO	NEXT	;no clear next
CONTINUE			
	:		;yes continue
			· •





NOTES:

3.0 DATA EEPROM AND FLASH PROGRAM MEMORY

The Data EEPROM and FLASH Program Memory are readable and writable during normal operation over the entire VDD range. These operations take place on a single byte for Data EEPROM memory and a single word for Program memory. A write operation causes an erase-then-write operation to take place on the specified byte or word. A bulk erase operation may not be issued from user code (which includes removing code protection).

Access to program memory allows for checksum calculation. The values written to Program memory do not need to be valid instructions. Therefore, numbers of up to 14 bits can be stored in memory for use as calibration parameters, serial numbers, packed 7-bit ASCII, etc. Executing a program memory location, containing data that forms an invalid instruction, results in the execution of a NOP instruction.

The EEPROM Data memory is rated for high erase/ write cycles (specification #D120). The FLASH Program memory is rated much lower (specification #D130) because EEPROM Data memory can be used to store frequently updated values. An on-chip timer controls the write time and it will vary with voltage and temperature, as well as from chip to chip. Please refer to the specifications for exact limits (specifications #D122 and #D133).

A byte or word write automatically erases the location and writes the new value (erase before write). Writing to EEPROM Data memory does not impact the operation of the device. Writing to Program memory will cease the execution of instructions until the write is complete. The program memory cannot be accessed during the write. During the write operation, the oscillator continues to run, the peripherals continue to function and interrupt events will be detected and essentially "queued" until the write is complete. When the write completes, the next instruction in the pipeline is executed and the branch to the interrupt vector will take place if the interrupt is enabled and occurred during the write.

Read and write access to both memories take place indirectly through a set of Special Function Registers (SFR). The six SFRs used are:

- EEDATA
- EEDATH
- EEADR
- EEADRH
- EECON1
- EECON2

The EEPROM Data memory allows byte read and write operations without interfering with the normal operation of the microcontroller. When interfacing to EEPROM Data memory, the EEADR register holds the address to be accessed. Depending on the operation, the EEDATA register holds the data to be written or the data read at the address in EEADR. The PIC16F872 has 64 bytes of EEPROM Data memory and therefore, requires that the two Most Significant bits of EEADR remain clear. EEPROM Data memory on these devices wraps around to 0 (i.e., 40h in the EEADR maps to 00h).

The FLASH Program memory allows non-intrusive read access, but write operations cause the device to stop executing instructions until the write completes. When interfacing to the Program memory, the EEADRH:EEADR registers pair forms a two-byte word which holds the 13-bit address of the memory location being accessed. The EEDATH:EEDATA register pair holds the 14-bit data for writes or reflects the value of program memory after a read operation. Just as in EEPROM Data memory accesses, the value of the EEADRH:EEADR registers must be within the valid range of program memory, depending on the device (0000h to 07FFh). Addresses outside of this range wrap around to 0000h (i.e., 0800h maps to 0000h).

3.1 EECON1 and EECON2 Registers

The EECON1 register is the control register for configuring and initiating the access. The EECON2 register is not a physically implemented register, but is used exclusively in the memory write sequence to prevent inadvertent writes.

There are many bits used to control the read and write operations to EEPROM Data and FLASH Program memory. The EEPGD bit determines if the access will be a program or data memory access. When clear, any subsequent operations will work on the EEPROM Data memory. When set, all subsequent operations will operate in the Program memory.

Read operations only use one additional bit, RD, which initiates the read operation from the desired memory location. Once this bit is set, the value of the desired memory location will be available in the data registers. This bit cannot be cleared by firmware. It is automatically cleared at the end of the read operation. For EEPROM Data memory reads, the data will be available in the EEDATA register in the very next instruction cycle after the RD bit is set. For program memory reads, the data will be loaded into the EEDATH:EEDATA registers, following the second instruction after the RD bit is set. Write operations have two control bits, WR and WREN. and two status bits, WRERR and EEIF. The WREN bit is used to enable or disable the write operation. When WREN is clear, the write operation will be disabled. Therefore, the WREN bit must be set before executing a write operation. The WR bit is used to initiate the write operation. It also is automatically cleared at the end of the write operation. The interrupt flag EEIF (located in register PIR2) is used to determine when the memory write completes. This flag must be cleared in software before setting the WR bit. For EEPROM Data memory, once the WREN bit and the WR bit have been set, the desired memory address in EEADR will be erased followed by a write of the data in EEDATA. This operation takes place in parallel with the microcontroller continuing to execute normally. When the write is complete, the EEIF flag bit will be set. For program memory, once the WREN bit and the WR bit have been set, the microcontroller will cease to execute instructions. The

desired memory location pointed to by EEADRH:EEADR will be erased. Then the data value in EEDATH:EEDATA will be programmed. When complete, the EEIF flag bit will be set and the microcontroller will continue to execute code.

The WRERR bit is used to indicate when the device has been RESET during a write operation. WRERR should be cleared after Power-on Reset. Thereafter, it should be checked on any other RESET. The WRERR bit is set when a write operation is interrupted by a MCLR Reset or a WDT Time-out Reset during normal operation. In these situations, following a RESET, the user should check the WRERR bit and rewrite the memory location if set. The contents of the data registers, address registers and EEPGD bit are not affected by either MCLR Reset or WDT Time-out Reset during normal operation.

REGISTER 3-1: EECON1 REGISTER (ADDRESS 18Ch)

-			· -	,				
	R/W-x	U-0	U-0	U-0	R/W-x	R/W-0	R/S-0	R/S-0
	EEPGD	_	—	_	WRERR	WREN	WR	RD
	bit 7							bit 0
bit 7	EEPGD: Pr	ogram/Data	a EEPROM S	Select bit				
		es Program						
		es data mei		a read or wri	to operation	ie in progra		
bit 6-4			•			ris in piogre		
bit 3	WRERR: E							
DIT 5			•	y terminated				
			•	Reset during		eration)		
	• •		n completed	·	5	,		
bit 2	WREN: EE	PROM Writ	e Enable bit					
		write cycles						
		write to the	EEPROM					
bit 1	WR: Write							
		-	•	s cleared by	hardware o	nce write is	complete. T	he WR bit
		•	t cleared) in					
bit 0	RD: Read (•						
	1 = Initiates	an EEPRC	DM read RD	is cleared in	hardware.	The RD bit o	can only be a	set (not
) in software						,
	0 = Does n	ot initiate ar	EEPROM I	read				
	Legend:							
	S = Settable		-	adable bit		W = Writab	le bit	
	U = Unimple	emented bit	, read as '0'			- n = Value	at POR	
	'1' = Bit is s	et	'0' = Bi	t is cleared		x = Bit is ur	Iknown	

3.2 Reading the EEPROM Data Memory

Reading EEPROM Data memory only requires that the desired address to access be written to the EEADR register and clear the EEPGD bit. After the RD bit is set, data will be available in the EEDATA register on the very next instruction cycle. EEDATA will hold this value until another read operation is initiated or until it is written by firmware.

The steps to reading the EEPROM Data Memory are:

- 1. Write the address to EEDATA. Make sure that the address is not larger than the memory size of the device.
- 2. Clear the EEPGD bit to point to EEPROM Data memory.
- 3. Set the RD bit to start the read operation.
- 4. Read the data from the EEDATA register.

EXAMPLE 3-1: EEPROM DATA READ

BSF	STATUS,	RP1	;
BCF	STATUS,	RP0	;Bank 2
MOVF	ADDR, W		;Write address
MOVWF	EEADR		;to read from
BSF	STATUS,	RP0	;Bank 3
BCF	EECON1,	EEPGD	;Point to Data memory
BSF	EECON1,	RD	;Start read operation
BCF	STATUS,	RP0	;Bank 2
MOVF	EEDATA,	W	;W = EEDATA

3.3 Writing to the EEPROM Data Memory

There are many steps in writing to the EEPROM Data memory. Both address and data values must be written to the SFRs. The EEPGD bit must be cleared and the WREN bit must be set to enable writes. The WREN bit should be kept clear at all times, except when writing to the EEPROM Data. The WR bit can only be set if the WREN bit was set in a previous operation, i.e., they both cannot be set in the same operation. The WREN bit should then be cleared by firmware after the write. Clearing the WREN bit before the write actually completes will not terminate the write in progress.

Writes to EEPROM Data memory must also be prefaced with a special sequence of instructions that prevent inadvertent write operations. This is a sequence of five instructions that must be executed without interruption for each byte written.

The steps to write to program memory are:

- 1. Write the address to EEADR. Make sure that the address is not larger than the memory size of the device.
- 2. Write the 8-bit data value to be programmed in the EEDATA registers.
- 3. Clear the EEPGD bit to point to EEPROM Data memory.
- 4. Set the WREN bit to enable program operations.
- 5. Disable interrupts (if enabled).
- 6. Execute the special five instruction sequence:
 - Write 55h to EECON2 in two steps (first to W, then to EECON2)
 - Write AAh to EECON2 in two steps (first to W, then to EECON2)
 - Set the WR bit
- 7. Enable interrupts (if using interrupts).
- 8. Clear the WREN bit to disable program operations.
- At the completion of the write cycle, the WR bit is cleared and the EEIF interrupt flag bit is set. (EEIF must be cleared by firmware). Firmware may check for EEIF to be set or WR to clear to indicate end of program cycle.

EEPROM DATA \	NRITE
STATUS, RP1 STATUS, RP0 ADDR, W EEADR VALUE, W EEDATA STATUS, RP0 EECON1, EEPGD EECON1, WREN	; ;Bank 2 ;Address to ;write to ;Data to ;write ;Bank 3 ;Point to Data memory ;Enable writes
INTCON, GIE	;Only disable interrupts ;if already enabled, ;otherwise discard
0x55 EECON2 0xAA EECON2 EECON1, WR	;Write 55h to ;EECON2 ;Write AAh to ;EECON2 ;Start write operation
INTCON, GIE	;Only enable interrupts ;if using interrupts, ;otherwise discard ;Disable writes
	STATUS, RP0 ADDR, W EEADR VALUE, W EEDATA STATUS, RP0 EECON1, EEPGD EECON1, WREN INTCON, GIE 0x55 EECON2 0xAA EECON2 EECON1, WR

3.4 Reading the FLASH Program Memory

Reading FLASH Program memory is much like that of EEPROM Data memory, only two NOP instructions must be inserted after the RD bit is set. These two instruction cycles that the NOP instructions execute will be used by the microcontroller to read the data out of program memory and insert the value into the EEDATH:EEDATA registers. Data will be available following the second NOP instruction. EEDATH and EEDATA will hold their value until another read operation is initiated, or until they are written by firmware.

The steps to reading the FLASH Program Memory are:

- 1. Write the address to EEADRH:EEADR. Make sure that the address is not larger than the memory size of the device.
- 2. Set the EEPGD bit to point to FLASH Program memory.
- 3. Set the RD bit to start the read operation.
- 4. Execute two NOP instructions to allow the microcontroller to read out of program memory.
- 5. Read the data from the EEDATH:EEDATA registers.

		I EAGITT HOUHA	
	BSF	STATUS, RP1	;
	BCF	STATUS, RPO	;Bank 2
	MOVF	ADDRL, W	;Write the
	MOVWF	EEADR	;address bytes
	MOVF	ADDRH,W	; for the desired
	MOVWF	EEADRH	;address to read
	BSF	STATUS, RPO	;Bank 3
	BSF	EECON1, EEPGD	;Point to Program memory
8 9	BSF	EECON1, RD	;Start read operation
uen	NOP		;Required two NOPs
Required Sequence	NOP		;
	BCF	STATUS, RPO	;Bank 2
	MOVF	EEDATA, W	;DATAL = EEDATA
	MOVWF	DATAL	;
	MOVF	EEDATH,W	;DATAH = EEDATH
	MOVWF	DATAH	;

EXAMPLE 3-3: FLASH PROGRAM READ

3.5 Writing to the FLASH Program Memory

Writing to FLASH Program memory is unique in that the microcontroller does not execute instructions while programming is taking place. The oscillator continues to run and all peripherals continue to operate and queue interrupts, if enabled. Once the write operation completes (specification #D133), the processor begins executing code from where it left off. The other important difference when writing to FLASH Program memory is that the WRT configuration bit, when clear, prevents any writes to program memory (see Table 3-1).

Just like EEPROM Data memory, there are many steps in writing to the FLASH Program memory. Both address and data values must be written to the SFRs. The EEPGD bit must be set and the WREN bit must be set to enable writes. The WREN bit should be kept clear at all times, except when writing to the FLASH Program memory. The WR bit can only be set if the WREN bit was set in a previous operation, i.e., they both cannot be set in the same operation. The WREN bit should then be cleared by firmware after the write. Clearing the WREN bit before the write actually completes will not terminate the write in progress.

Writes to program memory must also be prefaced with a special sequence of instructions that prevent inadvertent write operations. This is a sequence of five instructions that must be executed without interruption for each byte written. These instructions must then be followed by two NOP instructions to allow the microcontroller to setup for the write operation. Once the write is complete, the execution of instructions starts with the instruction after the second NOP. The steps to write to program memory are:

- 1. Write the address to EEADRH:EEADR. Make sure that the address is not larger than the memory size of the device.
- 2. Write the 14-bit data value to be programmed in the EEDATH:EEDATA registers.
- 3. Set the EEPGD bit to point to FLASH Program memory.
- 4. Set the WREN bit to enable program operations.
- 5. Disable interrupts (if enabled).
- 6. Execute the special five instruction sequence:
 - Write 55h to EECON2 in two steps (first to W, then to EECON2)

- Write AAh to EECON2 in two steps (first to W, then to EECON2)
- · Set the WR bit
- 7. Execute two NOP instructions to allow the microcontroller to setup for write operation.
- 8. Enable interrupts (if using interrupts).
- 9. Clear the WREN bit to disable program operations.

At the completion of the write cycle, the WR bit is cleared and the EEIF interrupt flag bit is set. (EEIF must be cleared by firmware). Since the microcontroller does not execute instructions during the write cycle, the firmware does not necessarily have to check either EEIF or WR to determine if the write had finished.

		BSF	STATUS, RP1	;
		BCF	STATUS, RPO	;Bank 2
		MOVF	ADDRL, W	;Write address
		MOVWF	EEADR	;of desired
		MOVF	ADDRH, W	;program memory
		MOVWF	EEADRH	;location
		MOVF	VALUEL, W	;Write value to
		MOVWF	EEDATA	;program at
		MOVF	VALUEH, W	;desired memory
		MOVWF	EEDATH	;location
		BSF	STATUS, RPO	;Bank 3
		BSF	EECON1, EEPGD	;Point to Program memory
		BSF	EECON1, WREN	;Enable writes
				;Only disable interrupts
		BCF	INTCON, GIE	; if already enabled,
				;otherwise discard
		MOVLW	0x55	;Write 55h to
		MOVWF	EECON2	; EECON2
	Required Sequence	MOVLW	0xAA	;Write AAh to
	qui	MOVWF	EECON2	; EECON2
	Sec	BSF	EECON1, WR	;Start write operation
		NOP		;Two NOPs to allow micro
		NOP		;to setup for write
				;Only enable interrupts
		BSF	INTCON, GIE	; if using interrupts,
1				;otherwise discard
1		BCF	EECON1, WREN	;Disable writes

EXAMPLE 3-4: FLASH PROGRAM WRITE

3.6 Write Verify

The PIC16F87X devices do not automatically verify the value written during a write operation. Depending on the application, good programming practice may dictate that the value written to memory be verified against the original value. This should be used in applications where excessive writes can stress bits near the specified endurance limits.

3.7 Protection Against Spurious Writes

There are conditions when the device may not want to write to the EEPROM Data memory or FLASH program memory. To protect against these spurious write conditions various mechanisms have been built into the device. On power-up, the WREN bit is cleared and the Power-up Timer (if enabled) prevents writes.

The write initiate sequence and the WREN bit together help prevent any accidental writes during brown-out, power glitches or firmware malfunction.

3.8 Operation While Code Protected

The PIC16F872 has two code protect mechanisms, one bit for EEPROM Data memory and two bits for FLASH Program memory. Data can be read and written to the EEPROM Data memory regardless of the state of the code protection bit, CPD. When code protection is enabled, CPD cleared, external access via ICSP is disabled regardless of the state of the program memory code protect bits. This prevents the contents of EEPROM Data memory from being read out of the device.

The state of the program memory code protect bits, CP0 and CP1, do not affect the execution of instructions out of program memory. The PIC16F872 can always read the values in program memory, regardless of the state of the code protect bits. However, the state of the code protect bits and the WRT bit will have different effects on writing to program memory. Table 4-1 shows the effect of the code protect bits and the WRT bit on program memory.

Once code protection has been enabled for either EEPROM Data memory or FLASH Program memory, only a full erase of the entire device will disable code protection.

3.9 FLASH Program Memory Write Protection

The configuration word contains a bit that write protects the FLASH Program memory called WRT. This bit can only be accessed when programming the device via ICSP. Once write protection is enabled, only an erase of the entire device will disable it. When enabled, write protection prevents any writes to FLASH Program memory. Write protection does not affect program memory reads.

TABLE 3-1: READ/WRITE STATE OF INTERNAL FLASH PROGRAM MEMORY

Cor	nfiguration	Bits	MomenyLeastion	Internal	Internal	ICSP Read	ICSP Write	
CP1	CP0	WRT	Memory Location	Read	Write	ICSP Read		
0	0	0	All program memory	Yes	No	No	No	
0	0	1	All program memory	Yes	Yes	No	No	
1	1	0	All program memory	Yes	No	Yes	Yes	
1	1	1	All program memory	Yes	Yes	Yes	Yes	

TABLE 3-2: REGISTERS ASSOCIATED WITH DATA EEPROM/PROGRAM FLASH
--

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
0Bh, 8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TMR0IE	INTE RBIE TMR0IF INTF RBIF					0000 000x	0000 000u
10Dh	EEADR	EEPROM	Address I	xxxx xxxx	uuuu uuuu						
10Fh	EEADRH	—	—	_	EEPROM	xxxx xxxx	uuuu uuuu				
10Ch	EEDATA	EEPROM	Data Reg	ister, Low	Byte					xxxx xxxx	uuuu uuuu
10Eh	EEDATH	—	—	EEPROM	Data Reg	jister, High	Byte			xxxx xxxx	uuuu uuuu
18Ch	EECON1	EEPGD		_		WRERR	WREN	WR	RD	x x000	x u000
18Dh	EECON2	EEPROM	Control R	—							
8Dh	PIE2	_	(1)	—	EEIE	BCLIE	-r-0 0r	-r-0 0r			
0Dh	PIR2	—	(1)	—	EEIF	BCLIF	—		(1)	-r-0 0r	-r-0 0r

Legend: x = unknown, u = unchanged, r = reserved, - = unimplemented, read as '0'. Shaded cells are not used during FLASH/EEPROM access.

Note 1: These bits are reserved; always maintain these bits clear.

4.0 I/O PORTS

The PIC16F872 provides three general purpose I/O ports. Some pins for these ports are multiplexed with an alternate function for the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

Additional information on I/O ports may be found in the PICmicro[™] Mid-Range Reference Manual (DS33023).

4.1 PORTA and the TRISA Register

PORTA is a 6-bit wide, bi-directional port. The corresponding data direction register is TRISA. Setting a TRISA bit (= '1') will make the corresponding PORTA pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISA bit (= '0') will make the corresponding PORTA pin an output (i.e., put the contents of the output latch on the selected pin).

Reading the PORTA register reads the status of the pins, whereas writing to it will write to the port latch. All write operations are read-modify-write operations. Therefore, a write to a port implies that the port pins are read, the value is modified and then written to the port data latch.

Pin RA4 is multiplexed with the Timer0 module clock input to become the RA4/T0CKI pin. The RA4/T0CKI pin is a Schmitt Trigger input and an open drain output. All other PORTA pins have TTL input levels and full CMOS output drivers.

Other PORTA pins are multiplexed with analog inputs and analog VREF input. The operation of each pin is selected by clearing/setting the control bits in the ADCON1 register (A/D Control Register1).

Note:	On a Power-on Reset, these pins are con-
	figured as analog inputs and read as '0'.

The TRISA register controls the direction of the RA pins, even when they are being used as analog inputs. The user must ensure the bits in the TRISA register are maintained set when using them as analog inputs.

EXAMPLE 4-1: INITIALIZING PORTA

BCF	STATUS,	RP0	;
BCF	STATUS,	RP1	; Bank0
CLRF	PORTA		; Initialize PORTA by
			; clearing output
			; data latches
BSF	STATUS,	RP0	; Select Bank 1
MOVLW	0x06		; Configure all pins
MOVWF	ADCON1		; as digital inputs
MOVLW	0xCF		; Value used to
			; initialize data
			; direction
MOVWF	TRISA		; Set RA<3:0> as inputs
			; RA<5:4> as outputs
			; TRISA<7:6>are always
			; read as '0'.

FIGURE 4-1:

BLOCK DIAGRAM OF RA3:RA0 AND RA5 PINS

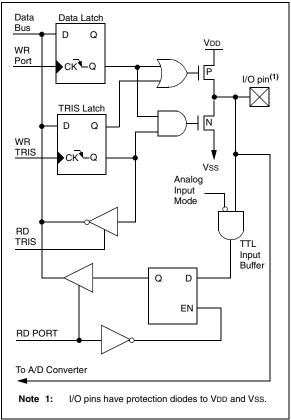
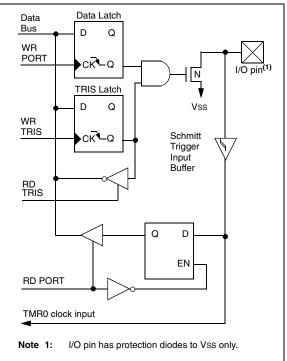


FIGURE 4-2:

BLOCK DIAGRAM OF RA4/T0CKI PIN



Name	Bit#	Buffer	Function
RA0/AN0	bit0	TTL	Input/output or analog input.
RA1/AN1	bit1	TTL	Input/output or analog input.
RA2/AN2	bit2	TTL	Input/output or analog input.
RA3/AN3/VREF	bit3	TTL	Input/output or analog input or VREF.
RA4/T0CKI	bit4	ST	Input/output or external clock input for Timer0. Output is open drain type.
RA5/SS/AN4	bit5	TTL	Input/output or slave select input for synchronous serial port or analog input.

TABLE 4-1: PORTA FUNCTIONS

Legend: TTL = TTL input, ST = Schmitt Trigger input

TABLE 4-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
05h	PORTA	—	—	RA5	RA4	RA3	RA2	RA1	RA0	0x 0000	0u 0000
85h	TRISA	—		PORTA	PORTA Data Direction Register						11 1111
9Fh	ADCON1	ADFM	_	_		PCFG3	PCFG2	PCFG1	PCFG0	0- 0000	0- 0000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTA.

Note: When using the SSP module in SPI Slave mode and \overline{SS} enabled, the A/D converter must be set to one of the following modes, where PCFG3:PCFG0 = 0100, 0101, 011x, 1101, 1110, 1111.

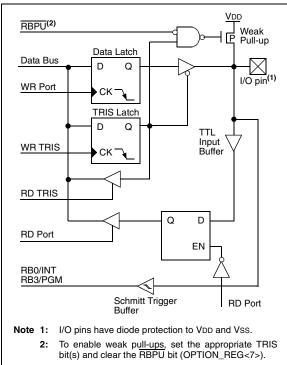
4.2 PORTB and the TRISB Register

PORTB is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISB. Setting a TRISB bit (= '1') will make the corresponding PORTB pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISB bit (= '0') will make the corresponding PORTB pin an output (i.e., put the contents of the output latch on the selected pin).

Three pins of PORTB are multiplexed with the Low Voltage Programming function; RB3/PGM, RB6/PGC and RB7/PGD. The alternate functions of these pins are described in the Special Features Section.

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is performed by clearing bit RBPU (OPTION_REG<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on a Power-on Reset.





Four of the PORTB pins, RB7:RB4, have an interrupton-change feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB7:RB4 pin configured as an output is excluded from the interrupton-change comparison). The input pins (of RB7:RB4) are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB7:RB4 are OR'ed together to generate the RB Port Change Interrupt with flag bit RBIF (INTCON<0>). This interrupt can wake the device from SLEEP. The user, in the Interrupt Service Routine, can clear the interrupt in the following manner:

- a) Any read or write of PORTB. This will end the mismatch condition.
- b) Clear flag bit RBIF.

A mismatch condition will continue to set flag bit RBIF. Reading PORTB will end the mismatch condition and allow flag bit RBIF to be cleared.

The interrupt-on-change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt-on-change feature. Polling of PORTB is not recommended while using the interrupt-on-change feature.

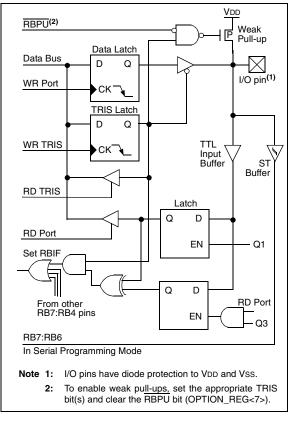
This interrupt on mismatch feature, together with software configurable pull-ups on these four pins, allow easy interface to a keypad and make it possible for wake-up on key depression. Refer to the Embedded Control Handbook, *"Implementing Wake-Up on Key Stroke"* (AN552).

RB0/INT is an external interrupt input pin and is configured using the INTEDG bit (OPTION_REG<6>).

RB0/INT is discussed in detail in Section 11.10.1.

FIGURE 4-4: B

BLOCK DIAGRAM OF RB7:RB4 PINS



Name	Bit#	Buffer	Function
RB0/INT	bit0	TTL/ST ⁽¹⁾	Input/output pin or external interrupt input. Internal software programmable weak pull-up.
RB1	bit1	TTL	Input/output pin. Internal software programmable weak pull-up.
RB2	bit2	TTL	Input/output pin. Internal software programmable weak pull-up.
RB3/PGM	bit3	TTL	Input/output pin or programming pin in LVP mode. Internal software programmable weak pull-up.
RB4	bit4	TTL	Input/output pin (with interrupt-on-change). Internal software programmable weak pull-up.
RB5	bit5	TTL	Input/output pin (with interrupt-on-change). Internal software programmable weak pull-up.
RB6/PGC	bit6	TTL/ST ⁽²⁾	Input/output pin (with interrupt-on-change) or In-Circuit Debugger pin. Internal software programmable weak pull-up. Serial programming clock.
RB7/PGD	bit7	TTL/ST ⁽²⁾	Input/output pin (with interrupt-on-change) or In-Circuit Debugger pin. Internal software programmable weak pull-up. Serial programming data.

TABLE 4-3: PORTB FUNCTIONS

Legend: TTL = TTL input, ST = Schmitt Trigger input

Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.

2: This buffer is a Schmitt Trigger input when used in Serial Programming mode.

TABLE 4-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
06h, 106h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	XXXX XXXX	uuuu uuuu
86h, 186h	TRISB	PORTB	PORTB Data Direction Register							1111 1111	1111 1111
81h, 181h	OPTION_REG	RBPU	INTEDG	TOCS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111

Legend: \mathbf{x} = unknown, \mathbf{u} = unchanged. Shaded cells are not used by PORTB.

4.3 PORTC and the TRISC Register

PORTC is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISC. Setting a TRISC bit (= '1') will make the corresponding PORTC pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISC bit (= '0') will make the corresponding PORTC pin an output (i.e., put the contents of the output latch on the selected pin).

PORTC is multiplexed with several peripheral functions (Table 4-5). PORTC pins have Schmitt Trigger input buffers.

When the l^2C module is enabled, the PORTC (4:3) pins can be configured with normal l^2C levels or with SMBus levels by using the CKE bit (SSPSTAT<6>).

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTC pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. Since the TRIS bit override is in effect while the peripheral is enabled, read-modify-write instructions (BSF, BCF, XORWF) with TRISC as the destination should be avoided. The user should refer to the corresponding peripheral section for the correct TRIS bit settings.

FIGURE 4-5: PORTC BLOCK DIAGRAM (PERIPHERAL OUTPUT OVERRIDE) RC<2:0> RC<7:5>

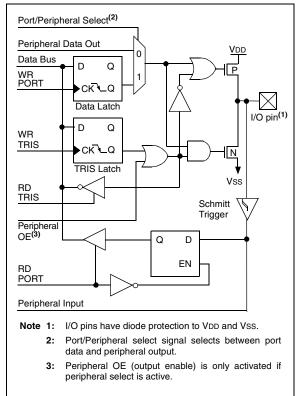


FIGURE 4-6:

PORTC BLOCK DIAGRAM (PERIPHERAL OUTPUT OVERRIDE) RC<4:3>

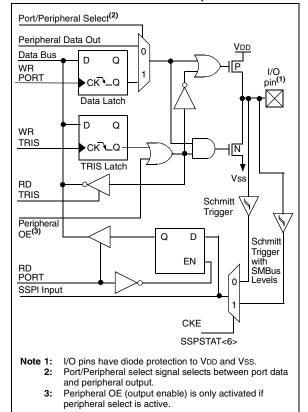


TABLE 4-5:PORTC FUNCTIONS

Name	Bit#	Buffer Type	Function
RC0/T1OSO/T1CKI	bit0	ST	Input/output port pin or Timer1 oscillator output/Timer1 clock input.
RC1/T1OSI/CCP2	bit1	ST	Input/output port pin or Timer1 oscillator input or Capture2 input/ Compare2 output/PWM2 output.
RC2/CCP1	bit2	ST	Input/output port pin or Capture1 input/Compare1 output/ PWM output.
RC3/SCK/SCL	bit3	ST	RC3 can also be the synchronous serial clock for both SPI and I^2C modes.
RC4/SDI/SDA	bit4	ST	RC4 can also be the SPI Data In (SPI mode) or Data I/O (I ² C mode).
RC5/SDO	bit5	ST	Input/output port pin or Synchronous Serial Port data output (SPI mode).
RC6	bit6	ST	Input/output port pin.
RC7	bit7	ST	Input/output port pin.

Legend: ST = Schmitt Trigger input

TABLE 4-6: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
07h	PORTC	RC7	RC6	XXXX XXXX	uuuu uuuu						
87h	TRISC	PORTC	Data Dire		1111 1111	1111 1111					

Legend: x = unknown, u = unchanged

5.0 TIMER0 MODULE

The Timer0 module timer/counter has the following features:

- 8-bit timer/counter
- Readable and writable
- 8-bit software programmable prescaler
- Internal or external clock select
- Interrupt on overflow from FFh to 00h
- Edge select for external clock

Figure 5-1 is a block diagram of the Timer0 module and the prescaler shared with the WDT.

Additional information on the Timer0 module is available in the PICmicro[™] Mid-Range MCU Family Reference Manual (DS33023).

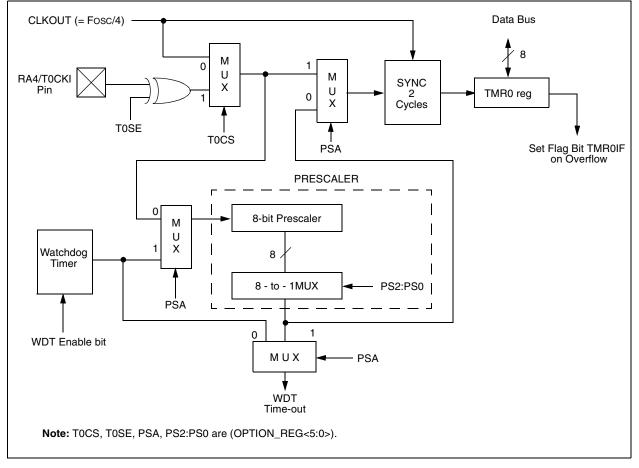
Timer mode is selected by clearing bit TOCS (OPTION_REG<5>). In Timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If the TMR0 register is written, the increment is inhibited for the following two instruction cycles. The user can work around this by writing an adjusted value to the TMR0 register. Counter mode is selected by setting bit TOCS (OPTION_REG<5>). In Counter mode, Timer0 will increment either on every rising or falling edge of pin RA4/T0CKI. The incrementing edge is determined by the Timer0 Source Edge Select bit T0SE (OPTION_REG<4>). Clearing bit T0SE selects the rising edge. Restrictions on the external clock input are discussed in detail in Section 5.2.

The prescaler is mutually exclusively shared between the Timer0 module and the Watchdog Timer. The prescaler is not readable or writable. Section 5.3 details the operation of the prescaler.

5.1 Timer0 Interrupt

The TMR0 interrupt is generated when the TMR0 register overflows from FFh to 00h. This overflow sets bit TMR0IF (INTCON<2>). The interrupt can be masked by clearing bit TMR0IE (INTCON<5>). Bit TMR0IF must be cleared in software by the Timer0 module Interrupt Service Routine before re-enabling this interrupt. The TMR0 interrupt cannot awaken the processor from SLEEP, since the timer is shut-off during SLEEP.

FIGURE 5-1: BLOCK DIAGRAM OF THE TIMER0/WDT PRESCALER



5.2 Using Timer0 with an External Clock

When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of T0CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks. Therefore, it is necessary for TOCKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device.

5.3 Prescaler

There is only one prescaler available, which is mutually exclusively shared between the Timer0 module and the Watchdog Timer. A prescaler assignment for the

REGISTER 5-1: OPTION_REG REGISTER

Timer0 module means that there is no prescaler for the Watchdog Timer, and vice-versa. This prescaler is not readable or writable (see Figure 5-1).

The PSA and PS2:PS0 bits (OPTION REG<3:0>) determine the prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g. CLRF1, MOVWF1, BSF 1, x....etc.) will clear the prescaler. When assigned to WDT, a CLRWDT instruction will clear the prescaler along with the Watchdog Timer. The prescaler is not readable or writable.

Note: Writing to TMR0, when the prescaler is assigned to Timer0, will clear the prescaler count, but will not change the prescaler assignment.

	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1				
	RBPU	INTEDG	TOCS	T0SE	PSA	PS2	PS1	PS0				
	bit 7							bit 0				
bit 7	RBPU											
bit 6	INTEDG											
bit 5	1 = Transi	R0 Clock Sou tion on T0CK al instruction o	l pin									
bit 4	1 = Increm	R0 Source Ed nent on high-t nent on low-to	o-low transi	tion on T0C	•							
bit 3	1 = Presca	PSA : Prescaler Assignment bit 1 = Prescaler is assigned to the WDT 0 = Prescaler is assigned to the Timer0 module										
bit 2-0	PS2:PS0: Prescaler Rate Select bits											
	Bit Value	TMR0 Rate	WDT Rate									
	000 001 010 011 100 101 110 111	1:2 1:4 1:8 1:16 1:32 1:64 1:128 1:256	1:1 1:2 1:4 1:8 1:16 1:32 1:64 1:128									
	Legend:											
	R = Reada	able bit	W = W	ritable bit	U = Unin	nplemented	bit, read as	'0'				
	- n = Value		'1' = Bit is set $'0' = Bit is cleared x = Bit is t$									

Note: To avoid an unintended device RESET, the instruction sequence shown in the PICmicro™ Mid-Range MCU Family Reference Manual (DS33023) must be executed when changing the prescaler assignment from Timer0 to the WDT. This sequence must be followed even if the WDT is disabled.

TABLE 5-1:	REGISTERS ASSOCIATED WITH TIMER0
------------	---

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
01h,101h	TMR0	Timer0	Module R	egister						xxxx xxxx	uuuu uuuu
0Bh,8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000 000x	0000 000u
81h,181h	OPTION_REG	RBPU	INTEDG	TOCS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by Timer0.

NOTES:

6.0 TIMER1 MODULE

The Timer1 module is a 16-bit timer/counter consisting of two 8-bit registers (TMR1H and TMR1L), which are readable and writable. The TMR1 Register pair (TMR1H:TMR1L) increments from 0000h to FFFFh and rolls over to 0000h. The TMR1 Interrupt, if enabled, is generated on overflow, which is latched in interrupt flag bit TMR1IF (PIR1<0>). This interrupt can be enabled/disabled by setting/clearing TMR1 interrupt enable bit TMR1IE (PIE1<0>).

Timer1 can operate in one of two modes:

- As a Timer
- As a Counter

The operating mode is determined by the clock select bit, TMR1CS (T1CON<1>).

In Timer mode, Timer1 increments every instruction cycle. In Counter mode, it increments on every rising edge of the external clock input.

Timer1 can be enabled/disabled by setting/clearing control bit TMR1ON (T1CON<0>).

Timer1 also has an internal "RESET input". This RESET can be generated by either of the two CCP modules (Section 8.0). Register 6-1 shows the Timer1 control register.

When the Timer1 oscillator is enabled (T1OSCEN is set), the RC1/T1OSI/CCP2 and RC0/T1OSO/T1CKI pins become inputs. That is, the TRISC<1:0> value is ignored, and these pins read as '0'.

Additional information on timer modules is available in the PICmicro[™] Mid-range MCU Family Reference Manual (DS33023).

-			-	(- /						
	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
	—	_	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N				
	bit 7							bit 0				
bit 7-6	Unimpleme	nted: Bea	d as '0'									
bit 5-4	Unimplemented: Read as '0' T1CKPS1:T1CKPS0: Timer1 Input Clock Prescale Select bits											
DIT 5-4	11 = 1:8 Pre 10 = 1:4 Pre 01 = 1:2 Pre 00 = 1:1 Pre	escale value escale value escale value	e e e	I CIUCK FIES		115						
bit 3	T1OSCEN:	Timer1 Os	cillator Enab	ble Control b	it							
	1 = Oscillato 0 = Oscillato		-	ator inverter	is turned off	to eliminate	e power drai	n)				
bit 2	T1SYNC : Timer1 External Clock Input Synchronization Control bit <u>When TMR1CS = 1:</u> 1 = Do not synchronize external clock input											
	0 = Synchronize external clock input											
	When TMR1CS = 0:											
	This bit is ig	nored. Tim	er1 uses the	e internal clo	ck when TM	R1CS = 0.						
bit 1	TMR1CS : Timer1 Clock Source Select bit 1 = External clock from pin RC0/T1OSO/T1CKI (on the rising edge)											
	0 = Internal				Υ.	0 0 /						
bit 0	TMR1ON: T	ïmer1 On b	oit									
	1 = Enables 0 = Stops Ti											
	Legend:											
	R = Readab	le bit	W = W	/ritable bit	U = Unim	plemented	bit, read as	'0'				
	- n = Value a	at POR	'1' = B	it is set	'0' = Bit is	cleared	x = Bit is u	nknown				

REGISTER 6-1: T1CON: TIMER1 CONTROL REGISTER (ADDRESS 10h)

6.1 Timer1 Operation in Timer Mode

Timer mode is selected by clearing the TMR1CS (T1CON<1>) bit. In this mode, the input clock to the timer is FOSC/4. The synchronize control bit T1SYNC (T1CON<2>) has no effect since the internal clock is always in sync.

6.2 Timer1 Counter Operation

Timer1 may operate in either a Synchronous or an Asynchronous mode, depending on the setting of the TMR1CS bit.

When Timer1 is being incremented via an external source, increments occur on a rising edge. After Timer1 is enabled in Counter mode, the module must first have a falling edge before the counter begins to increment.

FIGURE 6-1: TIMER1 INCREMENTING EDGE

6.3 Timer1 Operation in Synchronized Counter Mode

Counter mode is selected by setting bit TMR1CS. In this mode, the timer increments on every rising edge of clock input on pin RC1/T1OSI/CCP2, when bit T1OSCEN is set, or on pin RC0/T1OSO/T1CKI, when bit T1OSCEN is cleared.

If $\overline{T1SYNC}$ is cleared, then the external clock input is synchronized with internal phase clocks. The synchronization is done after the prescaler stage. The prescaler stage is an asynchronous ripple counter.

In this configuration, during SLEEP mode, Timer1 will not increment even if the external clock is present, since the synchronization circuit is shut-off. The prescaler, however, will continue to increment.

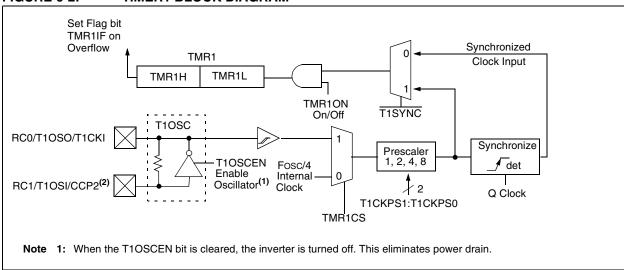


FIGURE 6-2: TIMER1 BLOCK DIAGRAM

6.4 Timer1 Operation in Asynchronous Counter Mode

If control bit $\overline{T1SYNC}$ (T1CON<2>) is set, the external clock input is not synchronized. The timer continues to increment asynchronous to the internal phase clocks. The timer will continue to run during SLEEP and can generate an interrupt on overflow, which will wake-up the processor. However, special precautions in software are needed to read/write the timer (Section 6.4.1).

In Asynchronous Counter mode, Timer1 cannot be used as a time-base for capture or compare operations.

6.4.1 READING AND WRITING TIMER1 IN ASYNCHRONOUS COUNTER MODE

Reading TMR1H or TMR1L while the timer is running from an external asynchronous clock will guarantee a valid read (taken care of in hardware). However, the user should keep in mind that reading the 16-bit timer in two 8-bit values itself, poses certain problems, since the timer may overflow between the reads.

For writes, it is recommended that the user simply stop the timer and write the desired values. A write contention may occur by writing to the timer registers while the register is incrementing. This may produce an unpredictable value in the timer register.

Reading the 16-bit value requires some care. Examples 12-2 and 12-3 in the PICmicro[™] Mid-Range MCU Family Reference Manual (DS33023) show how to read and write Timer1 when it is running in Asynchronous mode.

6.5 Timer1 Oscillator

A crystal oscillator circuit is built-in between pins T1OSI (input) and T1OSO (amplifier output). It is enabled by setting control bit T1OSCEN (T1CON<3>). The oscillator is a low power oscillator, rated up to 200 kHz. It will continue to run during SLEEP. It is primarily intended for use with a 32 kHz crystal. Table 6-1 shows the capacitor selection for the Timer1 oscillator.

The Timer1 oscillator is identical to the LP oscillator. The user must provide a software time delay to ensure proper oscillator start-up.

TABLE 6-1:CAPACITOR SELECTION FOR
THE TIMER1 OSCILLATOR

Osc Type	Freq	C1	C2					
LP	32 kHz	33 pF	33 pF					
	100 kHz	15 pF	15 pF					
	200 kHz 15 pF		15 pF					
These va	lues are for o	design guidaı	nce only.					
Crystals Tested:								
32.768 kHz	Epson C-00	1R32.768K-A	± 20 PPM					
100 kHz	Epson C-2	100.00 KC-P	± 20 PPM					
200 kHz	STD XTL	200.000 kHz	± 20 PPM					
 200 kHz STD XTL 200.000 kHz ± 20 PPM Note 1: Higher capacitance increases the stability of oscillator, but also increases the start-up time. 2: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components. 								

6.6 Resetting Timer1 using a CCP Trigger Output

If the CCP1 or CCP2 module is configured in Compare mode to generate a "special event trigger" (CCP1M3:CCP1M0 = 1011), this signal will reset Timer1.

Note:	The special event triggers from the CCP1
	and CCP2 modules will not set interrupt
	flag bit TMR1IF (PIR1<0>).

Timer1 must be configured for either Timer or Synchronized Counter mode to take advantage of this feature. If Timer1 is running in Asynchronous Counter mode, this RESET operation may not work.

In the event that a write to Timer1 coincides with a special event trigger from CCP1 or CCP2, the write will take precedence.

In this mode of operation, the CCPRxH:CCPRxL register pair effectively becomes the period register for Timer1.

6.7 Resetting of Timer1 Register Pair (TMR1H, TMR1L)

TMR1H and TMR1L registers are not reset to 00h on a POR or any other RESET, except by the CCP1 and CCP2 special event triggers.

T1CON register is reset to 00h on a Power-on Reset or a Brown-out Reset, which shuts off the timer and leaves a 1:1 prescale. In all other RESETS, the register is unaffected.

6.8 Timer1 Prescaler

The prescaler counter is cleared on writes to the TMR1H or TMR1L registers.

TABLE 6-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR		Value on all other RESETS	
0Bh,8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	(3)	ADIF	(3)	(3)	SSPIF	CCP1IF	TMR2IF	TMR1IF	r0rr	0000	0000	0000
8Ch	PIE1	(3)	ADIE	(3)	(3)	SSPIE	CCP1IE	TMR2IE	TMR1IE	r0rr	0000	0000	0000
0Eh	TMR1L	Holding	Register	for the Lea	st Significa	nt Byte of th	e 16-bit TM	MR1 Regis	ter	xxxx	xxxx	uuuu	uuuu
0Fh	TMR1H	Holding	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register					xxxx	xxxx	uuuu	uuuu		
10h	T1CON	_	_	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00	0000	uu	uuuu

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the Timer1 module.

7.0 TIMER2 MODULE

Timer2 is an 8-bit timer with a prescaler and a postscaler. It can be used as the PWM time-base for the PWM mode of the CCP module(s). The TMR2 register is readable and writable, and is cleared on any device RESET.

The input clock (Fosc/4) has a prescale option of 1:1, 1:4 or 1:16, selected by control bits T2CKPS1:T2CKPS0 (T2CON<1:0>).

The Timer2 module has an 8-bit period register, PR2. Timer2 increments from 00h until it matches PR2 and then resets to 00h on the next increment cycle. PR2 is a readable and writable register. The PR2 register is initialized to FFh upon RESET.

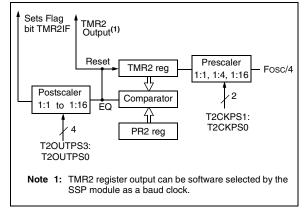
The match output of TMR2 goes through a 4-bit postscaler (which gives a 1:1 to 1:16 scaling inclusive) to generate a TMR2 interrupt (latched in flag bit, TMR2IF (PIR1<1>)).

Timer2 can be shut-off by clearing control bit TMR2ON (T2CON<2>) to minimize power consumption.

Register 7-1 shows the Timer2 Control register.

Additional information on timer modules is available in the PICmicro[™] Mid-Range MCU Family Reference Manual (DS33023).

FIGURE 7-1: TIMER2 BLOCK DIAGRAM



REGISTER 7-1: T2CON: TIMER2 CONTROL REGISTER (ADDRESS 12h)

	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0				
	bit 7							bit 0				
bit 7	Unimplen	nented: Rea	d as '0'									
bit 6-3	TOUTPS3	:TOUTPS0:	Timer2 Out	out Postscal	e Select bits	;						
	0000 = 1:1 Postscale											
	0001 = 1:2 Postscale											
	0010 = 1:3 Postscale											
	•											
	•											
	1111 = 1 :	16 Postscale)									
bit 2	TMR2ON:	Timer2 On I	bit									
	1 = Timer2 0 = Timer2											
bit 1-0	T2CKPS1	:T2CKPS0:	Timer2 Cloc	k Prescale S	Select bits							
	00 = Pres	caler is 1										
	01 = Pres											
	1x = Pres	caler is 16										
	Legend:											
	R = Reada			/ritable bit			bit, read as					
	- n = Value	e at POR	'1' = B	it is set	'0' = Bit i	s cleared	x = Bit is u	nknown				

7.1 Timer2 Prescaler and Postscaler

The prescaler and postscaler counters are cleared when any of the following occurs:

- a write to the TMR2 register
- a write to the T2CON register
- any device RESET (POR, MCLR Reset, WDT Reset or BOR)

TMR2 is not cleared when T2CON is written.

7.2 Output of TMR2

The output of TMR2 (before the postscaler) is fed to the SSP module, which optionally uses it to generate shift clock.

TABLE 7-1: REGISTERS ASSOCIATED WITH TIMER2 AS A TIMER/COUNTE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value PO BC	R,	all c	e on other ETS
0Bh,8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	(3)	ADIF	(3)	(3)	SSPIF	CCP1IF	TMR2IF	TMR1IF	r0rr	0000	0000	0000
8Ch	PIE1	(3)	ADIE	(3)	(3)	SSPIE	CCP1IE	TMR2IE	TMR1IE	r0rr	0000	0000	0000
11h	TMR2	Timer2	Module Reg	jister						0000	0000	0000	0000
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000	0000	-000	0000
92h	PR2	Timer2	ner2 Period Register							1111	1111	1111	1111

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the Timer2 module.

8.0 CAPTURE/COMPARE/PWM MODULE

The Capture/Compare/PWM (CCP) module contains a 16-bit register, which can operate as a:

- 16-bit Capture register
- 16-bit Compare register
- PWM Master/Slave Duty Cycle register

The timer resources used by the module are shown in Table 8-1.

Capture/Compare/PWM Register 1 (CCPR1) is comprised of two 8-bit registers: CCPR1L (low byte) and CCPR1H (high byte). The CCP1CON register controls the operation of CCP1. The special event trigger is generated by a compare match and will reset Timer1. Additional information on CCP modules is available in the PICmicro[™] Mid-Range MCU Family Reference Manual (DS33023) and in Application Note (AN594), *"Using the CCP Modules"* (DS00594).

TABLE 8-1: CCP MODE - TIMER RESOURCES REQUIRED

CCP Mode	Timer Resource
Capture	Timer1
Compare	Timer1
PWM	Timer2

REGISTER 8-1: CCP1CON REGISTER (ADDRESS: 17h)

	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
		_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0				
	bit 7			•			•	bit 0				
bit 7-6	Unimplem	ented: Rea	d as '0'									
bit 5-4	CCP1X:CC	P1Y : PWM	Least Signit	ficant bits								
	Capture mode:											
	Unused <u>Compare mode:</u>											
	Unused											
	PWM mode	<u>e:</u>										
	These bits	are the two	LSbs of the	PWM duty of	cycle. The ei	ight MSbs ai	re found in C	CPR1L.				
bit 3-0	CCP1M3:CCP1M0: CCP1 Mode Select bits											
	0000 = Ca	oture/Comp	are/PWM di	sabled (rese	ts CCP mod	dule)						
			, every falling	0 0								
			, every rising									
			every 4th ri									
			, every 16th e, set output	•••		e eot)						
		•	•	•		,						
	1001 = Compare mode, clear output on match (CCP1IF bit is set) 1010 = Compare mode, generate software interrupt on match (CCP1IF bit is set, CCP1 pin is											
	unaffected)											
	1011 = Compare mode, trigger special event (CCP1IF bit is set, CCP1 pin is unaffected);											
			MR1 and sta	arts an A/D o	conversion (if A/D modul	le is enableo	(k				
	11xx = PW	/M mode										
	Legend:											
	B = Beada	hle hit	W = W	/ritable bit	LI = LInim	nlemented	hit read as	'O'				

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

8.1 Capture Mode

In Capture mode, CCPR1H:CCPR1L captures the 16-bit value of the TMR1 register when an event occurs on pin RC2/CCP1. An event is defined as one of the following:

- Every falling edge
- · Every rising edge
- · Every 4th rising edge
- Every 16th rising edge

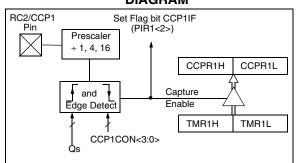
The type of event is configured by control bits CCP1M3:CCP1M0 (CCP1CON<3:0>). When a capture is made, the interrupt request flag bit CCP1IF (PIR1<2>) is set. The interrupt flag must be cleared in software. If another capture occurs before the value in register CCPR1 is read, the old captured value is overwritten by the new value.

8.1.1 CCP PIN CONFIGURATION

In Capture mode, the RC2/CCP1 pin should be configured as an input by setting the TRISC<2> bit.

Note: If the RC2/CCP1 pin is configured as an output, a write to the port can cause a capture condition.

FIGURE 8-1: CAPTURE MODE OPERATION BLOCK DIAGRAM



8.1.2 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode for the CCP module to use the capture feature. In Asynchronous Counter mode, the capture operation may not work.

8.1.3 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep bit CCP1IE (PIE1<2>) clear to avoid false interrupts and should clear the flag bit, CCP1IF, following any such change in operating mode.

8.1.4 CCP PRESCALER

There are four prescaler settings, specified by bits CCP1M3:CCP1M0. Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. Any RESET will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared, therefore, the first capture may be from a non-zero prescaler. Example 8-1 shows the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

EXAMPLE 8-1: CHANGING BETWEEN CAPTURE PRESCALERS

CLRF MOVLW	CCP1CON NEW_CAPT_PS	; Turn CCP module off ; Load the W reg with
		; the new prescaler
		; move value and CCP ON
MOVWF	CCP1CON	; Load CCP1CON with this
		; value

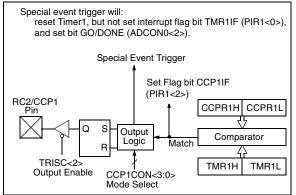
8.2 Compare Mode

In Compare mode, the 16-bit CCPR1 register value is constantly compared against the TMR1 register pair value. When a match occurs, the RC2/CCP1 pin is:

- Driven high
- Driven low
- · Remains unchanged

The action on the pin is based on the value of control bits, CCP1M3:CCP1M0 (CCP1CON<3:0>). At the same time, interrupt flag bit CCP1IF is set.

FIGURE 8-2: COMPARE MODE OPERATION BLOCK DIAGRAM



8.2.1 CCP PIN CONFIGURATION

The user must configure the RC2/CCP1 pin as an output by clearing the TRISC<2> bit.

Note:	Clearing the CCP1CON register will force									
	the RC2/CCP1 compare output latch to the									
	default low level. This is not the PORTC									
	I/O data latch.									

8.2.2 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode if the CCP module is using the compare feature. In Asynchronous Counter mode, the compare operation may not work.

8.2.3 SOFTWARE INTERRUPT MODE

When Generate Software Interrupt mode is chosen, the CCP1 pin is not affected. The CCPIF bit is set, causing a CCP interrupt (if enabled).

8.2.4 SPECIAL EVENT TRIGGER

In this mode, an internal hardware trigger is generated, which may be used to initiate an action.

The special event trigger output of CCP1 resets the TMR1 register pair and starts an A/D conversion (if the A/D module is enabled). This allows the CCPR1 register to effectively be a 16-bit programmable period register for Timer1.

Note: The special event trigger from the CCP module will not set interrupt flag bit TMR1IF (PIR1<0>).

TABLE 8-2: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, AND TIMER1

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value PO BC	R,	all o	e on other SETS
0Bh,8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	(1)	ADIF	(1)	(1)	SSPIF	CCP1IF	TMR2IF	TMR1IF	r0rr	0000	0000	0000
8Ch	PIE1	(1)	ADIE	(1)	(1)	SSPIE	CCP1IE	TMR2IE	TMR1IE	r0rr	0000	0000	0000
87h	TRISC	PORTC	Data Di	rection Reg	ister					1111	1111	1111	1111
0Eh	TMR1L	Holding	Registe	r for the Lea	ast Significa	nt Byte of th	ie 16-bit Tl	MR1 Regis	ster	xxxx	xxxx	uuuu	uuuu
0Fh	TMR1H	Holding	Registe	r for the Mo	st Significar	nt Byte of the	e 16-bit TN	/IR1 Regis	ter	xxxx	xxxx	uuuu	uuuu
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00	0000	uu	uuuu
15h	CCPR1L	Capture	/Compa	re/PWM Re	gister1 (LSE	3)				xxxx	xxxx	uuuu	uuuu
16h	CCPR1H	Capture	Capture/Compare/PWM Register1 (MSB)								xxxx	uuuu	uuuu
17h	CCP1CON	_	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00	0000	00	0000

Note 1: These bits are reserved; always maintain clear.

8.3 PWM Mode (PWM)

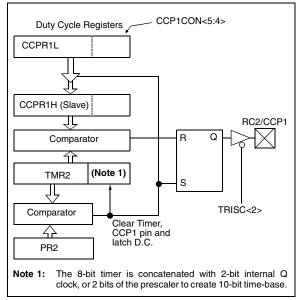
In Pulse Width Modulation mode, the CCP1 pin produces up to a 10-bit resolution PWM output. Since the CCP1 pin is multiplexed with the PORTC data latch, the TRISC<2> bit must be cleared to make the CCP1 pin an output.

Note:	Clearing the CCP1CON register will force the CCP1 PWM output latch to the default
	low level. This is not the PORTC I/O data latch.

Figure 8-3 shows a simplified block diagram of the CCP module in PWM mode.

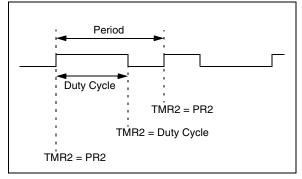
For a step-by-step procedure on how to set up the CCP module for PWM operation, see Section 8.3.3.

FIGURE 8-3: SIMPLIFIED PWM BLOCK DIAGRAM



A PWM output (Figure 8-4) has a time-base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).





8.3.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following formula:

PWM frequency is defined as 1 / [PWM period].

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The CCP1 pin is set (exception: if PWM duty cycle = 0%, the CCP1 pin will not be set)
- The PWM duty cycle is latched from CCPR1L into CCPR1H

Note:	The Timer2 postscaler (see Section 7.1) is								
	not used in the determination of the PWM								
	frequency. The postscaler could be us								
	frequency. The postscaler could be use to have a servo update rate at a different								
	frequency than the PWM output.								

8.3.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR1L register and to the CCP1CON<5:4> bits. Up to 10-bit resolution is available. The CCPR1L contains the eight MSbs and the CCP1CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR1L:CCP1CON<5:4>. The following equation is used to calculate the PWM duty cycle in time:

CCPR1L and CCP1CON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPR1H until after a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR1H is a read only register.

The CCPR1H register and a 2-bit internal latch are used to double buffer the PWM duty cycle. This double buffering is essential for glitch-free PWM operation.

When the CCPR1H and 2-bit latch match TMR2, concatenated with an internal 2-bit Q clock or 2 bits of the TMR2 prescaler, the CCP1 pin is cleared.

The maximum PWM resolution (bits) for a given PWM frequency is given by the formula:

Resolution =
$$\frac{\log(\frac{Fosc}{FPWM})}{\log(2)}$$
 bits

Note: If the PWM duty cycle value is longer than the PWM period, the CCP1 pin will not be cleared.

8.3.3 SETUP FOR PWM OPERATION

The following steps should be taken when configuring the CCP module for PWM operation:

- 1. Set the PWM period by writing to the PR2 register.
- 2. Set the PWM duty cycle by writing to the CCPR1L register and CCP1CON<5:4> bits.
- 3. Make the CCP1 pin an output by clearing the TRISC<2> bit.
- 4. Set the TMR2 prescale value and enable Timer2 by writing to T2CON.
- 5. Configure the CCP1 module for PWM operation.

TABLE 8-3: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 20 MHz

PWM Frequency	1.22 kHz	4.88 kHz	19.53 kHz	78.12kHz	156.3 kHz	208.3 kHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	FFh	FFh	FFh	3Fh	1Fh	17h
Maximum Resolution (bits)	10	10	10	8	7	5.5

TABLE 8-4: REGISTERS ASSOCIATED WITH PWM AND TIMER2

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR		Value on all other RESETS	
0Bh,8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	(1)	ADIF	(1)	(1)	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000	0000	0000
8Ch	PIE1	(1)	ADIE	(1)	(1)	SSPIE	CCP1IE	TMR2IE	TMR1IE	r0rr	0000	0000	0000
87h	TRISC	PORTO	Data Direct	ion Registe	r					1111	1111	1111	1111
11h	TMR2	Timer2	Modules Reg	gister						0000	0000	0000	0000
92h	PR2	Timer2	Module Peri	od Register						1111	1111	1111	1111
12h	T2CON		TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000	0000	-000	0000
15h	CCPR1L	Capture	e/Compare/P	WM Regist	er1 (LSB)					xxxx	xxxx	uuuu	uuuu
16h	CCPR1H	Capture	Capture/Compare/PWM Register1 (MSB)								xxxx	uuuu	uuuu
17h	CCP1CON	_	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00	0000	00	0000

Note 1: These bits are reserved; always maintain clear.

NOTES:

9.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP) MODULE

The Master Synchronous Serial Port (MSSP) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D converters, etc. The MSSP module can operate in one of two modes:

- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I²C)

The operation of the module in SPI mode is discussed in greater detail in Section 9.1. The operations of the module in the the various I^2C modes are covered in Section 9.2, while special considerations for connecting the I^2C bus are discussed in Section 9.3. The MSSP module is controlled by three special function registers:

- SSPSTAT
- SSPCON
- SSPCON2

The SSPSTAT and SSPCON registers are used in both SPI and I^2C modes; their individual bits take on different functions depending on the mode selected. The SSPCON2 register, on the other hand, is associated only with I^2C operations. The registers are detailed in Registers 9-1 through 9-3 on the following pages.

SSPSTAT: SYNC SERIAL PORT STATUS REGISTER (ADDRESS: 94h) **REGISTER 9-1:** R/W-0 R/W-0 R-0 R-0 R-0 R-0 R-0 R-0 SMP CKE D/A Ρ S R/W UA BF bit 7 bit 0 bit 7 SMP: Sample bit SPI Master mode: 1 = Input data sampled at end of data output time 0 = Input data sampled at middle of data output time SPI Slave mode: SMP must be cleared when SPI is used in Slave mode In I²C Master or Slave mode: 1= Slew rate control disabled for Standard Speed mode (100 kHz and 1 MHz) 0= Slew rate control enabled for High Speed mode (400 kHz) bit 6 CKE: SPI Clock Edge Select bit (Figure 9-2, Figure 9-3 and Figure 9-4) SPI mode: For CKP = 01 = Transmit happens on transition from active clock state to idle clock state 0 = Transmit happens on transition from idle clock state to active clock state For CKP = 11 = Data transmitted on falling edge of SCK 0 = Data transmitted on rising edge of SCK In I²C Master or Slave mode: 1 = Input levels conform to SMBus spec 0 = Input levels conform to I²C specs bit 5 **D/A**: Data/Address bit (I²C mode only) 1 = Indicates that the last byte received or transmitted was data 0 = Indicates that the last byte received or transmitted was address bit 4 P: STOP bit (I²C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.) 1 = Indicates that a STOP bit has been detected last (this bit is '0' on RESET) 0 = STOP bit was not detected last bit 3 S: START bit (I²C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.) 1 = Indicates that a START bit has been detected last (this bit is '0' on RESET) 0 = START bit was not detected last bit 2 **R/W**: Read/Write bit information (I²C mode only) This bit holds the R/W bit information following the last address match. This bit is only valid from the address match to the next START bit, STOP bit or not ACK bit. In I²C Slave mode: 1 = Read0 = Write In I²C Master mode: 1 = Transmit is in progress 0 = Transmit is not in progress. Logical OR of this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSP is in IDLE mode. bit 1 **UA**: Update Address bit (10-bit I²C mode only) 1 = Indicates that the user needs to update the address in the SSPADD register 0 = Address does not need to be updated bit 0 BF: Buffer Full Status bit Receive (SPI and I²C modes): 1 = Receive complete, SSPBUF is full 0 = Receive not complete, SSPBUF is empty Transmit (I²C mode only): 1 = Data Transmit in progress (does not include the ACK and STOP bits), SSPBUF is full 0 = Data Transmit complete (does not include the ACK and STOP bits), SSPBUF is empty

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

REGISTER 9-2: SSPCON: SYNC SERIAL PORT CONTROL REGISTER (ADDRESS: 14h) **R/W-0** R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 WCOL SSPOV SSPEN CKP SSPM3 SSPM2 SSPM1 SSPM0 bit 7 bit 0 bit 7 WCOL: Write Collision Detect bit Master mode: 1 = A write to SSPBUF was attempted while the I²C conditions were not valid 0 = No collision Slave mode: 1 = SSPBUF register is written while still transmitting the previous word (must be cleared in software) 0 = No collision bit 6 SSPOV: Receive Overflow Indicator bit In SPI mode: 1 = A new byte is received while SSPBUF holds previous data. Data in SSPSR is lost on overflow. In Slave mode, the user must read the SSPBUF, even if only transmitting data, to avoid overflows. In Master mode, the overflow bit is not set since each operation is initiated by writing to the SSPBUF register. (Must be cleared in software.) 0 = No overflow In I²C mode: 1 = A byte is received while the SSPBUF is holding the previous byte. SSPOV is a "don't care" in Transmit mode. (Must be cleared in software.) 0 = No overflow bit 5 SSPEN: Synchronous Serial Port Enable bit In SPI mode: When enabled, these pins must be properly configured as input or output. 1 = Enables serial port and configures SCK, SDO, SDI, and \overline{SS} as the source of the serial port pins 0 = Disables serial port and configures these pins as I/O port pins In I²C mode: When enabled, these pins must be properly configured as input or output. 1 = Enables the serial port and configures the SDA and SCL pins as the source of the serial port pins 0 = Disables serial port and configures these pins as I/O port pins bit 4 CKP: Clock Polarity Select bit In SPI mode: 1 = IDLE state for clock is a high level 0 = IDLE state for clock is a low level In I²C slave mode: SCK release control 1 = Enable clock 0 = Holds clock low (clock stretch). (Used to ensure data setup time.) In I²C master mode: Unused in this mode bit 3-0 SSPM3:SSPM0: Synchronous Serial Port Mode Select bits 0000 = SPI Master mode, clock = Fosc/4 0001 = SPI Master mode, clock = Fosc/16 0010 = SPI Master mode, clock = Fosc/64 0011 = SPI Master mode, clock = TMR2 output/2 0100 = SPI Slave mode, clock = SCK pin. SS pin control enabled.<math>0101 = SPI Slave mode, clock = SCK pin. SS pin control disabled. SS can be used as I/O pin. $0110 = I^2C$ Slave mode, 7-bit address $0111 = I^2C$ Slave mode, 10-bit address $1000 = I^2C$ Master mode, clock = Fosc / (4 * (SSPADD+1)) $1011 = I^2C$ Firmware Controlled Master mode (slave idle) 1110 = I²C Firmware Controlled Master mode, 7-bit address with START and STOP bit interrupts enabled $1111 = I^2C$ Firmware Controlled Master mode, 10-bit address with START and STOP bit interrupts enabled 1001, 1010, 1100, 1101 = reserved

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented b	it, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

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TER 9-3:	SSPCON2	2: SYNC SEF	RIAL POR	T CONTRO	LREGIST	ER2 (ADD	RESS: 91	h)				
	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN				
	bit 7							bit 0				
bit 7		neral Call Ena	-									
		interrupt whe	-	I call address	s (0000h) is	received in	the SSPSF	2				
0 = General call address disabled												
bit 6	ACKSTAT: Acknowledge Status bit (In I ² C Master mode only)											
	In Master Transmit mode: 1 = Acknowledge was not received from slave											
		wledge was no wledge was re										
bit 5		cknowledge D		-	ode only)							
DIL D		Receive mode			oue only)							
		will be transm		the user initi	ates an Δcl	(nowledge (sequence at	t the end of				
	a receive.	will be transm			ales an Aci	(nownedge (sequence a					
	1 = Not Ac	knowledge										
	0 = Acknow	•										
bit 4	ACKEN: A	cknowledge S	equence E	nable bit (In	I ² C Master	mode only)						
	In Master Receive mode:											
	matical	Acknowledge	hardware.	on SDA and	SCL pins, a	ind transmit	ACKDT dat	ta bit. Auto-				
		wledge sequer										
bit 3		ceive Enable I	•	laster mode	only).							
	1 = Enable 0 = Receiv	es Receive mo re IDLE	de for l ² C									
bit 2	PEN: STO	P Condition E	nable bit (I	n I ² C Master	r mode only)						
	<u>SCK Relea</u>	<u>ase Control:</u>										
		STOP conditi condition IDLE		and SCL pir	ns. Automat	ically cleare	ed by hardwa	are.				
bit 1	RSEN: Re	peated STAR	T Condition	Enabled bit	(In I ² C Mas	ster mode o	nly)					
		Repeated ST						d by				
	hardwa			_								
	-	ted START co										
bit 0		RT Condition		·		• ·						
	0 = START	START condi	.E			-						
	1	For bits ACKE mode, this bit writes to the S	may not be	set (no spoo								
	Legend:											
	R = Reada	ble bit	W = Wr	itable bit	U = Unim	plemented I	oit, read as '	0'				
	- n = Value	at POR	'1' = Bit	is set	'0' = Bit is	cleared	x = Bit is u	nknown				

9.1 SPI Mode

The SPI mode allows 8 bits of data to be synchronously transmitted and received, simultaneously. All four modes of SPI are supported. To accomplish communication, typically three pins are used:

- Serial Data Out (SDO)
- Serial Data In (SDI)
- Serial Clock (SCK)

Additionally, a fourth pin may be used when in a Slave mode of operation:

• Slave Select (SS)

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSPCON<5:0> and SSPSTAT<7:6>). These control bits allow the following to be specified:

- Master mode (SCK is the clock output)
- Slave mode (SCK is the clock input)
- Clock Polarity (IDLE state of SCK)
- Data input sample phase (middle or end of data output time)
- Clock edge (output data on rising/falling edge of SCK)
- Clock Rate (Master mode only)
- Slave Select mode (Slave mode only)

Figure 9-4 shows the block diagram of the MSSP module when in SPI mode.

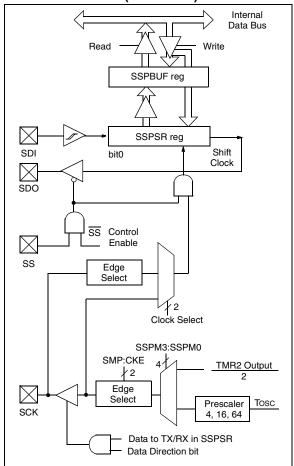
To enable the serial port, MSSP Enable bit, SSPEN (SSPCON<5>) must be set. To reset or reconfigure SPI mode, clear bit SSPEN, re-initialize the SSPCON registers, and then set bit SSPEN. This configures the SDI, SDO, SCK and SS pins as serial port pins. For the pins to behave as the serial port function, some must have their data direction bits (in the TRIS register) appropriately programmed. That is:

- SDI is automatically controlled by the SPI module
- SDO must have TRISC<5> cleared
- SCK (Master mode) must have TRISC<3> cleared
- SCK (Slave mode) must have TRISC<3> set
- SS must have TRISA<5> set, and
- Register ADCON1 must be set in a way that pin RA5 is configured as a digital I/O

Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value.

FIGURE 9-1:

MSSP BLOCK DIAGRAM (SPI MODE)



9.1.1 MASTER MODE

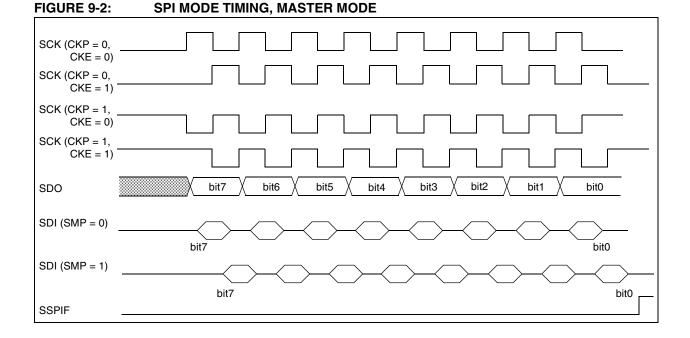
The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave (Processor 2, Figure 9-5) is to broad-cast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI module is only going to receive, the SDO output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a "line activity monitor". The clock polarity is selected by appropriately programming bit CKP (SSPCON<4>). This, then, would give waveforms for SPI communication as shown in Figure 9-6, Figure 9-8 and Figure 9-9, where the MSb is transmitted first. In Master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- Fosc/4 (or Tcy)
- Fosc/16 (or 4 Tcy)
- Fosc/64 (or 16 Tcy)
- Timer2 Output/2

This allows a maximum bit clock frequency (at 20 MHz) of 5.0 MHz.

Figure 9-6 shows the waveforms for Master mode. When CKE = 1, the SDO data is valid before there is a clock edge on SCK. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPBUF is loaded with the received data is shown.

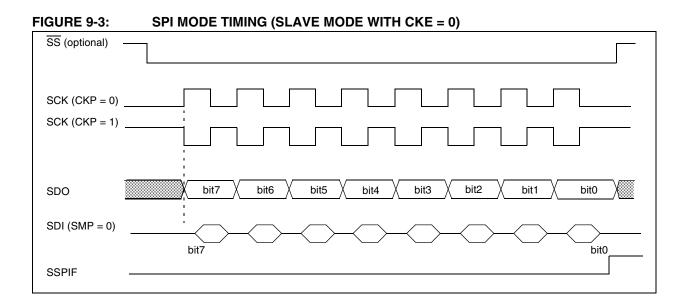


9.1.2 SLAVE MODE

In Slave mode, the data is transmitted and received as the external clock pulses appear on SCK. When the last bit is latched, the interrupt flag bit SSPIF (PIR1<3>) is set.

While in Slave mode, the external clock is supplied by the external clock source on the SCK pin. This external clock must meet the minimum high and low times, as specified in the electrical specifications. While in SLEEP mode, the slave can transmit/receive data. When a byte is received, the device will wake-up from SLEEP.

- Note 1: When the SPI module is in Slave mode with SS pin control enabled (SSPCON<3:0> = 0100), the SPI module will reset if the SS pin is set to VDD.
 - **2:** If the SPI is used in Slave mode with CKE = '1', then \overline{SS} pin control must be enabled.





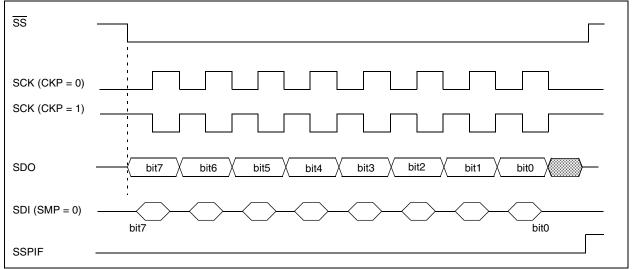


TABLE 9-1: REGISTERS ASSOCIATED WITH SPI OPERATION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
0Bh, 8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	(1)	ADIF	(1)	(1)	SSPIF	CCP1IF	TMR2IF	TMR1IF	r0rr 0000	0000 0000
8Ch	PIE1	(1)	ADIE	(1)	(1)	SSPIE	CCP1IE	TMR2IE	TMR1IE	r0rr 0000	0000 0000
13h	SSPBUF	Synchrono	ous Serial	Port Rece	ive Buf	fer/Transr	nit Registe	r		xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
94h	SSPSTAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000 0000	0000 0000

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the SSP in SPI mode. Note 1: These bits are reserved; always maintain these bits clear.

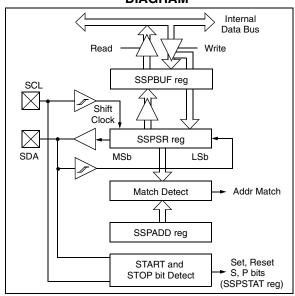
9.2 MSSP I²C Operation

The MSSP module in I²C mode, fully implements all master and slave functions (including general call support) and provides interrupts on START and STOP bits in hardware to determine a free bus (multi-master function). The MSSP module implements the standard mode specifications, as well as 7-bit and 10-bit addressing.

Refer to Application Note (AN578), "Use of the SSP Module in the I^2C Multi-Master Environment."

A "glitch" filter is on the SCL and SDA pins when the pin is an input. This filter operates in both the 100 kHz and 400 kHz modes. In the 100 kHz mode, when these pins are an output, there is a slew rate control of the pin that is independent of device frequency.

FIGURE 9-5: I²C SLAVE MODE BLOCK DIAGRAM



Two pins are used for data transfer. These are the SCL pin, which is the clock, and the SDA pin, which is the data. The SDA and SCL pins are automatically configured when the l^2C mode is enabled. The SSP module functions are enabled by setting SSP Enable bit SSPEN (SSPCON<5>).

The MSSP module has six registers for ${\rm I}^2{\rm C}$ operation. They are the:

- SSP Control Register (SSPCON)
- SSP Control Register2 (SSPCON2)
- SSP Status Register (SSPSTAT)
- Serial Receive/Transmit Buffer (SSPBUF)
- SSP Shift Register (SSPSR) Not directly accessible
- SSP Address Register (SSPADD)

The SSPCON register allows control of the I^2C operation. Four mode selection bits (SSPCON<3:0>) allow one of the following I^2C modes to be selected:

- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Master mode, clock = OSC/4 (SSPADD +1)

Before selecting any I^2C mode, the SCL and SDA pins must be programmed to inputs by setting the appropriate TRIS bits. Selecting an I^2C mode by setting the SSPEN bit, enables the SCL and SDA pins to be used as the clock and data lines in I^2C mode. Pull-up resistors must be provided externally to the SCL and SDA pins for the proper operation of the I^2C module.

The CKE bit (SSPSTAT<6:7>) sets the levels of the SDA and SCL pins in either Master or Slave mode. When CKE = 1, the levels will conform to the SMBus specification. When CKE = 0, the levels will conform to the l^2C specification.

The SSPSTAT register gives the status of the data transfer. This information includes detection of a START (S) or STOP (P) bit, specifies if the received byte was data or address, if the next byte is the completion of 10-bit address, and if this will be a read or write data transfer.

SSPBUF is the register to which the transfer data is written to or read from. The SSPSR register shifts the data in or out of the device. In receive operations, the SSPBUF and SSPSR create a doubled buffered receiver. This allows reception of the next byte to begin before reading the last byte of received data. When the complete byte is received, it is transferred to the SSPBUF register and flag bit SSPIF is set. If another complete byte is received before the SSPBUF register is read, a receiver overflow has occurred and bit SSPOV (SSPCON<6>) is set and the byte in the SSPSR is lost.

The SSPADD register holds the slave address. In 10-bit mode, the user needs to write the high byte of the address (1111 0 A9 A8 0). Following the high byte address match, the low byte of the address needs to be loaded (A7:A0).

9.2.1 SLAVE MODE

In Slave mode, the SCL and SDA pins must be configured as inputs. The MSSP module will override the input state with the output data when required (slavetransmitter).

When an address is matched, or the data transfer after an address match is received, the hardware automatically will generate the Acknowledge (\overline{ACK}) pulse, and then load the SSPBUF register with the received value currently in the SSPSR register. There are certain conditions that will cause the MSSP module not to give this $\overline{\text{ACK}}$ pulse. These are if either (or both):

- a) The buffer full bit BF (SSPSTAT<0>) was set before the transfer was received.
- b) The overflow bit SSPOV (SSPCON<6>) was set before the transfer was received.

If the BF bit is set, the SSPSR register value is not loaded into the SSPBUF, but bit SSPIF and SSPOV are set. Table 9-2 shows what happens when a data transfer byte is received, given the status of bits BF and SSPOV. The shaded cells show the condition where user software did not properly clear the overflow condition. Flag bit BF is cleared by reading the SSPBUF register, while bit SSPOV is cleared through software.

The SCL clock input must have a minimum high and low time for proper operation. The high and low times of the I^2C specification, as well as the requirement of the MSSP module, is shown in timing parameter #100 and parameter #101 of the electrical specifications.

9.2.1.1 Addressing

Once the MSSP module has been enabled, it waits for a START condition to occur. Following the START condition, the 8-bits are shifted into the SSPSR register. All incoming bits are sampled with the rising edge of the clock (SCL) line. The value of register SSPSR<7:1> is compared to the value of the SSPADD register. The address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match, and the BF and SSPOV bits are clear, the following events occur:

- The SSPSR register value is loaded into the SSPBUF register on the falling edge of the 8th SCL pulse.
- b) The buffer full bit, BF, is set on the falling edge of the 8th SCL pulse.
- c) An \overline{ACK} pulse is generated.
- d) SSP interrupt flag bit, SSPIF (PIR1<3>), is set (interrupt is generated if enabled) on the falling edge of the 9th SCL pulse.

In 10-bit Address mode, two address bytes need to be received by the slave. The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. Bit R/\overline{W} (SSPSTAT<2>) must specify a write, so the slave device will receive the second address byte. For a 10-bit address the first byte would equal '1111 0 A9 A8 0', where A9 and A8 are the two MSbs of the address. The sequence of events for a 10-bit address is as follows, with steps 7-9 for slave transmitter:

- 1. Receive first (high) byte of Address (bits SSPIF, BF and UA (SSPSTAT<1>) are set).
- 2. Update the SSPADD register with the second (low) byte of Address (clears bit UA and releases the SCL line).
- 3. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- 4. Receive second (low) byte of Address (bits SSPIF, BF and UA are set).
- 5. Update the SSPADD register with the first (high) byte of Address. This will clear bit UA and release the SCL line.
- 6. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- 7. Receive Repeated START condition.
- 8. Receive first (high) byte of Address (bits SSPIF and BF are set).
- 9. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.

Note:	Following the Repeated START condition (step 7) in 10-bit mode, the user only needs to match the first 7-bit address. The user does not update the SSPADD for the
	second half of the address.

9.2.1.2 Slave Reception

When the R/\overline{W} bit of the address byte is clear and an address match occurs, the R/\overline{W} bit of the SSPSTAT register is cleared. The received address is loaded into the SSPBUF register.

When the address <u>byte</u> overflow condition exists, then no Acknowledge (ACK) pulse is given. An overflow condition is defined as either bit BF (SSPSTAT<0>) is set, or bit SSPOV (SSPCON<6>) is set. This is an error condition due to user firmware.

An SSP interrupt is generated for each data transfer byte. Flag bit SSPIF (PIR1<3>) must be cleared in software. The SSPSTAT register is used to determine the status of the received byte.

Note: The SSPBUF will be loaded if the SSPOV bit is set and the BF flag is cleared. If a read of the SSPBUF was performed, but the user did not clear the state of the SSPOV bit before the next receive occurred, the ACK is not sent and the SSPBUF is updated.

Status Bits as Data Transfer is Received				Set bit SSPIF			
BF	SSPOV	$SSPSR \to SSPBUF$	Generate ACK Pulse	(SSP Interrupt occurs if enabled)			
0	0	Yes	Yes	Yes			
1	0	No	No	Yes			
1	1	No	No	Yes			
0	1	Yes	No	Yes			

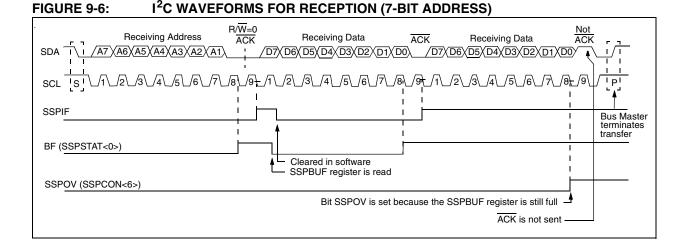
TABLE 9-2:DATA TRANSFER RECEIVED BYTE ACTIONS

Note: Shaded cells show the conditions where the user software did not properly clear the overflow condition.

9.2.1.3 Slave Transmission

When the R/W bit of the incoming address byte is set and an address match occurs, the R/W bit of the SSPSTAT register is set. The received address is loaded into the SSPBUF register. The ACK pulse will be sent on the ninth bit, and the SCL pin is held low. The transmit data must be loaded into the SSPBUF register, which also loads the SSPSR register. Then the SCL pin should be enabled by setting bit CKP (SSPCON<4>). The master must monitor the SCL pin prior to asserting another clock pulse. The slave devices may be holding off the master by stretching the clock. The eight data bits are shifted out on the falling edge of the SCL input. This ensures that the SDA signal is valid during the SCL high time (Figure 9-7). An SSP interrupt is generated for each data transfer byte. The SSPIF flag bit must be cleared in software and the SSPSTAT register is used to determine the status of the byte transfer. The SSPIF flag bit is set on the falling edge of the ninth clock pulse.

As a slave-transmitter, the \overline{ACK} pulse from the master receiver is latched on the rising edge of the ninth SCL input pulse. If the SDA line is high (Not \overline{ACK}), then the data transfer is complete. When the Not \overline{ACK} is latched by the slave, the slave logic is reset and the slave then monitors for another occurrence of the START bit. If the SDA line was low (\overline{ACK}), the transmit data must be loaded into the SSPBUF register, which also loads the SSPSR register. Then, the SCL pin should be enabled by setting the CKP bit.



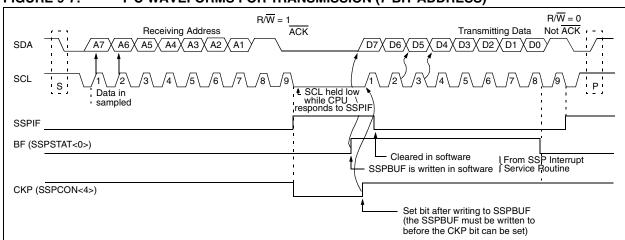


FIGURE 9-7: I²C WAVEFORMS FOR TRANSMISSION (7-BIT ADDRESS)

9.2.2 GENERAL CALL ADDRESS SUPPORT

The addressing procedure for the I^2C bus is such that the first byte after the START condition usually determines which device will be the slave addressed by the master. The exception is the general call address, which can address all devices. When this address is used, all devices should, in theory, respond with an Acknowledge.

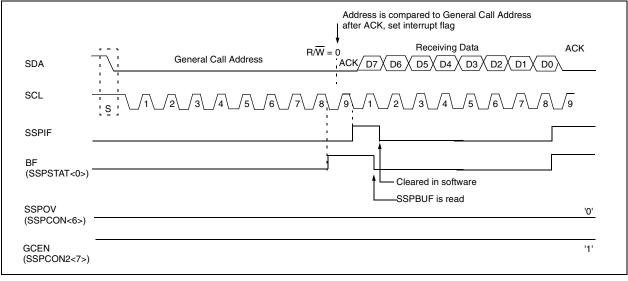
The general call address is one of eight addresses reserved for specific purposes by the I²C protocol. It consists of all 0's with R/W = 0.

The general call address is recognized when the General Call Enable bit (GCEN) is enabled (SSPCON2<7> is set). Following a START bit detect, 8-bits are shifted into SSPSR and the address is compared against SSPADD. It is also compared to the general call address and fixed in hardware. If the general call address matches, the SSPSR is transferred to the SSPBUF, the BF flag is set (eighth bit), and on the falling edge of the ninth bit (ACK bit), the SSPIF flag is set.

When the interrupt is serviced, the source for the interrupt can be checked by reading the contents of the SSPBUF, to determine if the address was device specific or a general call address.

In 10-bit mode, the SSPADD is required to be updated for the second half of the address to match, and the UA bit is set (SSPSTAT<1>). If the general call address is sampled when GCEN is set while the slave is configured in 10-bit Address mode, then the second half of the address is not necessary, the UA bit will not be set, and the slave will begin receiving data after the Acknowledge (Figure 9-8).





9.2.3 SLEEP OPERATION

While in SLEEP mode, the I^2C module can receive addresses or data. When an address match or complete byte transfer occurs, wake the processor from SLEEP (if the SSP interrupt is enabled).

9.2.4 EFFECTS OF A RESET

A RESET disables the SSP module and terminates the current transfer.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 PC		Value on: POR, BOR		POR,		POR, a		e on other ETS
0Bh, 8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000	000x	0000	000u				
0Ch	PIR1	(1)	ADIF	(1)	(1)	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000	0000	0000				
8Ch	PIE1	(1)	ADIE	(1)	(1)	SSPIE	CCP1IE	TMR2IE	TMR1IE	r0rr	0000	0000	0000				
0Dh	PIR2	—	(1)	_	EEIF	BCLIF	—	(1)	CCP2IF	-r-0	0 0	-r-0	0 0				
8Dh	PIE2	—	(1)	_	EEIE	BCLIE	—	(1)	CCP2IE	-r-0	0r	-r-0	0r				
13h	SSPBUF	3UF Synchronous Serial Port Receive Buffer/Transmit Register								xxxx	xxxx	uuuu	uuuu				
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000	0000	0000	0000				
91h	SSPCON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000	0000	0000	0000				
94h	SSPSTAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000	0000	0000	0000				

TABLE 9-3: REGISTERS ASSOCIATED WITH I²C OPERATION

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by the SSP in I²C mode. Note 1: These bits are reserved; always maintain these bits clear.

9.2.5 MASTER MODE

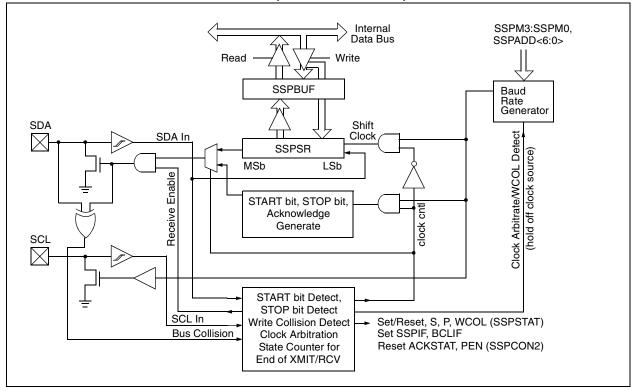
Master mode of operation is supported by interrupt generation on the detection of the START and STOP conditions. The STOP (P) and START (S) bits are cleared from a RESET or when the MSSP module is disabled. Control of the I^2C bus may be taken when the P bit is set, or the bus is IDLE, with both the S and P bits clear.

In Master mode, the SCL and SDA lines are manipulated by the MSSP hardware.

The following events will cause the SSP Interrupt Flag bit, SSPIF, to be set (an SSP Interrupt will occur if enabled):

- START condition
- STOP condition
- · Data transfer byte transmitted/received
- Acknowledge transmit
- Repeated START

FIGURE 9-9: SSP BLOCK DIAGRAM (I²C MASTER MODE)



9.2.6 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the START and STOP conditions allows the determination of when the bus is free. The STOP (P) and START (S) bits are cleared from a RESET or when the MSSP module is disabled. Control of the I²C bus may be taken when bit P (SSPSTAT<4>) is set, or the bus is IDLE with both the S and P bits clear. When the bus is busy, enabling the SSP interrupt will generate the interrupt when the STOP condition occurs.

In Multi-Master operation, the SDA line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed in hardware, with the result placed in the BCLIF bit. The states where arbitration can be lost are:

- Address Transfer
- Data Transfer
- A START Condition
- A Repeated START Condition
- An Acknowledge Condition

9.2.7 I²C MASTER MODE SUPPORT

Master mode is enabled by setting and clearing the appropriate SSPM bits in SSPCON and by setting the SSPEN bit. Once Master mode is enabled, the user has six options.

- · Assert a START condition on SDA and SCL.
- Assert a Repeated START condition on SDA and SCL.
- Write to the SSPBUF register, initiating transmission of data/address.
- Generate a STOP condition on SDA and SCL.
- Configure the I²C port to receive data.
- Generate an Acknowledge condition at the end of a received byte of data.
 - **Note:** The MSSP module, when configured in I²C Master mode, does not allow queueing of events. For instance, the user is not allowed to initiate a START condition and immediately write the SSPBUF register to initiate transmission, before the START condition is complete. In this case, the SSPBUF will not be written to and the WCOL bit will be set, indicating that a write to the SSPBUF did not occur.

9.2.7.1 I²C Master Mode Operation

The master device generates all of the serial clock pulses and the START and STOP conditions. A transfer is ended with a STOP condition or with a Repeated START condition. Since the Repeated START condition is also the beginning of the next serial transfer, the l^2C bus will not be released.

In Master Transmitter mode, serial data is output through SDA, while SCL outputs the serial clock. The first byte transmitted contains the slave address of the receiving device (7 bits) and the Read/Write (R/\overline{W}) bit. In this case, the R/\overline{W} bit will be logic '0'. Serial data is transmitted 8 bits at a time. After each byte is transmitted, an Acknowledge bit is received. START and STOP conditions are output to indicate the beginning and the end of a serial transfer.

In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the R/W bit. In this case, the R/W bit will be logic '1'. Thus, the first byte transmitted is a 7-bit slave address followed by a '1' to indicate receive bit. Serial data is received via SDA, while SCL outputs the serial clock. Serial data is received 8 bits at a time. After each byte is received, an Acknowledge bit is transmitted. START and STOP conditions indicate the beginning and end of transmission.

The baud rate generator used for SPI mode operation is now used to set the SCL clock frequency for either 100 kHz, 400 kHz or 1 MHz I^2C operation. The baud rate generator reload value is contained in the lower 7 bits of the SSPADD register. The baud rate generator will automatically begin counting on a write to the SSPBUF. Once the given operation is complete (i.e., transmission of the last data bit is followed by ACK) the internal clock will automatically stop counting and the SCL pin will remain in its last state

A typical transmit sequence would go as follows:

- a) The user generates a Start Condition by setting the START enable bit (SEN) in SSPCON2.
- b) SSPIF is set. The module will wait the required start time before any other operation takes place.
- c) The user loads the SSPBUF with address to transmit.
- d) Address is shifted out the SDA pin until all 8 bits are transmitted.
- e) The MSSP module shifts in the ACK bit from the slave device and writes its value into the SSPCON2 register (SSPCON2<6>).
- f) The module generates an interrupt at the end of the ninth clock cycle by setting SSPIF.
- g) The user loads the SSPBUF with eight bits of data.
- h) DATA is shifted out the SDA pin until all 8 bits are transmitted.
- i) The MSSP module shifts in the ACK bit from the slave device, and writes its value into the SSPCON2 register (SSPCON2<6>).
- j) The MSSP module generates an interrupt at the end of the ninth clock cycle by setting the SSPIF bit.
- k) The user generates a STOP condition by setting the STOP enable bit PEN in SSPCON2.
- I) Interrupt is generated once the STOP condition is complete.

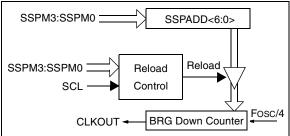
9.2.8 BAUD RATE GENERATOR

In I^2C Master mode, the reload value for the BRG is located in the lower 7 bits of the SSPADD register (Figure 9-10). When the BRG is loaded with this value, the BRG counts down to 0 and stops until another reload has taken place. The BRG count is decremented twice per instruction cycle (TCY), on the Q2 and Q4 clock.

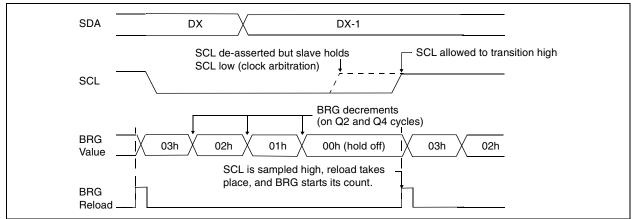
In I²C Master mode, the BRG is reloaded automatically. If Clock Arbitration is taking place, for instance, the BRG will be reloaded when the SCL pin is sampled high (Figure 9-11).

FIGURE 9-10:

BAUD RATE GENERATOR BLOCK DIAGRAM







9.2.9 I²C MASTER MODE START CONDITION TIMING

To initiate a START condition, the user sets the START condition enable bit, SEN (SSPCON2<0>). If the SDA and SCL pins are sampled high, the baud rate generator is reloaded with the contents of SSPADD<6:0> and starts its count. If SCL and SDA are both sampled high when the baud rate generator times out (TBRG), the SDA pin is driven low. The action of the SDA being driven low while SCL is high is the START condition, and causes the S bit (SSPSTAT<3>) to be set. Following this, the baud rate generator is reloaded with the contents of SSPADD<6:0> and resumes its count. When the baud rate generator times out (TBRG), the SEN bit (SSPCON2<0>) will be automatically cleared by hardware. The baud rate generator is suspended, leaving the SDA line held low, and the START condition is complete.

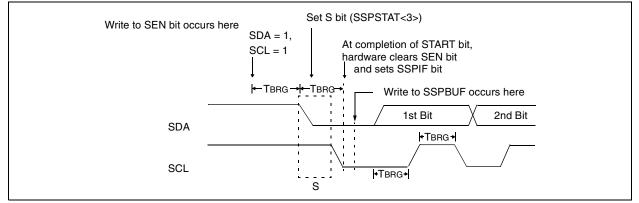
Note: If, at the beginning of START condition, the SDA and SCL pins are already sampled low, or if during the START condition, the SCL line is sampled low before the SDA line is driven low, a bus collision occurs, the Bus Collision Interrupt Flag (BCLIF) is set, the START condition is aborted, and the I²C module is reset into its IDLE state.

9.2.9.1 WCOL Status Flag

If the user writes the SSPBUF when a START sequence is in progress, then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing to the lower 5 bits of SSPCON2 is disabled until the START condition is complete.

FIGURE 9-12: FIRST START BIT TIMING



9.2.10 I²C MASTER MODE REPEATED START CONDITION TIMING

A Repeated START condition occurs when the RSEN bit (SSPCON2<1>) is programmed high and the I²C module is in the IDLE state. When the RSEN bit is set, the SCL pin is asserted low. When the SCL pin is sampled low, the baud rate generator is loaded with the contents of SSPADD<6:0> and begins counting. The SDA pin is released (brought high) for one baud rate generator count (TBRG). When the baud rate generator times out if SDA is sampled high, the SCL pin will be de-asserted (brought high). When SCL is sampled high, the baud rate generator is reloaded with the contents of SSPADD<6:0> and begins counting. SDA and SCL must be sampled high for one TBRG. This action is then followed by assertion of the SDA pin (SDA is low) for one TBRG, while SCL is high. Following this, the RSEN bit in the SSPCON2 register will be automatically cleared and the baud rate generator will not be reloaded, leaving the SDA pin held low. As soon as a START condition is detected on the SDA and SCL pins, the S bit (SSPSTAT<3>) will be set. The SSPIF bit will not be set until the baud rate generator has timed out.

- Note 1: If RSEN is programmed while any other event is in progress, it will not take effect.
 - 2: A bus collision during the Repeated START condition occurs if:
 - SDA is sampled low when SCL goes from low to high.
 - SCL goes low before SDA is asserted low. This may indicate that another master is attempting to transmit a data "1".

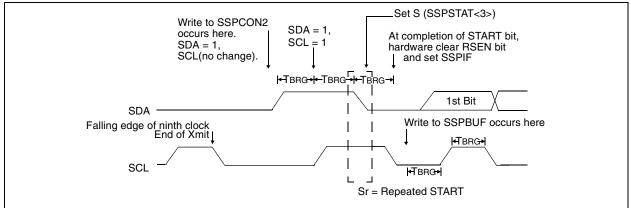
Immediately following the SSPIF bit getting set, the user may write the SSPBUF with the 7-bit address in 7-bit mode, or the default first address in 10-bit mode. After the first eight bits are transmitted and an ACK is received, the user may then transmit an additional eight bits of address (10-bit mode), or eight bits of data (7-bit mode).

9.2.10.1 WCOL Status Flag

If the user writes the SSPBUF when a Repeated START sequence is in progress, then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing of the lower 5 bits of SSPCON2 is disabled until the Repeated START condition is complete.

FIGURE 9-13: REPEAT START CONDITION WAVEFORM



9.2.11 I²C MASTER MODE TRANSMISSION

Transmission of a data byte, a 7-bit address, or either half of a 10-bit address, is accomplished by simply writing a value to SSPBUF register. This action will set the buffer full flag (BF) and allow the baud rate generator to begin counting and start the next transmission. Each bit of address/data will be shifted out onto the SDA pin after the falling edge of SCL is asserted (see data hold time spec). SCL is held low for one baud rate generator rollover count (TBRG). Data should be valid before SCL is released high (see data setup time spec). When the SCL pin is released high, it is held that way for TBRG. The data on the SDA pin must remain stable for that duration and some hold time after the next falling edge of SCL. After the eighth bit is shifted out (the falling edge of the eighth clock), the BF flag is cleared and the master releases SDA, allowing the slave device being addressed to respond with an ACK bit during the ninth bit time, if an address match occurs or if data was received properly. The status of ACK is read into the ACKDT on the falling edge of the ninth clock. If the master receives an Acknowledge, the Acknowledge status bit (ACKSTAT) is cleared. If not, the bit is set, After the ninth clock, the SSPIF is set and the master clock (baud rate generator) is suspended until the next data byte is loaded into the SSPBUF, leaving SCL low and SDA unchanged (Figure 9-14).

After the write to the SSPBUF, each bit of address will be shifted out on the falling edge of SCL, until all seven address bits and the R/W bit are completed. On the falling edge of the eighth clock, the master will de-assert the SDA pin allowing the slave to respond with an Acknowledge. On the falling edge of the ninth clock, the master will sample the SDA pin to see if the address was recognized by a slave. The status of the ACK bit is loaded into the ACKSTAT status bit (SSPCON2<6>). Following the falling edge of the ninth clock transmission of the address, the SSPIF is set, the BF flag is cleared, and the baud rate generator is turned off until another write to the SSPBUF takes place, holding SCL low and allowing SDA to float.

9.2.11.1 BF Status Flag

In Transmit mode, the BF bit (SSPSTAT<0>) is set when the CPU writes to SSPBUF and is cleared when all 8 bits are shifted out.

9.2.11.2 WCOL Status Flag

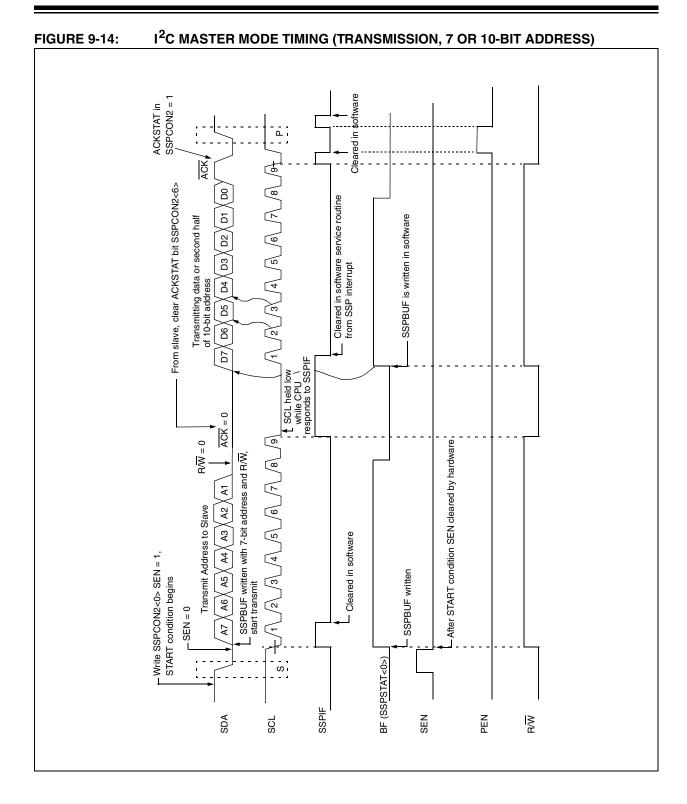
If the user writes the SSPBUF when a transmit is already in progress (i.e., SSPSR is still shifting out a data byte), then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

WCOL must be cleared in software.

9.2.11.3 ACKSTAT Status Flag

In Transmit mode, the ACKSTAT bit (SSPCON2<6>) is cleared when the slave has sent an Acknowledge $(\overline{ACK} = 0)$, and is set when the slave does Not Acknowledge $(\overline{ACK} = 1)$. A slave sends an Acknowledge when it has recognized its address (including a general call), or when the slave has properly received its data.

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9.2.12 I²C MASTER MODE RECEPTION

Master mode reception is enabled by programming the receive enable bit, RCEN (SSPCON2<3>).

Note: The SSP module must be in an IDLE state before the RCEN bit is set, or the RCEN bit will be disregarded.

The baud rate generator begins counting, and on each rollover, the state of the SCL pin changes (high to low/ low to high), and data is shifted into the SSPSR. After the falling edge of the eighth clock, the receive enable flag is automatically cleared, the contents of the SSPSR are loaded into the SSPBUF, the BF flag is set, the SSPIF is set, and the baud rate generator is suspended from counting, holding SCL low. The SSP is now in IDLE state, awaiting the next command. When the buffer is read by the CPU, the BF flag is automatically cleared. The user can then send an Acknowledge bit at the end of reception, by setting the Acknowledge sequence enable bit, ACKEN (SSPCON2<4>).

9.2.12.1 BF Status Flag

In receive operation, BF is set when an address or data byte is loaded into SSPBUF from SSPSR. It is cleared when SSPBUF is read.

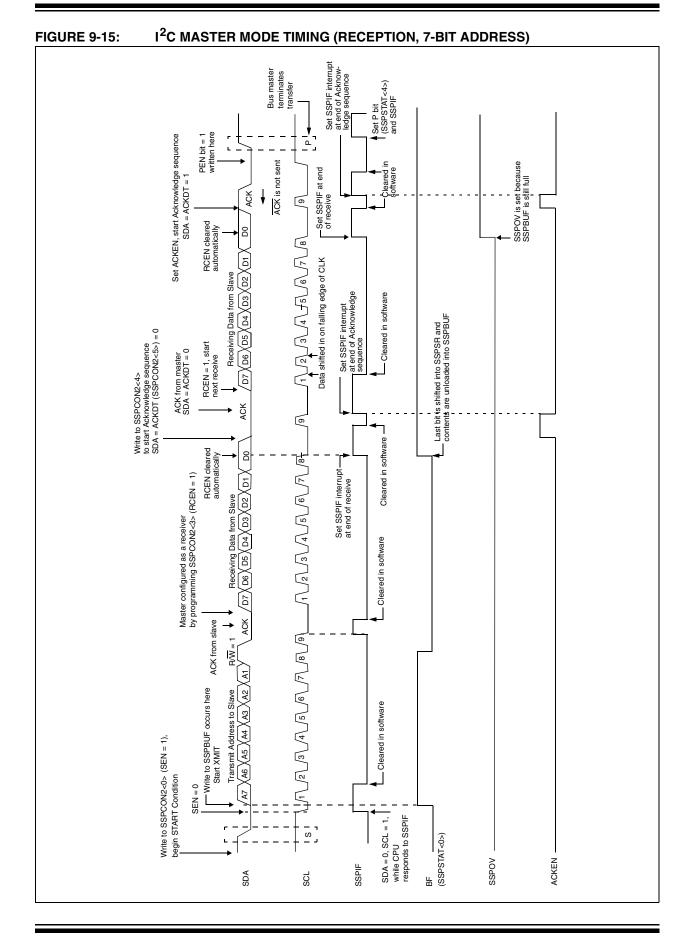
9.2.12.2 SSPOV Status Flag

In receive operation, SSPOV is set when 8 bits are received into the SSPSR, and the BF flag is already set from a previous reception.

9.2.12.3 WCOL Status Flag

If the user writes the SSPBUF when a receive is already in progress (i.e., SSPSR is still shifting in a data byte), then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

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9.2.13 ACKNOWLEDGE SEQUENCE TIMING

An Acknowledge sequence is enabled by setting the Acknowledge sequence enable bit, ACKEN (SSPCON2<4>). When this bit is set, the SCL pin is pulled low and the contents of the Acknowledge data bit are presented on the SDA pin. If the user wishes to generate an Acknowledge, the ACKDT bit should be cleared. If not, the user should set the ACKDT bit before starting an Acknowledge sequence. The baud rate generator then counts for one rollover period (TBRG), and the SCL pin is de-asserted high). When the SCL pin is

sampled high (clock arbitration), the baud rate generator counts for TBRG. The SCL pin is then pulled low. Following this, the ACKEN bit is automatically cleared, the baud rate generator is turned off, and the SSP module then goes into IDLE mode (Figure 9-16).

9.2.13.1 WCOL Status Flag

If the user writes the SSPBUF when an acknowledge sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

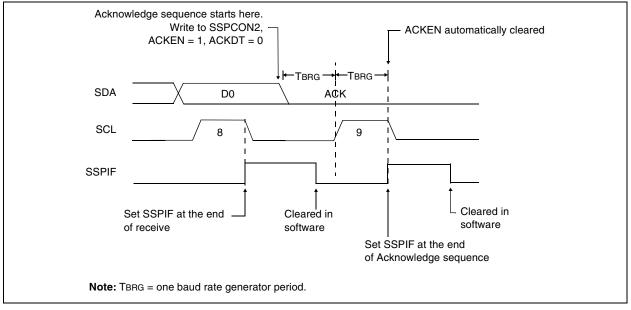


FIGURE 9-16: ACKNOWLEDGE SEQUENCE WAVEFORM

9.2.14 STOP CONDITION TIMING

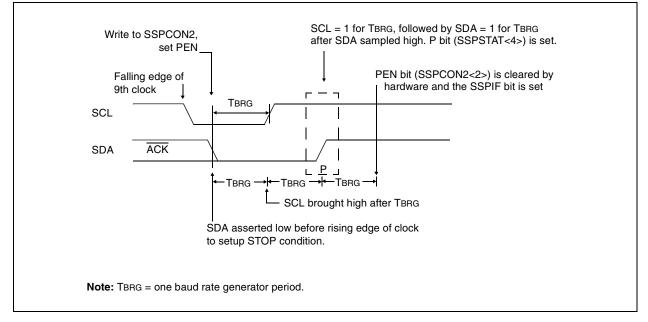
A STOP bit is asserted on the SDA pin at the end of a receive/transmit, by setting the Stop Sequence Enable bit PEN (SSPCON2<2>). At the end of a receive/ transmit, the SCL line is held low after the falling edge of the ninth clock. When the PEN bit is set, the master will assert the SDA line low. When the SDA line is sampled low, the baud rate generator is reloaded and counts down to 0. When the baud rate generator times out, the SCL pin will be brought high, and one TBRG (baud rate generator rollover count) later, the SDA pin will be de-asserted. When the SDA pin is sampled high while SCL is high, the P bit (SSPSTAT<4>) is set. A TBRG later, the PEN bit is cleared and the SSPIF bit is set (Figure 9-17).

Whenever the firmware decides to take control of the bus, it will first determine if the bus is busy by checking the S and P bits in the SSPSTAT register. If the bus is busy, then the CPU can be interrupted (notified) when a STOP bit is detected (i.e., bus is free).

9.2.14.1 WCOL Status Flag

If the user writes the SSPBUF when a STOP sequence is in progress, then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

FIGURE 9-17: STOP CONDITION RECEIVE OR TRANSMIT MODE



9.2.15 CLOCK ARBITRATION

Clock arbitration occurs when the master, during any receive, transmit, or Repeated START/STOP condition, de-asserts the SCL pin (SCL allowed to float high). When the SCL pin is allowed to float high, the baud rate generator (BRG) is suspended from counting until the SCL pin is actually sampled high. When the SCL pin is sampled high, the baud rate generator is reloaded with the contents of SSPADD<6:0> and begins counting. This ensures that the SCL high time will always be at least one BRG rollover count, in the event that the clock is held low by an external device (Figure 9-18).

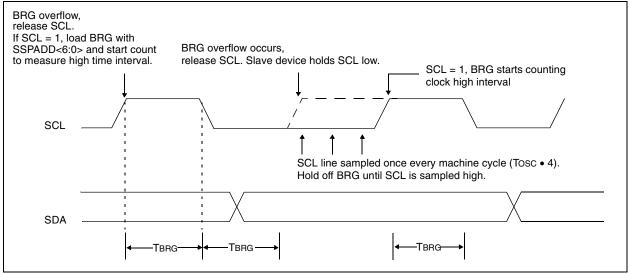
9.2.16 SLEEP OPERATION

While in SLEEP mode, the I²C module can receive addresses or data, and when an address match or complete byte transfer occurs, wake the processor from SLEEP (if the SSP interrupt is enabled).

9.2.17 EFFECTS OF A RESET

A RESET disables the SSP module and terminates the current transfer.

FIGURE 9-18: CLOCK ARBITRATION TIMING IN MASTER TRANSMIT MODE



9.2.18 MULTI -MASTER COMMUNICATION, BUS COLLISION, AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDA pin, arbitration takes place when the master outputs a '1' on SDA, by letting SDA float high and another master asserts a '0'. When the SCL pin floats high, data should be stable. If the expected data on SDA is a '1' and the data sampled on the SDA pin = '0', a bus collision has taken place. The master will set the Bus Collision Interrupt Flag, BCLIF and reset the I^2C port to its IDLE state. (Figure 9-19).

If a transmit was in progress when the bus collision occurred, the transmission is halted, the BF flag is cleared, the SDA and SCL lines are de-asserted, and the SSPBUF can be written to. When the user services the bus collision Interrupt Service Routine, and if the I^2C bus is free, the user can resume communication by asserting a START condition.

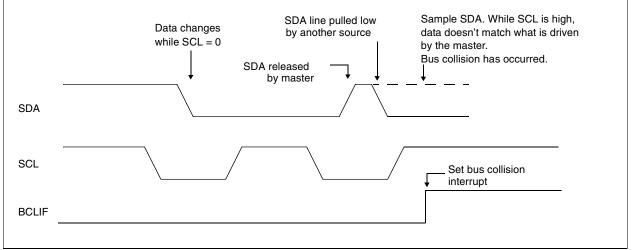
If a START, Repeated START, STOP or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDA and SCL lines are de-asserted, and the respective control bits in the SSPCON2 register are cleared. When the user services the bus collision Interrupt Service Routine, and if the l^2C bus is free, the user can resume communication by asserting a START condition.

The master will continue to monitor the SDA and SCL pins, and if a STOP condition occurs, the SSPIF bit will be set.

A write to the SSPBUF will start the transmission of data at the first data bit, regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of START and STOP conditions allows the determination of when the bus is free. Control of the I^2C bus can be taken when the P bit is set in the SSPSTAT register, or the bus is IDLE and the S and P bits are cleared.





9.2.18.1 Bus Collision During a START Condition

During a START condition, a bus collision occurs if:

- a) SDA or SCL are sampled low at the beginning of the START condition (Figure 9-20).
- b) SCL is sampled low before SDA is asserted low. (Figure 9-21).

During a START condition, both the SDA and the SCL pins are monitored. If either the SDA pin <u>or</u> the SCL pin is already low, then these events all occur:

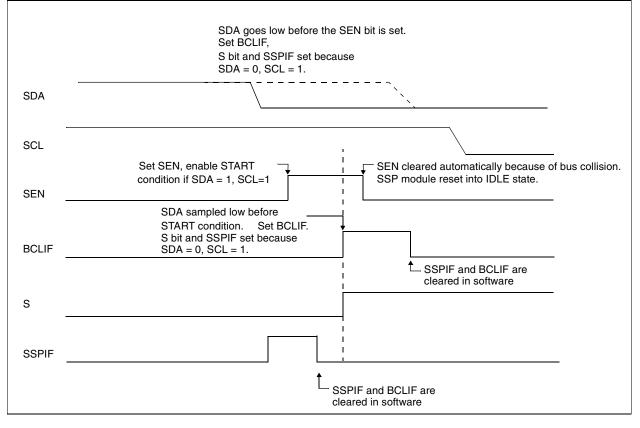
- the START condition is aborted,
- and the BCLIF flag is set
- <u>and</u> the SSP module is reset to its IDLE state (Figure 9-20).

The START condition begins with the SDA and SCL pins de-asserted. When the SDA pin is sampled high, the baud rate generator is loaded from SSPADD<6:0> and counts down to 0. If the SCL pin is sampled low while SDA is high, a bus collision occurs, because it is assumed that another master is attempting to drive a data '1' during the START condition.

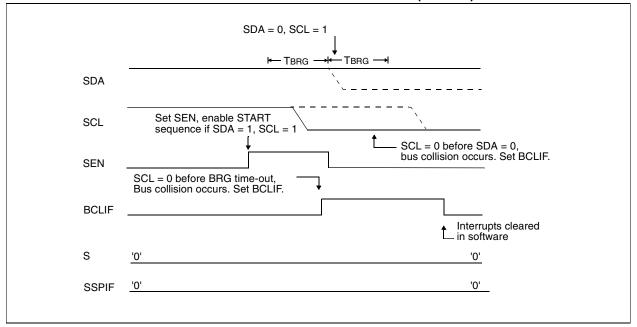
If the SDA pin is sampled low during this count, the BRG is reset and the SDA line is asserted early (Figure 9-22). If, however, a '1' is sampled on the SDA pin, the SDA pin is asserted low at the end of the BRG count. The baud rate generator is then reloaded and counts down to 0. During this time, if the SCL pins are sampled as '0', a bus collision does not occur. At the end of the BRG count, the SCL pin is asserted low.

Note: The reason that bus collision is not a factor during a START condition, is that no two bus masters can assert a START condition at the exact same time. Therefore, one master will always assert SDA before the other. This condition does not cause a bus collision, because the two masters must be allowed to arbitrate the first address following the START condition. If the address is the same, arbitration must be allowed to continue into the data portion, Repeated START or STOP conditions.

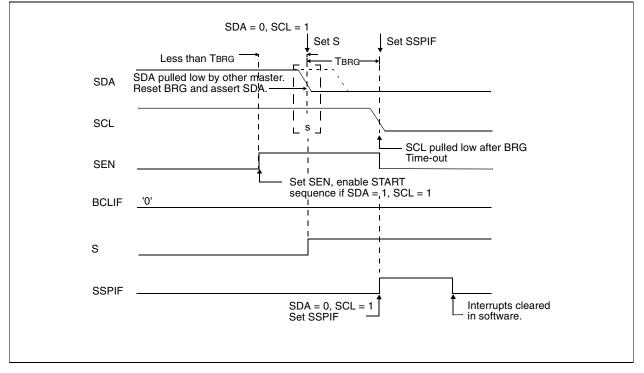
FIGURE 9-20: BUS COLLISION DURING START CONDITION (SDA ONLY)











9.2.18.2 Bus Collision During a Repeated START Condition

During a Repeated START condition, a bus collision occurs if:

- a) A low level is sampled on SDA when SCL goes from low level to high level.
- b) SCL goes low before SDA is asserted low, indicating that another master is attempting to transmit a data '1'.

When the user de-asserts SDA and the pin is allowed to float high, the BRG is loaded with SSPADD<6:0> and counts down to 0. The SCL pin is then de-asserted, and when sampled high, the SDA pin is sampled. If SDA is low, a bus collision has occurred (i.e., another master is attempting to transmit a data'0'). If, however, SDA is sampled high, the BRG is reloaded and begins counting. If SDA goes from high to low before the BRG times out, no bus collision occurs, because no two masters can assert SDA at exactly the same time.

If, however, SCL goes from high to low before the BRG times out and SDA has not already been asserted, a bus collision occurs. In this case, another master is attempting to transmit a data'1' during the Repeated START condition.

If, at the end of the BRG time-out, both SCL and SDA are still high, the SDA pin is driven low, the BRG is reloaded and begins counting. At the end of the count, regardless of the status of the SCL pin, the SCL pin is driven low and the Repeated START condition is complete (Figure 9-23).

FIGURE 9-23: BUS COLLISION DURING A REPEATED START CONDITION (CASE 1)

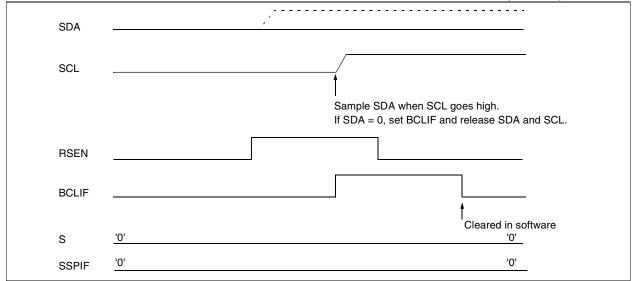
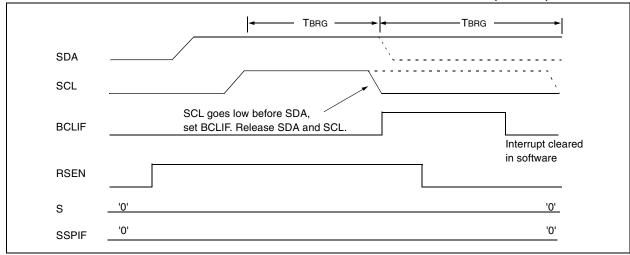


FIGURE 9-24: BUS COLLISION DURING REPEATED START CONDITION (CASE 2)



9.2.18.3 Bus Collision During a STOP Condition

Bus collision occurs during a STOP condition if:

- a) After the SDA pin has been de-asserted and allowed to float high, SDA is sampled low after the BRG has timed out.
- b) After the SCL pin is de-asserted, SCL is sampled low before SDA goes high.

The STOP condition begins with SDA asserted low. When SDA is sampled low, the SCL pin is allowed to float. When the pin is sampled high (clock arbitration), the baud rate generator is loaded with SSPADD<6:0> and counts down to 0. After the BRG times out, SDA is sampled. If SDA is sampled low, a bus collision has occurred. This is due to another master attempting to drive a data '0'. If the SCL pin is sampled low before SDA is allowed to float high, a bus collision occurs. This is a case of another master attempting to drive a data '0' (Figure 9-25).

FIGURE 9-25: BUS COLLISION DURING A STOP CONDITION (CASE 1)

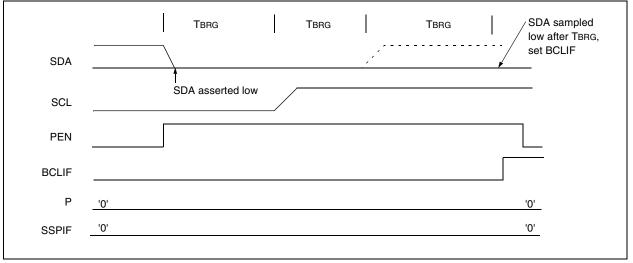
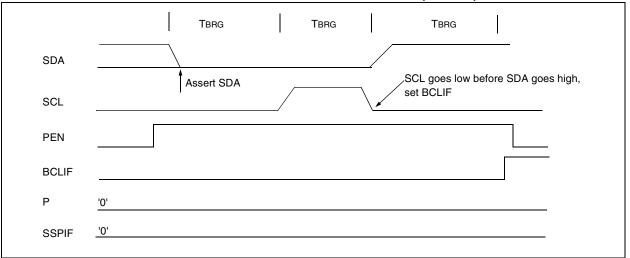


FIGURE 9-26: BUS COLLISION DURING A STOP CONDITION (CASE 2)



9.3 Connection Considerations for I²C Bus

For standard mode I^2C bus devices, the values of resistors R_p and R_s in Figure 9-27 depend on the following parameters:

- Supply voltage
- Bus capacitance
- Number of connected devices (input current + leakage current).

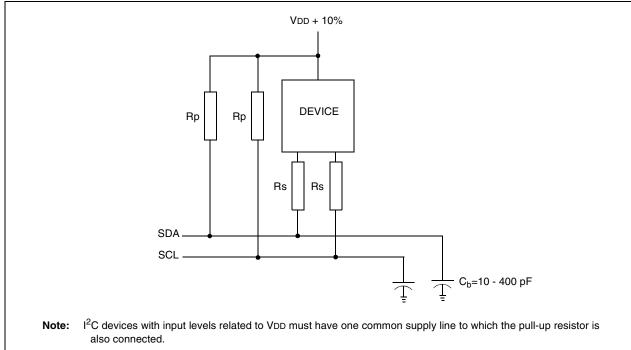
The supply voltage limits the minimum value of resistor R_p , due to the specified minimum sink current of 3 mA at VoL max = 0.4V, for the specified output stages. For example, with a supply voltage of VDD = $5V\pm10\%$ and

VoL max = 0.4V at 3 mA, $R_{p \text{ min}} = (5.5-0.4)/0.003 = 1.7 \text{ k}\Omega$. VDD, as a function of R_p , is shown in Figure 9-27. The desired noise margin of 0.1 VDD for the low level limits the maximum value of R_s . Series resistors are optional and used to improve ESD susceptibility.

The bus capacitance is the total capacitance of wire, connections, and pins. This capacitance limits the maximum value of R_{p} , due to the specified rise time (Figure 9-27).

The SMP bit is the slew rate control enabled bit. This bit is in the SSPSTAT register, and controls the slew rate of the I/O pins when in I^2C mode (master or slave).

FIGURE 9-27: SAMPLE DEVICE CONFIGURATION FOR I²C BUS



10.0 ANALOG-TO-DIGITAL CONVERTER (A/D) MODULE

The Analog-to-Digital (A/D) Converter module has five input channels. The analog input charges a sample and hold capacitor. The output of the sample and hold capacitor is the input into the converter. The converter then generates a digital result of this analog level via successive approximation. The A/D conversion of the analog input signal results in a corresponding 10-bit digital number. The A/D module has high and low voltage reference input that is software selectable to some combination of VDD, Vss, RA2 or RA3.

The A/D converter has a unique feature of being able to operate while the device is in SLEEP mode. To operate in SLEEP, the A/D clock must be derived from the A/D's internal RC oscillator. The A/D module has four registers. These registers are:

- A/D Result High Register (ADRESH)
- A/D Result Low Register (ADRESL)
- A/D Control Register0 (ADCON0)
- A/D Control Register1 (ADCON1)

The ADCON0 register, shown in Register 10-1, controls the operation of the A/D module. The ADCON1 register, shown in Register 10-2, configures the functions of the port pins. The port pins can be configured as analog inputs (RA3 can also be the voltage reference), or as digital I/O.

Additional information on using the A/D module can be found in the PICmicro[™] Mid-Range MCU Family Reference Manual (DS33023).

	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0
	ADCS1	ADCS0	CHS2	CHS1	CHS0	GO/DONE		ADON
	bit 7							bit 0
bit 7-6			Conversion C	lock Select	bits			
	00 = Fosc/ 01 = Fosc/	_						
	10 = FOSC/ 10 = FOSC/	-						
	11 = FRC (0	clock derived	d from the in	ternal A/D m	nodule RC c	scillator)		
bit 5-3	CHS2:CHS	0 : Analog C	hannel Sele	ct bits				
		nnel 0 (RA0/	,					
		nnel 1 (RA1/ nnel 2 (RA2/	,					
		nnel 3 (RA3/	,					
	100 = Cha	nnel 4 (RA5/	AN4)					
bit 2			rsion Status	bit				
	If ADON =		<i>,</i> .				、 、	
						D conversion cleared by ha		en the Δ/D
		sion is comp			lomatically	cicarca by ne		
bit 1	Unimplem	ented: Read	1 as '0'					
bit 0	ADON: A/D	On bit						
			ule is operat	•				
	0 = A/D cor	nverter mod	ule is shut-of	ff and consu	mes no ope	erating current	t	
	Legend:							
	R = Reada			ritable bit		plemented bi		
	- n = Value	at POR	'1' = Bi	t is set	$0^{\circ} = Bit is$	s cleared	x = Bit is ur	nknown

REGISTER 10-1: ADCON0 REGISTER (ADDRESS: 1Fh)

PIC16F872

REGISTER 10-2: ADCON1 REGISTER (ADDRESS: 9Fh)

	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
	ADFM	—	—	—	PCFG3	PCFG2	PCFG1	PCFG0
k	oit 7							bit 0

bit 7 ADFM: A/D Result Format Select bit

1 = Right justified. Six Most Significant bits of ADRESH are read as '0'.

0 = Left justified. Six Least Significant bits of ADRESL are read as '0'.

bit 6-4 Unimplemented: Read as '0'

bit 3-0	PCFG3:PCFG0:	A/D Port	Configuration	Control bits:

PCFG3: PCFG0	AN4 RA5	AN3 RA3	AN2 RA2	AN1 RA1	AN0 RA0	VREF+	VREF-	CHAN/ Refs ⁽¹⁾
0000	А	А	Α	Α	Α	Vdd	Vss	8/0
0001	А	VREF+	Α	Α	Α	RA3	Vss	7/1
0010	А	А	Α	Α	Α	Vdd	Vss	5/0
0011	А	VREF+	А	А	Α	RA3	Vss	4/1
0100	D	А	D	Α	Α	Vdd	Vss	3/0
0101	D	VREF+	D	Α	Α	RA3	Vss	2/1
011x	D	D	D	D	D	Vdd	Vss	0/0
1000	А	VREF+	VREF-	А	Α	RA3	RA2	6/2
1001	А	А	А	А	Α	Vdd	Vss	6/0
1010	А	VREF+	А	А	Α	RA3	Vss	5/1
1011	А	VREF+	VREF-	А	Α	RA3	RA2	4/2
1100	А	VREF+	VREF-	Α	Α	RA3	RA2	3/2
1101	D	VREF+	VREF-	А	Α	RA3	RA2	2/2
1110	D	D	D	D	А	Vdd	Vss	1/0
1111	D	VREF+	VREF-	D	Α	RA3	RA2	1/2

A = Analog input

D = Digital I/O

Note 1: This column indicates the number of analog channels available as A/D inputs and the number of analog channels used as voltage reference inputs.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

The ADRESH:ADRESL registers contain the 10-bit result of the A/D conversion. When the A/D conversion is complete, the result is loaded into this A/D result register pair, the GO/DONE bit (ADCON0<2>) is cleared and the A/D interrupt flag bit ADIF is set. The block diagram of the A/D module is shown in Figure 10-1.

After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as inputs.

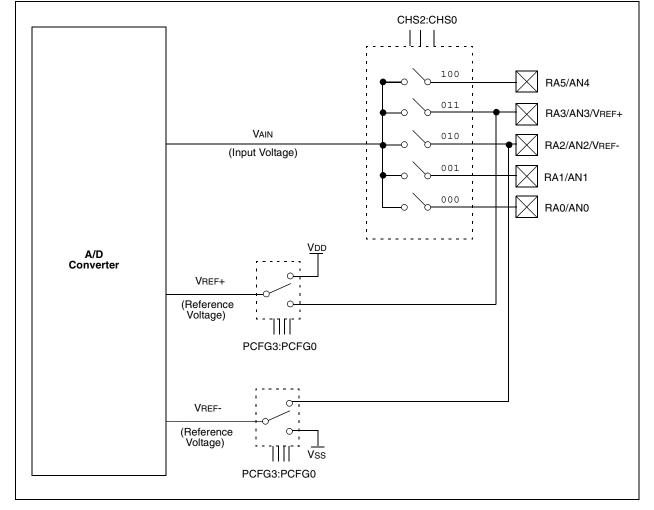
To determine sample time, see Section 10.1. After this acquisition time has elapsed, the A/D conversion can be started.

These steps should be followed for doing an A/D conversion:

- 1. Configure the A/D module:
 - Configure analog pins/voltage reference and digital I/O (ADCON1)
 - Select A/D input channel (ADCON0)
 - Select A/D conversion clock (ADCON0)
 - Turn on A/D module (ADCON0)



- 2. Configure A/D interrupt (if desired):
 - Clear ADIF bit
 - Set ADIE bit
 - Set PEIE bit
 - · Set GIE bit
- 3. Wait the required acquisition time.
- 4. Start conversion:
 - Set GO/DONE bit (ADCON0)
- 5. Wait for A/D conversion to complete, by either:
 - Polling for the GO/DONE bit to be cleared (with interrupts enabled); OR
 - Waiting for the A/D interrupt
- 6. Read A/D Result register pair (ADRESH:ADRESL), clear bit ADIF if required.
- 7. For the next conversion, go to step 1 or step 2, as required. The A/D conversion time per bit is defined as TAD.



10.1 A/D Acquisition Requirements

For the A/D converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 10-2. The source impedance (Rs) and the internal sampling switch (Rss) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (Rss) impedance varies over the device voltage (VDD), Figure 10-2. The maximum recommended impedance for analog sources is 10 k Ω . As the impedance is decreased, the acquisition time may be

EQUATION 10-1: ACQUISITION TIME

decreased. After the analog input channel is selected (changed), this acquisition must be done before the conversion can be started.

Equation 10-1 may be used to calculate the minimum acquisition time. This equation assumes that 1/2 LSb error is used (1024 steps for the A/D). The 1/2 LSb error is the maximum error allowed for the A/D to meet its specified resolution.

To calculate the minimum acquisition time, TACQ, see the PICmicro[™] Mid-Range Reference Manual (DS33023).

TACQ	= Amplifier Settling Time + Hold Capacitor Charging Time + Temperature Coefficient
	= TAMP + TC + TCOFF
	= $2 \mu s + TC + [(Temperature -25^{\circ}C)(0.05 \mu s/^{\circ}C)]$
TC	= CHOLD (RIC + RSS + RS) In(1/2047) - 120 pF (1 k Ω + 7 k Ω + 10 k Ω) In(0.0004885)
	$= 16.47 \mu s$
TACQ	= $2 \mu s + 16.47 \mu s + [(50^{\circ}C - 25^{\circ}C)(0.05 \mu s)^{\circ}C)$
	$= 19.72 \mu s$

Note 1: The reference voltage (VREF) has no effect on the equation, since it cancels itself out.

- 2: The charge holding capacitor (CHOLD) is not discharged after each conversion.
- 3: The maximum recommended impedance for analog sources is 10 kΩ. This is required to meet the pin leakage specification.

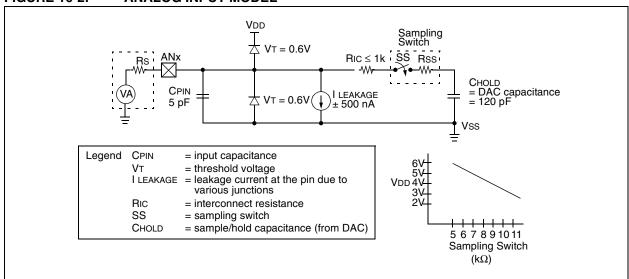


FIGURE 10-2: ANALOG INPUT MODEL

10.2 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires a minimum 12TAD per 10-bit conversion. The source of the A/D conversion clock is software selected. The four possible options for TAD are:

- 2Tosc
- 8Tosc
- 32Tosc
- Internal A/D module RC oscillator (2-6 μs)

For correct A/D conversions, the A/D conversion clock (TAD) must be selected to ensure a minimum TAD time of 1.6 $\mu s.$

Table 10-1
shows the resultant TAD times derived from the device operating frequencies and the
 A/D clock source selected.

10.3 Configuring Analog Port Pins

The ADCON1, and TRIS registers control the operation of the A/D port pins. The port pins that are desired as analog inputs must have their corresponding TRIS bits set (input). If the TRIS bit is cleared (output), the digital output level (VOH or VOL) will be converted.

The A/D operation is independent of the state of the CHS2:CHS0 bits and the TRIS bits.

- Note 1: When reading the port register, any pin configured as an analog input channel will read as cleared (a low level). Pins configured as digital inputs will convert an analog input. Analog levels on a digitally configured input will not affect the conversion accuracy.
 - 2: Analog levels on any pin that is defined as a digital input (including the AN7:AN0 pins), may cause the input buffer to consume current that is out of the device specifications.

TABLE 10-1: TAD VS. MAXIMUM DEVICE OPERATING FREQUENCIES (STANDARD DEVICES (C))

AD Clock S	Maximum Davias Fraguenay	
Operation	ADCS1:ADCS0	Maximum Device Frequency
2Tosc	0 0	1.25 MHz
8Tosc	01	5 MHz
32Tosc	10	20 MHz
RC ^(1, 2, 3)	11	(Note 1)

Note 1: The RC source has a typical TAD time of 4 µs, but can vary between 2-6 µs.

2: When the device frequencies are greater than 1 MHz, the RC A/D conversion clock source is only recommended for SLEEP operation.

3: For extended voltage devices (LC), please refer to the Electrical Characteristics (Sections 14.1 and 14.2).

10.4 A/D Conversions

Clearing the GO/DONE bit during a conversion will abort the current conversion. The A/D result register pair will NOT be updated with the partially completed A/D conversion sample. That is, the ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers). After the A/D conversion is aborted, acquisition on the selected channel is automatically started. The GO/DONE bit can then be set to start the conversion.

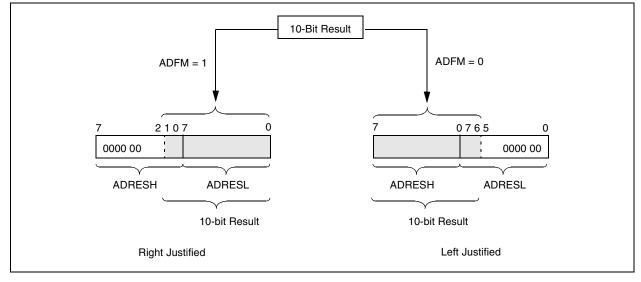
FIGURE 10-3: A/D CONVERSION TAD CYCLES

TCY to TAD TAD1 TAD2 TAD3 TAD4 Tad5 TAD6 TAD7 TAD8 TAD9 TAD10 TAD11 b9 b8 b7 b6 b5 b4 b3 b2 b1 b0 **Conversion Starts** Holding capacitor is disconnected from analog input (typically 100 ns) Set GO bit ADRES is loaded GO bit is cleared ADIF bit is set Holding capacitor is connected to analog input

10.4.1 A/D RESULT REGISTERS

The ADRESH:ADRESL register pair is the location where the 10-bit A/D result is loaded at the completion of the A/D conversion. This register pair is 16-bits wide. The A/D module gives the flexibility to left or right justify the 10-bit result in the 16-bit result register. The A/D Format Select bit (ADFM) controls this justification. Figure 10-4 shows the operation of the A/D result justification. The extra bits are loaded with '0's'. When an A/D result will not overwrite these locations (A/D disable), these registers may be used as two general purpose 8-bit registers.

FIGURE 10-4: A/D RESULT JUSTIFICATION



In Figure 10-3, after the GO bit is set, the first time segment has a minimum of TCY and a maximum of TAD.

Note: The GO/DONE bit should **NOT** be set in the same instruction that turns on the A/D.

10.5 A/D Operation During SLEEP

The A/D module can operate during SLEEP mode. This requires that the A/D clock source be set to RC (ADCS1:ADCS0 = 11). When the RC clock source is selected, the A/D module waits one instruction cycle before starting the conversion. This allows the SLEEP instruction to be executed, which eliminates all digital switching noise from the conversion. When the conversion is completed, the GO/DONE bit will be cleared and the result loaded into the ADRES register. If the A/D interrupt is enabled, the device will wake-up from SLEEP. If the A/D interrupt is not enabled, the ADON bit will remain set.

When the A/D clock source is another clock option (not RC), a SLEEP instruction will cause the present conversion to be aborted and the A/D module to be turned off, though the ADON bit will remain set.

Turning off the A/D places the A/D module in its lowest current consumption state.

Note:	For the A/D module to operate in SLEEP,
	the A/D clock source must be set to RC
	(ADCS1:ADCS0 = 11). To allow the con-
	version to occur during SLEEP, ensure the
	SLEEP instruction immediately follows the
	instruction that sets the GO/DONE bit.

10.6 Effects of a RESET

A device RESET forces all registers to their RESET state. This forces the A/D module to be turned off, and any conversion is aborted. All A/D input pins are configured as analog inputs.

The value that is in the ADRESH:ADRESL registers is not modified for a Power-on Reset. The ADRESH:ADRESL registers will contain unknown data after a Power-on Reset.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		DR, DR		ELR, DT
0Bh,8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TMR0IE	INTE	RBIE	TMR0IF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	(1)	ADIF	(1)	(1)	SSPIF	CCP1IF	TMR2IF	TMR1IF	r0rr	0000	0000	0000
8Ch	PIE1	(1)	ADIE	(1)	(1)	SSPIE	CCP1IE	TMR2IE	TMR1IE	r0rr	0000	0000	0000
1Eh	ADRESH	A/D Resu	It Registe	er High By	yte					xxxx	xxxx	uuuu	uuuu
9Eh	ADRESL	A/D Resu	It Registe	er Low By	rte					xxxx	xxxx	uuuu	uuuu
1Fh	ADCON0	ADCS1	ADCS0	CHS2	CHS1	CHS0	GO/DONE	_	ADON	0000	00-0	0000	00-0
9Fh	ADCON1	ADFM			_	PCFG3	PCFG2	PCFG1	PCFG0	0 -	0000	0 -	0000
85h	TRISA	—	_	PORTA Data Direction Register				11	1111	11	1111		
05h	PORTA	—	_	PORTA I	PORTA Data Latch when written: PORTA pins when read				0x	0000	0u	0000	

TABLE 10-2: REGISTERS/BITS ASSOCIATED WITH A/D

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used for A/D conversion.

Note 1: These bits are reserved; always maintain clear.

NOTES:

11.0 SPECIAL FEATURES OF THE CPU

The PIC16F872 microcontroller has a host of features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These are:

- Oscillator Selection
- RESET
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
 - Brown-out Reset (BOR)
- Interrupts
- Watchdog Timer (WDT)
- SLEEP
- Code Protection
- ID Locations
- In-Circuit Serial Programming
- Low Voltage In-Circuit Serial Programming
- In-Circuit Debugger

The microcontrollers have a Watchdog Timer, which can be shut-off only through configuration bits. It runs off its own RC oscillator for added reliability.

There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), intended to keep the chip in RESET until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay of 72 ms (nominal) on power-up only. It is designed to keep the part in RESET while the power supply stabilizes. With these two timers on-chip, most applications need no external RESET circuitry.

SLEEP mode is designed to offer a very low current power-down mode. The user can wake-up from SLEEP through external RESET, Watchdog Timer Wake-up, or through an interrupt.

Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost, while the LP crystal option saves power. A set of configuration bits is used to select various options.

Additional information on special features is available in the PICmicro[™] Mid-Range Reference Manual, (DS33023).

11.1 Configuration Bits

The configuration bits can be programmed (read as '0'), or left unprogrammed (read as '1'), to select various device configurations. The erased, or unprogrammed, value of the configuration word is 3FFFh. These bits are mapped in program memory location 2007h.

It is important to note that address 2007h is beyond the user program memory space, which can be accessed only during programming.

R/P-1 R/P-1 **R/P-1** U-0 R/P-1 R/P-1 **R/P-1 R/P-1 R/P-1 R/P-1** R/P-1 R/P-1 R/P-1 **R/P-1** F0SC0 CP1 CP0 DEBUG WRT CPD LVP BODEN CP1 CP0 PWRTE WDTE F0SC1 bit13 bit0 bit 13-12 CP1:CP0: FLASH Program Memory Code Protection bits⁽²⁾ 11 = Code protection off bit 5-4 10 = Not supported 01 = Not supported 00 = All memory code protected bit 11 DEBUG: In-Circuit Debugger Mode bit 1 = In-Circuit Debugger disabled, RB6 and RB7 are general purpose I/O pins 0 = In-Circuit Debugger enabled, RB6 and RB7 are dedicated to the debugger bit 10 Unimplemented: Read as '1' bit 9 WRT: FLASH Program Memory Write Enable bit 1 = Unprotected program memory may be written to by EECON control 0 = Unprotected program memory may not be written to by EECON control CPD: Data EEPROM Memory Code Protection bit bit 8 1 = Code protection off0 = Data EEPROM memory code protected bit 7 LVP: Low Voltage In-Circuit Serial Programming Enable bit 1 = RB3/PGM pin has PGM function, low voltage programming enabled 0 = RB3 is digital I/O, HV on MCLR must be used for programming BODEN: Brown-out Reset Enable bit⁽³⁾ bit 6 1 = BOR enabled 0 = BOR disabled bit 3 **PWRTE**: Power-up Timer Enable bit⁽³⁾ 1 = PWRT disabled 0 = PWRT enabled bit 2 WDTE: Watchdog Timer Enable bit 1 = WDT enabled 0 = WDT disabled bit 1-0 FOSC1:FOSC0: Oscillator Selection bits 11 = RC oscillator 10 = HS oscillator 01 = XT oscillator 00 = LP oscillator Note 1: The erased (unprogrammed) value of the configuration word is 3FFFh. 2: All of the CP1:CP0 pairs have to be given the same value to enable the code protection scheme listed. 3: Enabling Brown-out Reset automatically enables Power-up Timer (PWRT), regardless of the value of bit PWRTE. Ensure the Power-up Timer is enabled any time Brown-out Reset is enabled.

REGISTER 11-1: CONFIGURATION WORD (ADDRESS: 2007h)⁽¹⁾

Legend:

R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'
- n = Value when device is	s unprogrammed	u = Unchanged from programmed state

11.2 Oscillator Configurations

11.2.1 OSCILLATOR TYPES

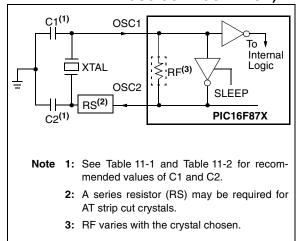
The PIC16F872 can be operated in four different oscillator modes. The user can program two configuration bits (FOSC1 and FOSC0) to select one of these four modes:

- LP Low Power Crystal
- XT Crystal/Resonator
- HS High Speed Crystal/Resonator
- RC Resistor/Capacitor

11.2.2 CRYSTAL OSCILLATOR/CERAMIC RESONATORS

In XT, LP or HS modes, a crystal or ceramic resonator is connected to the OSC1/CLKIN and OSC2/CLKOUT pins to establish oscillation (Figure 11-1). The PIC16F872 oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT, LP or HS modes, the device can have an external clock source to drive the OSC1/ CLKIN pin (Figure 11-2).

FIGURE 11-1: CRYSTAL/CERAMIC RESONATOR OPERATION (HS, XT OR LP OSC CONFIGURATION)



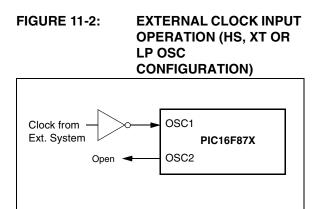


TABLE 11-1: CERAMIC RESONATORS

Ranges Tested:						
Mode	Freq	OSC1	OSC2			
ХТ	455 kHz	68 - 100 pF	68 - 100 pF			
	2.0 MHz	15 - 68 pF	15 - 68 pF			
	4.0 MHz	15 - 68 pF	15 - 68 pF			
HS	8.0 MHz	10 - 68 pF	10 - 68 pF			
	16.0 MHz	10 - 22 pF	10 - 22 pF			

These values are for design guidance only. See notes following Table 11-2.

Resonators Used:					
455 kHz Panasonic EFO-A455K04B ± 0.3%					
2.0 MHz	Murata Erie CSA2.00MG	± 0.5%			
4.0 MHz	Murata Erie CSA4.00MG	± 0.5%			
8.0 MHz	8.0 MHz Murata Erie CSA8.00MT				
16.0 MHz	Murata Erie CSA16.00MX	± 0.5%			
All resonators used did not have built-in capacitors.					

TABLE 11-2:CAPACITOR SELECTION FOR
CRYSTAL OSCILLATOR

Osc Type	Crystal Freq	Cap. Range C1	Cap. Range C2		
LP	32 kHz	33 pF	33 pF		
	200 kHz	15 pF	15 pF		
XT	200 kHz	47-68 pF	47-68 pF		
	1 MHz	15 pF	15 pF		
	4 MHz	15 pF	15 pF		
HS	4 MHz	15 pF	15 pF		
	8 MHz	15-33 pF	15-33 pF		
	20 MHz	15-33 pF	15-33 pF		
These values are for design guidance only. See notes following this table.					

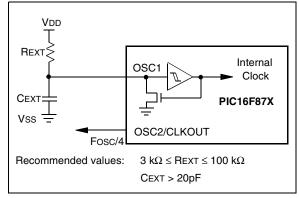
	Crystals Used					
32 kHz	Epson C-001R32.768K-A	± 20 PPM				
200 kHz	STD XTL 200.000KHz	± 20 PPM				
1 MHz	ECS ECS-10-13-1	± 50 PPM				
4 MHz	ECS ECS-40-20-1	± 50 PPM				
8 MHz	EPSON CA-301 8.000M-C	± 30 PPM				
20 MHz	EPSON CA-301 20.000M-C	± 30 PPM				

- **Note 1:** Higher capacitance increases the stability of oscillator, but also increases the startup time.
 - 2: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
 - **3:** Rs may be required in HS mode, as well as XT mode, to avoid overdriving crystals with low drive level specification.
 - 4: When migrating from other PICmicro[®] devices, oscillator performance should be verified.

11.2.3 RC OSCILLATOR

For timing insensitive applications, the "RC" device option offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (REXT) and capacitor (CEXT) values, and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low CEXT values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 11-3 shows how the R/C combination is connected to the PIC16F872.





11.3 Reset

The PIC16F872 differentiates between various kinds of RESET:

- Power-on Reset (POR)
- MCLR Reset during normal operation
- MCLR Reset during SLEEP
- WDT Reset (during normal operation)
- WDT Wake-up (during SLEEP)
- Brown-out Reset (BOR)

Some registers are not affected in any RESET condition. Their status is unknown on POR and unchanged in any other RESET. Most other registers are reset to a <u>"RESET state" on Power-on Reset (POR)</u>, on the MCLR and WDT Reset, on MCLR Reset during SLEEP, and Brown-out Reset (BOR). They are not affected by a WDT Wake-up, which is viewed as the resumption of normal operation. The $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits are set or cleared differently in different RESET situations, as indicated in Table 11-4. These bits are used in software to determine the nature of the RESET. See Table 11-6 for a full description of RESET states of all registers.

A simplified block diagram of the On-Chip Reset circuit is shown in Figure 11-4.

These devices have a MCLR noise filter in the MCLR Reset path. The filter will detect and ignore small pulses.

It should be noted that a WDT Reset does not drive $\overline{\text{MCLR}}$ pin low.

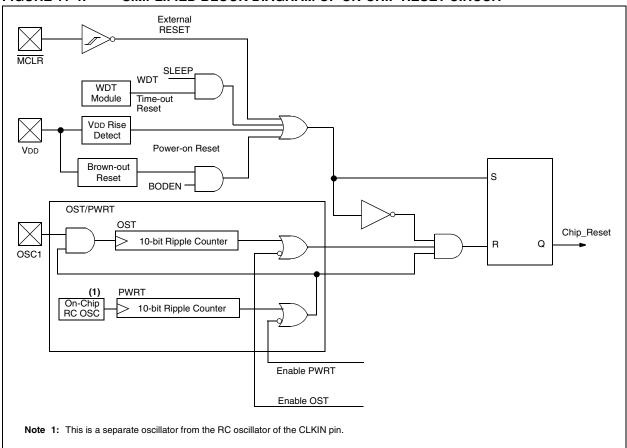


FIGURE 11-4: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT

11.4 Power-on Reset (POR)

A Power-on Reset pulse is generated on-chip when VDD rise is detected (in the range of 1.2V - 1.7V). To take advantage of the POR, tie the MCLR pin directly (or through a resistor) to VDD. This will eliminate external RC components usually needed to create a Power-on Reset. A maximum rise time for VDD is specified. See Electrical Specifications for details.

When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature,...) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met. Brown-out Reset may be used to meet the start-up conditions. For additional information, refer to Application Note (AN007), *"Power-up Trouble Shooting"*, (DS00007).

11.5 **Power-up Timer (PWRT)**

The Power-up Timer provides a fixed 72 ms nominal time-out on power-up only from the POR. The Power-up Timer operates on an internal RC oscillator. The chip is kept in RESET as long as the PWRT is active. The PWRT's time delay allows VDD to rise to an accept-able level. A configuration bit is provided to enable/disable the PWRT.

The power-up time delay will vary from chip to chip due to VDD, temperature and process variation. See DC parameters for details (TPWRT, parameter #33).

11.6 Oscillator Start-up Timer (OST)

The Oscillator Start-up Timer (OST) provides a delay of 1024 oscillator cycles (from OSC1 input) after the PWRT delay is over (if PWRT is enabled). This helps to ensure that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

11.7 Brown-out Reset (BOR)

The configuration bit, BODEN, can enable or disable the Brown-out Reset circuit. If VDD falls below VBOR (parameter #D005, about 4V) for longer than TBOR (parameter #35, about 100 μ S), the brown-out situation will reset the device. If VDD falls below VBOR for less than TBOR, a RESET may not occur.

Once the brown-out occurs, the device will remain in Brown-out Reset until VDD rises above VBOR. The Power-up Timer then keeps the device in RESET for TPWRT (parameter #33, about 72 mS). If VDD should fall below VBOR during TPWRT, the Brown-out Reset process will restart when VDD rises above VBOR with the Power-up Timer Reset. The Power-up Timer is always enabled when the Brown-out Reset circuit is enabled, regardless of the state of the PWRT configuration bit.

11.8 Time-out Sequence

On power-up, the time-out sequence is as follows: the PWRT delay starts (if enabled) when a POR Reset occurs. Then, OST starts counting 1024 oscillator cycles when PWRT ends (LP, XT, HS). When the OST ends, the device comes out of RESET.

If MCLR is kept low long enough, the time-outs will expire. Bringing MCLR high will begin execution immediately. This is useful for testing purposes or to synchronize more than one PIC16F872 device operating in parallel.

Table 11-5 shows the RESET conditions for the STATUS, PCON and PC registers, while Table 11-6 shows the RESET conditions for all the registers.

11.9 Power Control/Status Register (PCON)

The Power Control/Status Register, PCON, has two bits.

Bit 0 is the Brown-out Reset Status bit (\overline{BOR}). Bit \overline{BOR} is unknown on a Power-on Reset. It must then be set by the user and checked on subsequent RESETS to see if bit \overline{BOR} cleared, indicating a BOR occurred. When the Brown-out Reset is disabled, the state of the \overline{BOR} bit is unpredictable and is, therefore, not valid at any time.

Bit 1 is the Power-on Reset Status bit ($\overline{\text{POR}}$). It is cleared on a Power-on Reset and unaffected otherwise. The user must set this bit following a Power-on Reset.

Oscillator Configuration	Power	-up	Brown-out	Wake-up from	
Oscillator Configuration	PWRTE = 0	PWRTE = 1	Brown-out	SLEEP	
XT, HS, LP	72 ms + 1024Tosc	1024Tosc	72 ms + 1024Tosc	1024Tosc	
RC	72 ms —		72 ms	—	

TABLE 11-3: TIME-OUT IN VARIOUS SITUATIONS

POR	BOR	то	PD	
0	x	1	1	Power-on Reset
0	x	0	x	Illegal, TO is set on POR
0	x	x	0	Illegal, PD is set on POR
1	0	1	1	Brown-out Reset
1	1	0	1	WDT Reset
1	1	0	0	WDT Wake-up
1	1	u	u	MCLR Reset during normal operation
1	1	1	0	MCLR Reset during SLEEP or interrupt wake-up from SLEEP

TABLE 11-4: STATUS BITS AND THEIR SIGNIFICANCE

TABLE 11-5: RESET CONDITION FOR SPECIAL REGISTERS

Condition	Program Counter	STATUS Register	PCON Register
Power-on Reset	000h	0001 1xxx	0x
MCLR Reset during normal operation	000h	000u uuuu	uu
MCLR Reset during SLEEP	000h	0001 0uuu	uu
WDT Reset	000h	0000 luuu	uu
WDT Wake-up	PC + 1	uuu0 0uuu	uu
Brown-out Reset	000h	0001 luuu	u0
Interrupt wake-up from SLEEP	PC + 1 ⁽¹⁾	uuul 0uuu	uu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0'

Note 1: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

TABLE 11-6: INITIALIZATION CONDITIONS FOR ALL REGISTERS

Register	Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset	Wake-up via WDT or Interrupt
W	XXXX XXXX	uuuu uuuu	uuuu uuuu
INDF	N/A	N/A	N/A
TMR0	XXXX XXXX	uuuu uuuu	uuuu uuuu
PCL	0000h	0000h	PC + 1 ⁽²⁾
STATUS	0001 1xxx	000q quuu ⁽³⁾	uuuq quuu ⁽³⁾
FSR	XXXX XXXX	uuuu uuuu	uuuu uuuu
PORTA	0x 0000	0u 0000	uu uuuu
PORTB	XXXX XXXX	uuuu uuuu	uuuu uuuu
PORTC	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCLATH	0 0000	0 0000	u uuuu
INTCON	0000 000x	0000 000u	uuuu uuuu ⁽¹⁾
PIR1	r0rr 0000	r0rr 0000	rurr uuuu ⁽¹⁾
PIR2	-r-0 0r	-r-0 0r	-r-u ur ⁽¹⁾

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition, r = reserved, maintain clear

Note 1: One or more bits in INTCON, PIR1 and/or PIR2 will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

3: See Table 11-5 for RESET value for specific condition.

TABLE 11-6:	INITIALIZATION CONDITIONS FOR ALL REGISTERS ((CONTINUED)	

Register	Power-on Reset, Brown-out Reset	MCLR Resets WDT Reset	Wake-up via WDT or Interrupt
TMR1L	xxxx xxxx	uuuu uuuu	นนนน นนนน
TMR1H	xxxx xxxx	uuuu uuuu	uuuu uuuu
T1CON	00 0000	uu uuuu	uu uuuu
TMR2	0000 0000	0000 0000	uuuu uuuu
T2CON	-000 0000	-000 0000	-uuu uuuu
SSPBUF	xxxx xxxx	uuuu uuuu	uuuu uuuu
SSPCON	0000 0000	0000 0000	uuuu uuuu
CCPR1L	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1H	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON	00 0000	00 0000	uu uuuu
ADRESH	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADCON0	0000 00-0	0000 00-0	uuuu uu-u
OPTION_REG	1111 1111	1111 1111	uuuu uuuu
TRISA	11 1111	11 1111	uu uuuu
TRISB	1111 1111	1111 1111	uuuu uuuu
TRISC	1111 1111	1111 1111	uuuu uuuu
PIE1	r0rr 0000	r0rr 0000	rurr uuuu
PIE2	-r-0 0r	-r-0 0r	-r-u ur
PCON	dd	uu	uu
SSPCON2	0000 0000	0000 0000	uuuu uuuu
PR2	1111 1111	1111 1111	1111 1111
SSPADD	0000 0000	0000 0000	uuuu uuuu
SSPSTAT	00 0000	00 0000	uu uuuu
ADRESL	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADCON1	0 0000	0 0000	u uuuu
EEDATA	0 0000	0 0000	u uuuu
EEADR	XXXX XXXX	uuuu uuuu	սսսս սսսս
EEDATH	xxxx xxxx	uuuu uuuu	นนนน นนนน
EEADRH	xxxx xxxx	uuuu uuuu	นนนน นนนน
EECON1	x x000	u u000	u uuuu
EECON2			

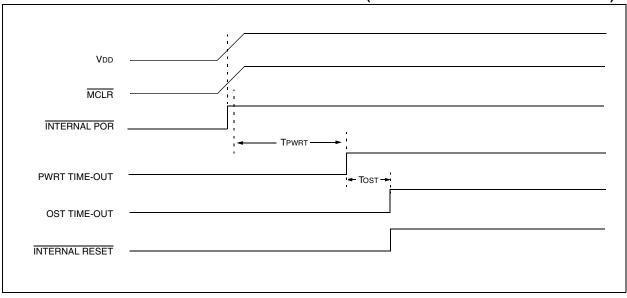
Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition, r = reserved, maintain clear

Note 1: One or more bits in INTCON, PIR1 and/or PIR2 will be affected (to cause wake-up).

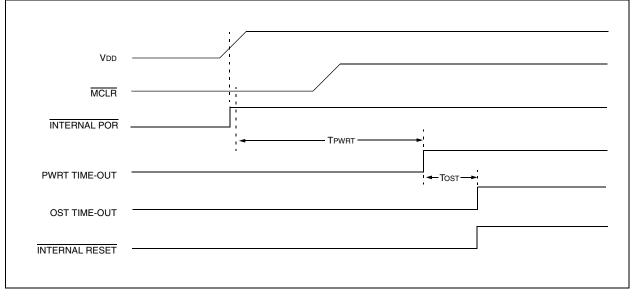
2: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

3: See Table 11-5 for RESET value for specific condition.









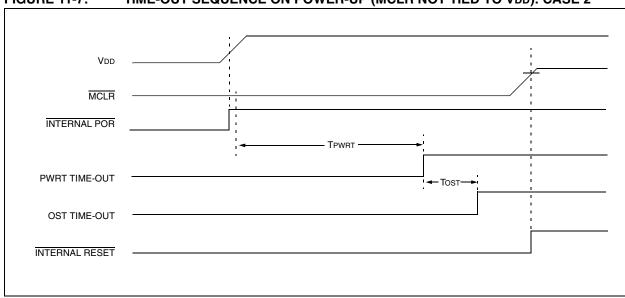
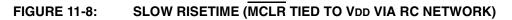
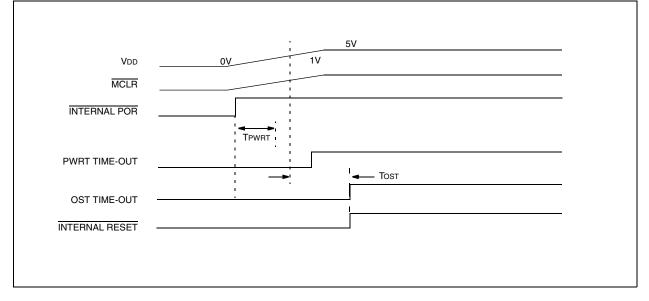


FIGURE 11-7: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 2





11.10 Interrupts

The PIC16F872 has 10 sources of interrupt. The interrupt control register (INTCON) records individual interrupt requests in flag bits. It also has individual and global interrupt enable bits.

Note:	Individual interrupt flag bits are set, regard-
	less of the status of their corresponding
	mask bit or the GIE bit.

A global interrupt enable bit, GIE (INTCON<7>), enables (if set) all unmasked interrupts or disables (if cleared) all interrupts. When bit GIE is enabled, and an interrupt's flag bit and mask bit are set, the interrupt will vector immediately. Individual interrupts can be disabled through their corresponding enable bits in various registers. Individual interrupt bits are set, regardless of the status of the GIE bit. The GIE bit is cleared on RESET.

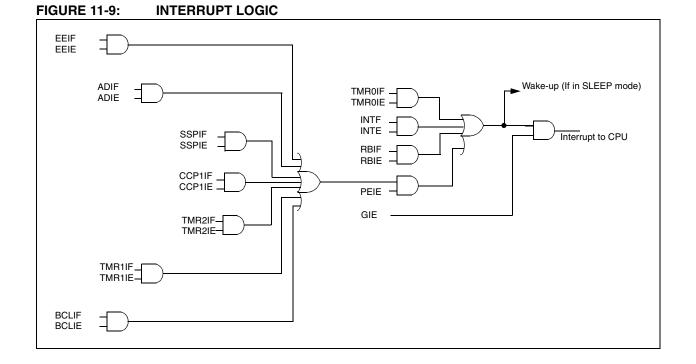
The "return from interrupt" instruction, RETFIE, exits the interrupt routine, as well as sets the GIE bit, which re-enables interrupts.

The RB0/INT pin interrupt, the RB port change interrupt and the TMR0 overflow interrupt flags are contained in the INTCON register.

The peripheral interrupt flags are contained in the special function registers, PIR1 and PIR2. The corresponding interrupt enable bits are contained in special function registers, PIE1 and PIE2, and the peripheral interrupt enable bit is contained in special function register, INTCON.

When an interrupt is responded to, the GIE bit is cleared to disable any further interrupt, the return address is pushed onto the stack and the PC is loaded with 0004h. Once in the Interrupt Service Routine, the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

For external interrupt events, such as the INT pin or PORTB change interrupt, the interrupt latency will be three or four instruction cycles. The exact latency depends when the interrupt event occurs. The latency is the same for one or two-cycle instructions. Individual interrupt flag bits are set, regardless of the status of their corresponding mask bit, PEIE bit, or GIE bit



11.10.1 INT INTERRUPT

External interrupt on the RB0/INT pin is edge triggered, either rising if bit INTEDG (OPTION_REG<6>) is set, or falling if the INTEDG bit is clear. When a valid edge appears on the RB0/INT pin, flag bit INTF (INTCON<1>) is set. This interrupt can be disabled by clearing enable bit INTE (INTCON<4>). Flag bit INTF must be cleared in software in the Interrupt Service Routine before re-enabling this interrupt. The INT interrupt can wake-up the processor from SLEEP, if bit INTE was set prior to going into SLEEP. The status of global interrupt enable bit GIE, decides whether or not the processor branches to the interrupt vector following wake-up. See Section 11.13 for details on SLEEP mode.

11.10.2 TMR0 INTERRUPT

An overflow (FFh \rightarrow 00h) in the TMR0 register will set flag bit TMR0IF (INTCON<2>). The interrupt can be enabled/disabled by setting/clearing enable bit TMR0IE (INTCON<5>), see Section 5.0.

11.10.3 PORTB INTCON CHANGE

An input change on PORTB<7:4> sets flag bit RBIF (INTCON<0>). The interrupt can be enabled/disabled by setting/clearing enable bit RBIE (INTCON<4>), see Section 4.2.

11.11 Context Saving During Interrupts

During an interrupt, only the return PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt, (i.e., W register and STATUS register). This will have to be implemented in software.

Since the upper 16 bytes of each bank are common in PIC16F872 devices, temporary holding registers, W_TEMP, STATUS_TEMP and PCLATH_TEMP, should be placed in here. These 16 locations don't require banking and therefore, make it easier for context save and restore. The same code shown in Example 11-1 can be used.

EXAMPLE 11-1: SAVING STATUS, W, AND PCLATH REGISTERS IN RAM

MOVWF	W_TEMP	;Copy W to TEMP register
SWAPF	STATUS,W	;Swap status to be saved into W
CLRF	STATUS	;bank 0, regardless of current bank, Clears IRP,RP1,RP0
MOVWF	STATUS_TEMP	;Save status to bank zero STATUS_TEMP register
MOVF	PCLATH, W	;Only required if using pages 1, 2 and/or 3
MOVWF	PCLATH_TEMP	;Save PCLATH into W
CLRF	PCLATH	;Page zero, regardless of current page
:		
:(ISR)		;(Insert user code here)
:		
MOVF	PCLATH_TEMP, W	;Restore PCLATH
MOVWF	PCLATH	;Move W into PCLATH
SWAPF	STATUS_TEMP,W	;Swap STATUS_TEMP register into W
		;(sets bank to original state)
MOVWF	STATUS	;Move W into STATUS register
SWAPF	W_TEMP,F	;Swap W_TEMP
SWAPF	W_TEMP,W	;Swap W_TEMP into W

11.12 Watchdog Timer (WDT)

The Watchdog Timer is a free running on-chip RC oscillator, which does not require any external components. This RC oscillator is separate from the RC oscillator of the OSC1/CLKI pin. That means that the WDT will run, even if the clock on the OSC1/CLKI and OSC2/CLKO pins of the device has been stopped, for example, by execution of a SLEEP instruction.

During normal operation, a WDT time-out generates a device RESET (Watchdog Timer Reset). If the device is in SLEEP mode, a WDT time-out causes the device to wake-up and continue with normal operation (Watchdog Timer Wake-up). The TO bit in the STATUS register will be cleared upon a Watchdog Timer time-out.

The WDT can be permanently disabled by clearing configuration bit WDTE (Section 11.1).

WDT time-out period values may be found in the Electrical Specifications section under parameter #31. Values for the WDT prescaler (actually a postscaler, but shared with the Timer0 prescaler) may be assigned using the OPTION_REG register.

- Note 1: The CLRWDT and SLEEP instructions clear the WDT and the postscaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET condition.
 - 2: When a CLRWDT instruction is executed and the prescaler is assigned to the WDT, the prescaler count will be cleared, but the prescaler assignment is not changed.

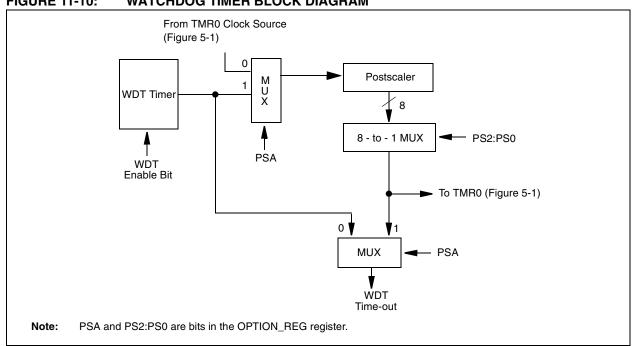


FIGURE 11-10: WATCHDOG TIMER BLOCK DIAGRAM

TABLE 11-7: SUMMARY OF WATCHDOG TIMER REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
2007h	Config. bits	(1)	BODEN ⁽¹⁾	CP1	CP0	PWRTE ⁽¹⁾	WDTE	FOSC1	FOSC0
81h,181h	OPTION_REG	RBPU	INTEDG	TOCS	T0SE	PSA	PS2	PS1	PS0

Legend: Shaded cells are not used by the Watchdog Timer.

Note 1: See Register 11-1 for operation of these bits.

11.13 Power-down Mode (SLEEP)

Power-down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the PD bit (STATUS<3>) is cleared, the TO (STATUS<4>) bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had before the SLEEP instruction was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, place all I/O pins at either VDD or Vss, ensure no external circuitry is drawing current from the I/O pin, power-down the A/D and disable external clocks. Pull all I/O pins that are hi-impedance inputs, high or low externally, to avoid switching currents caused by floating inputs. The TOCKI input should also be at VDD or Vss for lowest current consumption. The contribution from on-chip pull-ups on PORTB should also be considered.

The $\overline{\text{MCLR}}$ pin must be at a logic high level (VIHMC).

11.13.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

- 1. External RESET input on MCLR pin.
- 2. Watchdog Timer wake-up (if WDT was enabled).
- 3. Interrupt from INT pin, RB port change or Peripheral Interrupt.

External MCLR Reset will cause a device RESET. All other events are considered a continuation of program execution and cause a "wake-up". The TO and PD bits in the STATUS register can be used to determine the cause of device RESET. The PD bit, which is set on power-up, is cleared when SLEEP is invoked. The TO bit is cleared if a WDT time-out occurred and caused wake-up.

The following peripheral interrupts can wake the device from SLEEP:

- 1. PSP read or write.
- 2. TMR1 interrupt. Timer1 must be operating as an asynchronous counter.
- 3. CCP Capture mode interrupt.
- 4. Special event trigger (Timer1 in Asynchronous mode using an external clock).
- 5. SSP (START/STOP) bit detect interrupt.
- 6. SSP transmit or receive in Slave mode (SPI/I²C).
- 7. USART RX or TX (Synchronous Slave mode).
- 8. A/D conversion (when A/D clock source is RC).
- 9. EEPROM write operation completion.

Other peripherals cannot generate interrupts, since during SLEEP, no on-chip clocks are present.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction after the sLEEP instruction of the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

11.13.2 WAKE-UP USING INTERRUPTS

When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs before the execution of a SLEEP instruction, the SLEEP instruction will complete as a NOP. Therefore, the WDT and WDT postscaler will not be cleared, the TO bit will not be set and PD bits will not be cleared.
- If the interrupt occurs during or after the execution of a SLEEP instruction, the device will immediately wake-up from SLEEP. The SLEEP instruction will be completely executed before the wake-up. Therefore, the WDT and WDT postscaler will be cleared, the TO bit will be set and the PD bit will be cleared.

Even if the flag bits were checked before executing a SLEEP instruction, it may be possible for flag bits to become set before the SLEEP instruction completes. To determine whether a SLEEP instruction executed, test the PD bit. If the PD bit is set, the SLEEP instruction was executed as a NOP.

To ensure that the WDT is cleared, a CLRWDT instruction should be executed before a SLEEP instruction.

FIGURE 11-11:	WAKE-UP FROM SLEEP THROUGH INTERRUPT

<u>, 01 02 03 04, 01 02 03 04, 01</u>		Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4 (Q1 Q2 Q3 Q4 (Q1 Q2 Q3 Q4
	MAAA				
	Tost(2)		<u> </u>		
INT pin				1	I I
INTE Flag				ı •	
(INTCON<1>)	! :		Interrupt Latency (Note 2)	1 1	1
GIE bit (INTCON<7>) Proce	essor in			1	I
	EEP			1	1
INSTRUCTION FLOW				1	
PC X PC X PC+1 X	PC+2	PC+2	<u> PC + 2</u> χ	0004h X	0005h
Instruction Fetched { Inst(PC) = SLEEP Inst(PC + 1)		Inst(PC + 2)		Inst(0004h)	Inst(0005h)
Instruction { Inst(PC - 1) SLEEP		Inst(PC + 1)	Dummy cycle	Dummy cycle	Inst(0004h)
 Note 1: XT, HS or LP oscillator mode assumed. 2: Tost = 1024Tosc (drawing not to scale). This 	is delav will not be	e there for RC osc	c mode.		
3: GIE = '1' assumed. In this case, after wake-					
If GIE = '0', execution will continue in-line.		for timing referen			

4: CLKOUT is not available in these osc modes, but shown here for timing reference.

11.14 In-Circuit Debugger

When the DEBUG bit in the configuration word is programmed to a '0', the In-Circuit Debugger functionality is enabled. This function allows simple debugging functions when used with MPLAB[®] IDE. When the microcontroller has this feature enabled, some of the resources are not available for general use. Table 11-8 shows which features are consumed by the background debugger.

TABLE 11-8: DEBUGGER RESOURCES	ABLE 11-8:	DEBUGGER RESOURCES
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I/O pins	RB6, RB7
Stack	1 level
Program Memory	Address 0000h must be NOP
	Last 100h words
Data Memory	0x070 (0x0F0, 0x170, 0x1F0) 0x1EB - 0x1EF

To use the In-Circuit Debugger function of the microcontroller, the design must implement In-Circuit Serial Programming connections to $\overline{\text{MCLR}}/\text{VPP}$, VDD, GND, RB7 and RB6. This will interface to the In-Circuit Debugger module available from Microchip or one of the third party development tool companies.

11.15 Program Verification/Code Protection

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

11.16 ID Locations

Four memory locations (2000h - 2003h) are designated as ID locations, where the user can store checksum or other code identification numbers. These locations are not accessible during normal execution, but are readable and writable during program/verify. It is recommended that only the 4 Least Significant bits of the ID location are used.

11.17 In-Circuit Serial Programming

PIC16F872 microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data and three other lines for power, ground, and the programming voltage. This allows customers to manufacture boards with unprogrammed devices, and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

When using ICSP, the part must be supplied 4.5V to 5.5V if a bulk erase will be executed. This includes reprogramming of the code protect, both from an onstate to off-state. For all other cases of ICSP, the part may be programmed at the normal operating voltages. This means calibration values, unique user IDs or user code can be reprogrammed or added.

For complete details of serial programming, please refer to the EEPROM Memory Programming Specification for the PIC16F87X (DS39025).

11.18 Low Voltage ICSP Programming

The LVP bit of the configuration word enables low voltage ICSP programming. This mode allows the microcontroller to be programmed via ICSP, using a VDD source in the operating voltage range. This only means that VPP does not have to be brought to VIHH, but can instead be left at the normal operating voltage. In this mode, the RB3/PGM pin is dedicated to the programming function and ceases to be a general purpose I/O pin. During programming, VDD is applied to the MCLR pin. To enter Programming mode, VDD must be applied to the RB3/PGM pin, provided the LVP bit is set. The LVP bit defaults to on ('1') from the factory.

- Note 1: The High Voltage Programming mode is always available, regardless of the state of the LVP bit, by applying VIHH to the MCLR pin.
 - 2: While in low voltage ICSP mode, the RB3 pin can no longer be used as a general purpose I/O pin.
 - **3:** When using low voltage ICSP programming (LVP) and the pull-ups on PORTB are enabled, bit 3 in the TRISB register must be cleared to disable the pull-up on RB3 and ensure the proper operation of the device.

If Low Voltage Programming mode is not used, the LVP bit can be programmed to a '0' and RB3/PGM becomes a digital I/O pin. However, the LVP bit may only be programmed when programming is entered with VIHH on MCLR. The LVP bit can only be charged when using high voltage on MCLR.

It should be noted that once the LVP bit is programmed to 0, only the High Voltage Programming mode is available and only High Voltage Programming mode can be used to program the device.

When using low voltage ICSP, the part must be supplied 4.5V to 5.5V if a bulk erase will be executed. This includes reprogramming of the code protect bits from an on-state to off-state. For all other cases of low voltage ICSP, the part may be programmed at the normal operating voltage. This means calibration values, unique user IDs, or user code can be reprogrammed or added.

12.0 INSTRUCTION SET SUMMARY

The PIC16 instruction set is highly orthogonal and is comprised of three basic categories:

- Byte-oriented operations
- Bit-oriented operations
- Literal and control operations

Each PIC16 instruction is a 14-bit word divided into an **opcode** which specifies the instruction type, and one or more **operands** which further specify the operation of the instruction. The formats for each of the categories is presented in Figure 12-1, while the various opcode fields are summarized in Table 12-1.

Table 13-2 lists the instructions recognized by the MPASM[™] Assembler. A complete description of each instruction is also available in the PICmicro[™] Mid-Range Reference Manual (DS33023).

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator, which selects the bit affected by the operation, while 'f' represents the address of the file in which the bit is located.

For **literal and control** operations, 'k' represents an eight- or eleven-bit constant or literal value

One instruction cycle consists of four oscillator periods; for an oscillator frequency of 4 MHz, this gives a normal instruction execution time of 1 μ s. All instructions are executed within a single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. When this occurs, the execution takes two instruction cycles with the second cycle executed as a NOP.

Note:	To maintain upward compatibility with
	future PIC16F872 products, do not use the
	OPTION and TRIS instructions.

All instruction examples use the format '0xhh' to represent a hexadecimal number, where 'h' signifies a hexadecimal digit.

12.1 READ-MODIFY-WRITE OPERATIONS

Any instruction that specifies a file register as part of the instruction performs a Read-Modify-Write (R-M-W) operation. The register is read, the data is modified, and the result is stored according to either the instruction or the destination designator 'd'. A read operation is performed on a register even if the instruction writes to that register. For example, a "CLRF PORTB" instruction will read PORTB, clear all the data bits, then write the result back to PORTB. This example would have the unintended result that the condition that sets the RBIF flag would be cleared.

TABLE 12-1: OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1). The assembler will generate code with $x = 0$. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; $d = 0$: store result in W, d = 1: store result in file register f. Default is $d = 1$.
PC	Program Counter
ТО	Time-out bit
PD	Power-down bit

FIGURE 12-1: GENERAL FORMAT FOR INSTRUCTIONS

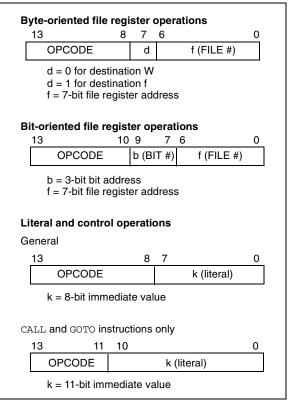


TABLE 12-2: PIC16F872 INSTRUCTION SET

Mnem		Description		14-Bit Opcode		Status	Notes		
Operands		Description		MSb			LSb	Affected	Notes
		BYTE-ORIENTED FILE RE	GISTER OPE	RATIC	NS				
ADDWF	f, d	Add W and f	1	00	0111	dfff	ffff	C,DC,Z	1,2
ANDWF	f, d	AND W with f	1	00	0101	dfff	ffff	Z	1,2
CLRF	f	Clear f	1	00	0001	lfff	ffff	Z	2
CLRW	-	Clear W	1	00	0001	0xxx	xxxx	Z	
COMF	f, d	Complement f	1	00	1001	dfff	ffff	Z	1,2
DECF	f, d	Decrement f	1	00	0011	dfff	ffff	Z	1,2
DECFSZ	f, d	Decrement f, Skip if 0	1(2)	00	1011	dfff	ffff		1,2,3
INCF	f, d	Increment f	1	00	1010	dfff	ffff	Z	1,2
INCFSZ	f, d	Increment f, Skip if 0	1(2)	00	1111	dfff	ffff		1,2,3
IORWF	f, d	Inclusive OR W with f	1	00	0100	dfff	ffff	Z	1,2
MOVF	f, d	Move f	1	00	1000	dfff	ffff	Z	1,2
MOVWF	f	Move W to f	1	00	0000	lfff	ffff		
NOP	-	No Operation	1	00	0000	0xx0	0000		
RLF	f, d	Rotate Left f through Carry	1	00	1101	dfff	ffff	С	1,2
RRF	f, d	Rotate Right f through Carry	1	00	1100	dfff	ffff	С	1,2
SUBWF	f, d	Subtract W from f	1	00	0010	dfff	ffff	C,DC,Z	1,2
SWAPF	f, d	Swap nibbles in f	1	00	1110	dfff	ffff		1,2
XORWF	f, d	Exclusive OR W with f	1	00	0110	dfff	ffff	Z	1,2
		BIT-ORIENTED FILE REC	SISTER OPER	RATION	IS				
BCF	f, b	Bit Clear f	1	01	00bb	bfff	ffff		1,2
BSF	f, b	Bit Set f	1	01	01bb	bfff	ffff		1,2
BTFSC	f, b	Bit Test f, Skip if Clear	1 (2)	01	10bb	bfff	ffff		3
BTFSS	f, b	Bit Test f, Skip if Set	1 (2)	01	11bb	bfff	ffff		3
		LITERAL AND CONTR	ROL OPERAT	IONS					
ADDLW	k	Add literal and W	1	11	111x	kkkk	kkkk	C,DC,Z	
ANDLW	k	AND literal with W	1	11	1001	kkkk	kkkk	Z	
CALL	k	Call subroutine	2	10	0kkk	kkkk	kkkk		
CLRWDT	-	Clear Watchdog Timer	1	00	0000	0110	0100	TO,PD	
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk		
IORLW	k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z	
MOVLW	k	Move literal to W	1	11	00xx	kkkk	kkkk		
RETFIE	-	Return from interrupt	2	00	0000	0000	1001		
RETLW	k	Return with literal in W	2	11	01xx	kkkk	kkkk		
RETURN	-	Return from Subroutine	2	00	0000	0000	1000		
SLEEP	-	Go into Standby mode	1	00	0000	0110	0011	TO,PD	
SUBLW	k	Subtract W from literal	1	11	110x	kkkk	kkkk	C,DC,Z	
XORLW	k	Exclusive OR literal with W	1	11	1010	kkkk	kkkk	Z	
Note 1:	When an	/O register is modified as a function of itself (e	.g., MOVF POI	RTB, I	1), the v	alue use	ed will b	e that value	present

Note 1: When an I/O register is modified as a function of itself (e.g., MOVF PORTB, 1), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 module.

3: If Program Counter (PC) is modified, or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

Note: Additional information on the mid-range instruction set is available in the PICmicro[™] Mid-Range MCU Family Reference Manual (DS33023).

12.2 Instruction Descriptions

ADDLW	Add Literal and W
Syntax:	[<i>label</i>] ADDLW k
Operands:	$0 \le k \le 255$
Operation:	$(W) + k \to (W)$
Status Affected:	C, DC, Z
Description:	The contents of the W register are added to the eight-bit literal 'k' and the result is placed in the W register.

ADDWF	Add W and f
Syntax:	[label] ADDWF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \left[0,1\right] \end{array}$
Operation:	(W) + (f) \rightarrow (destination)
Status Affected:	C, DC, Z
Description:	Add the contents of the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

BCF	Bit Clear f
Syntax:	[<i>label</i>] BCF f,b
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$
Operation:	$0 \rightarrow (f < b >)$
Status Affected:	None
Description:	Bit 'b' in register 'f' is cleared.

BSF	Bit Set f
Syntax:	[<i>label</i>] BSF f,b
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$
Operation:	$1 \rightarrow (f < b >)$
Status Affected:	None
Description:	Bit 'b' in register 'f' is set.

ANDLW	AND Literal with W
Syntax:	[<i>label</i>] ANDLW k
Operands:	$0 \le k \le 255$
Operation:	(W) .AND. (k) \rightarrow (W)
Status Affected:	Z
Description:	The contents of W register are AND'ed with the eight-bit literal 'k'. The result is placed in the W register.

BTFSS	Bit Test f, Skip if Set
Syntax:	[label] BTFSS f,b
Operands:	$0 \le f \le 127$ $0 \le b < 7$
Operation:	skip if (f) = 1
Status Affected:	None
Description:	If bit 'b' in register 'f' is '0', the next instruction is executed. If bit 'b' is '1', then the next instruction is discarded and a NOP is executed instead, making this a $2Tc\gamma$ instruction.

ANDWF	AND W with f
Syntax:	[label] ANDWF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \left[0,1 \right] \end{array}$
Operation:	(W) .AND. (f) \rightarrow (destination)
Status Affected:	Z
Description:	AND the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

BTFSC	Bit Test, Skip if Clear
Syntax:	[label] BTFSC f,b
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$
Operation:	skip if (f) = 0
Status Affected:	None
Description:	If bit 'b' in register 'f' is '1', the next instruction is executed. If bit 'b', in register 'f', is '0', the next instruction is discarded, and a NOP is executed instead, making this a 2TCY instruction.

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CALL	Call Subroutine
Syntax:	[<i>label</i>] CALL k
Operands:	$0 \le k \le 2047$
Operation:	$\begin{array}{l} (PC)+1 \rightarrow TOS, \\ k \rightarrow PC < 10:0>, \\ (PCLATH < 4:3>) \rightarrow PC < 12:11> \end{array}$
Status Affected:	None
Description:	Call Subroutine. First, return address (PC+1) is pushed onto the stack. The eleven-bit immedi- ate address is loaded into PC bits <10:0>. The upper bits of the PC are loaded from PCLATH. CALL is a two-cycle instruction.

CLRWDT	Clear Watchdog Timer
Syntax:	[label] CLRWDT
Operands:	None
Operation: Status Affected:	$\begin{array}{l} 00h \rightarrow WDT \\ 0 \rightarrow WDT \ prescaler, \\ 1 \rightarrow \overline{TO} \\ 1 \rightarrow \overline{PD} \\ \overline{TO}, \ \overline{PD} \end{array}$
Description:	CLRWDT instruction resets the Watchdog Timer. It also resets the prescaler of the WDT. Status bits TO and PD are set.

CLRF	Clear f
Syntax:	[label] CLRF f
Operands:	$0 \le f \le 127$
Operation:	$\begin{array}{l} 00h \rightarrow (f) \\ 1 \rightarrow Z \end{array}$
Status Affected:	Z
Description:	The contents of register 'f' are cleared and the Z bit is set.

COMF	Complement f
Syntax:	[label] COMF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \left[0,1\right] \end{array}$
Operation:	$(\overline{f}) \rightarrow$ (destination)
Status Affected:	Z
Description:	The contents of register 'f' are complemented. If 'd' is 0, the result is stored in W. If 'd' is 1, the result is stored back in register 'f'.

CLRW	Clear W
Syntax:	[label] CLRW
Operands:	None
Operation:	$\begin{array}{l} \text{00h} \rightarrow (\text{W}) \\ 1 \rightarrow \text{Z} \end{array}$
Status Affected:	Z
Description:	W register is cleared. Zero bit (Z) is set.

DECF	Decrement f
Syntax:	[label] DECF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \left[0,1\right] \end{array}$
Operation:	(f) - 1 \rightarrow (destination)
Status Affected:	Z
Description:	Decrement register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

DECFSZ	Decrement f, Skip if 0
Syntax:	[label] DECFSZ f,d
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in \ [0,1] \end{array}$
Operation:	(f) - 1 \rightarrow (destination); skip if result = 0
Status Affected:	None
Description:	The contents of register 'f' are decremented. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'. If the result is 1, the next instruc- tion is executed. If the result is 0, then a NOP is executed instead, making it a 2TCY instruction.

INCFSZ	Increment f, Skip if 0
Syntax:	[label] INCFSZ f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \left[0,1\right] \end{array}$
Operation:	(f) + 1 \rightarrow (destination), skip if result = 0
Status Affected:	None
Description:	The contents of register 'f' are incremented. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'. If the result is 1, the next instruc- tion is executed. If the result is 0, a NOP is executed instead, making it a 2TCY instruction.

GOTO	Unconditional Branch
Syntax:	[<i>label</i>] GOTO k
Operands:	$0 \le k \le 2047$
Operation:	$\label{eq:kappa} \begin{array}{l} k \to PC{<}10{:}0{>} \\ PCLATH{<}4{:}3{>} \to PC{<}12{:}11{>} \end{array}$
Status Affected:	None
Description:	GOTO is an unconditional branch. The eleven-bit immediate value is loaded into PC bits <10:0>. The upper bits of PC are loaded from PCLATH<4:3>. GOTO is a two- cycle instruction.

IORLW	Inclusive OR Literal with W
Syntax:	[<i>label</i>] IORLW k
Operands:	$0 \le k \le 255$
Operation:	(W) .OR. $k \rightarrow$ (W)
Status Affected:	Z
Description:	The contents of the W register are OR'ed with the eight-bit literal 'k'. The result is placed in the W register.

INCF	Increment f	IORWF	Inclusive OR W with f
Syntax:	[<i>label</i>] INCF f,d	Syntax:	[label] IORWF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \left[0,1\right] \end{array}$	Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \left[0,1\right] \end{array}$
Operation:	(f) + 1 \rightarrow (destination)	Operation:	(W) .OR. (f) \rightarrow (destination)
Status Affected:	Z	Status Affected:	Z
Description:	The contents of register 'f' are incremented. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.	Description:	Inclusive OR the W register with register 'f'. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.

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MOVF	Move f
Syntax:	[<i>label</i>] MOVF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \ [0,1] \end{array}$
Operation:	(f) \rightarrow (destination)
Status Affected:	Z
Description:	The contents of register f are moved to a destination dependant upon the status of d. If $d = 0$, destination is W register. If $d = 1$, the destination is file register f itself. d = 1 is useful to test a file register, since status flag Z is affected.

NOP	No Operation
Syntax:	[label] NOP
Operands:	None
Operation:	No operation
Status Affected:	None
Description:	No operation.

MOVLW	Move Literal to W
Syntax:	[<i>label</i>] MOVLW k
Operands:	$0 \le k \le 255$
Operation:	$k \rightarrow (W)$
Status Affected:	None
Description:	The eight-bit literal 'k' is loaded into W register. The don't cares will assemble as 0's.

RETFIE	Return from Interrupt
Syntax:	[label] RETFIE
Operands:	None
Operation:	$\begin{array}{l} TOS \to PC, \\ 1 \to GIE \end{array}$
Status Affected:	None

MOVWF	Move W to f
Syntax:	[label] MOVWF f
Operands:	$0 \le f \le 127$
Operation:	$(W) \to (f)$
Status Affected:	None
Description:	Move data from W register to register 'f'.

RETLW	Return with Literal in W
Syntax:	[<i>label</i>] RETLW k
Operands:	$0 \le k \le 255$
Operation:	$\begin{array}{l} k \rightarrow (W);\\ TOS \rightarrow PC \end{array}$
Status Affected:	None
Description:	The W register is loaded with the eight-bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.

RLF	Rotate Left f through Carry
Syntax:	[<i>label</i>] RLF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \left[0,1\right] \end{array}$
Operation:	See description below
Status Affected:	С
Description:	The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is stored back in register 'f'.

SLEEP

Syntax:	[label] SLEEP
Operands:	None
Operation:	$\begin{array}{l} 00h \rightarrow WDT, \\ 0 \rightarrow \underline{W}DT \text{ prescaler}, \\ 1 \rightarrow \overline{TO}, \\ 0 \rightarrow \overline{PD} \end{array}$
Status Affected:	TO, PD
Description:	The power-down status bit, $\overline{\text{PD}}$ is cleared. Time-out status bit, $\overline{\text{TO}}$ is set. Watchdog Timer and its prescaler are cleared. The processor is put into SLEEP mode with the oscillator stopped.

RETURN	Return from Subroutine
Syntax:	[label] RETURN
Operands:	None
Operation:	$TOS\toPC$
Status Affected:	None
Description:	Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a two-cycle instruction.

SUBLW	Subtract W from Literal
Syntax:	[<i>label</i>] SUBLW k
Operands:	$0 \le k \le 255$
Operation:	$k \text{ - } (W) \to (W)$
Status Affected:	C, DC, Z
Description:	The W register is subtracted (2's complement method) from the eight-bit literal 'k'. The result is placed in the W register.

RRF	Rotate Right f through Carry
Syntax:	[<i>label</i>] RRF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \left[0,1 \right] \end{array}$
Operation:	See description below
Status Affected:	С
Description:	The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.
	C Register f

SUBWF	Subtract W from f
Syntax:	[<i>label</i>] SUBWF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \ [0,1] \end{array}$
Operation:	(f) - (W) \rightarrow (destination)
Status Affected:	C, DC, Z
Description:	Subtract (2's complement method) W register from register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

PIC16F872

SWAPF	Swap Nibbles in f
Syntax:	[<i>label</i>] SWAPF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \ [0,1] \end{array}$
Operation:	$(f<3:0>) \rightarrow (destination<7:4>), (f<7:4>) \rightarrow (destination<3:0>)$
Status Affected:	None
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed in register 'f'.

XORWF	Exclusive OR W with f
Syntax:	[label] XORWF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \left[0,1\right] \end{array}$
Operation:	(W) .XOR. (f) \rightarrow (destination)
Status Affected:	Z
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

XORLW	Exclusive OR Literal with W
Syntax:	[<i>label</i>] XORLW k
Operands:	$0 \le k \le 255$
Operation:	(W) .XOR. $k \rightarrow (W)$
Status Affected:	Z
Description:	The contents of the W register are XOR'ed with the eight-bit lit- eral 'k'. The result is placed in the W register.

13.0 DEVELOPMENT SUPPORT

The PICmicro[®] microcontrollers are supported with a full range of hardware and software development tools:

- Integrated Development Environment
 - MPLAB® IDE Software
- Assemblers/Compilers/Linkers
 - MPASM[™] Assembler
 - MPLAB C17 and MPLAB C18 C Compilers
 - MPLINK[™] Object Linker/ MPLIB[™] Object Librarian
- Simulators
 - MPLAB SIM Software Simulator
- Emulators
 - MPLAB ICE 2000 In-Circuit Emulator
 - ICEPIC™ In-Circuit Emulator
- In-Circuit Debugger
 - MPLAB ICD
- Device Programmers
 - PRO MATE® II Universal Device Programmer
- PICSTART[®] Plus Entry-Level Development Programmer
- Low Cost Demonstration Boards
 - PICDEM[™] 1 Demonstration Board
 - PICDEM 2 Demonstration Board
 - PICDEM 3 Demonstration Board
 - PICDEM 17 Demonstration Board
 - KEELOQ[®] Demonstration Board

13.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8-bit microcontroller market. The MPLAB IDE is a Windows[®]-based application that contains:

- An interface to debugging tools
 - simulator
 - programmer (sold separately)
 - emulator (sold separately)
 - in-circuit debugger (sold separately)
- A full-featured editor
- A project manager
- Customizable toolbar and key mapping
- · A status bar
- On-line help

The MPLAB IDE allows you to:

- Edit your source files (either assembly or 'C')
- One touch assemble (or compile) and download to PICmicro emulator and simulator tools (automatically updates all project information)
- Debug using:
 - source files
 - absolute listing file
 - machine code

The ability to use MPLAB IDE with multiple debugging tools allows users to easily switch from the costeffective simulator to a full-featured emulator with minimal retraining.

13.2 MPASM Assembler

The MPASM assembler is a full-featured universal macro assembler for all PICmicro MCU's.

The MPASM assembler has a command line interface and a Windows shell. It can be used as a stand-alone application on a Windows 3.x or greater system, or it can be used through MPLAB IDE. The MPASM assembler generates relocatable object files for the MPLINK object linker, Intel[®] standard HEX files, MAP files to detail memory usage and symbol reference, an absolute LST file that contains source lines and generated machine code, and a COD file for debugging.

The MPASM assembler features include:

- Integration into MPLAB IDE projects.
- User-defined macros to streamline assembly code.
- Conditional assembly for multi-purpose source files.
- Directives that allow complete control over the assembly process.

13.3 MPLAB C17 and MPLAB C18 C Compilers

The MPLAB C17 and MPLAB C18 Code Development Systems are complete ANSI 'C' compilers for Microchip's PIC17CXXX and PIC18CXXX family of microcontrollers, respectively. These compilers provide powerful integration capabilities and ease of use not found with other compilers.

For easier source level debugging, the compilers provide symbol information that is compatible with the MPLAB IDE memory display.

13.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK object linker combines relocatable objects created by the MPASM assembler and the MPLAB C17 and MPLAB C18 C compilers. It can also link relocatable objects from pre-compiled libraries, using directives from a linker script.

The MPLIB object librarian is a librarian for precompiled code to be used with the MPLINK object linker. When a routine from a library is called from another source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications. The MPLIB object librarian manages the creation and modification of library files.

The MPLINK object linker features include:

- Integration with MPASM assembler and MPLAB C17 and MPLAB C18 C compilers.
- Allows all memory areas to be defined as sections to provide link-time flexibility.

The MPLIB object librarian features include:

- Easier linking because single libraries can be included instead of many smaller files.
- Helps keep code maintainable by grouping related modules together.
- Allows libraries to be created and modules to be added, listed, replaced, deleted or extracted.

13.5 MPLAB SIM Software Simulator

The MPLAB SIM software simulator allows code development in a PC-hosted environment by simulating the PICmicro series microcontrollers on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a file, or user-defined key press, to any of the pins. The execution can be performed in single step, execute until break, or trace mode.

The MPLAB SIM simulator fully supports symbolic debugging using the MPLAB C17 and the MPLAB C18 C compilers and the MPASM assembler. The software simulator offers the flexibility to develop and debug code outside of the laboratory environment, making it an excellent multiproject software development tool.

13.6 MPLAB ICE High Performance Universal In-Circuit Emulator with MPLAB IDE

The MPLAB ICE universal in-circuit emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PICmicro microcontrollers (MCUs). Software control of the MPLAB ICE in-circuit emulator is provided by the MPLAB Integrated Development Environment (IDE), which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICE 2000 is a full-featured emulator system with enhanced trace, trigger and data monitoring features. Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the MPLAB ICE in-circuit emulator allows expansion to support new PICmicro microcontrollers.

The MPLAB ICE in-circuit emulator system has been designed as a real-time emulation system, with advanced features that are generally found on more expensive development tools. The PC platform and Microsoft[®] Windows environment were chosen to best make these features available to you, the end user.

13.7 ICEPIC In-Circuit Emulator

The ICEPIC low cost, in-circuit emulator is a solution for the Microchip Technology PIC16C5X, PIC16C6X, PIC16C7X and PIC16CXXX families of 8-bit One-Time-Programmable (OTP) microcontrollers. The modular system can support different subsets of PIC16C5X or PIC16CXXX products through the use of interchangeable personality modules, or daughter boards. The emulator is capable of emulating without target application circuitry being present.

13.8 MPLAB ICD In-Circuit Debugger

Microchip's In-Circuit Debugger, MPLAB ICD, is a powerful, low cost, run-time development tool. This tool is based on the FLASH PICmicro MCUs and can be used to develop for this and other PICmicro microcontrollers. The MPLAB ICD utilizes the in-circuit debugging capability built into the FLASH devices. This feature, along with Microchip's In-Circuit Serial Programming[™] protocol, offers cost-effective in-circuit FLASH debugging from the graphical user interface of the MPLAB Integrated Development Environment. This enables a designer to develop and debug source code by watching variables, single-stepping and setting break points. Running at full speed enables testing hardware in realtime.

13.9 PRO MATE II Universal Device Programmer

The PRO MATE II universal device programmer is a full-featured programmer, capable of operating in stand-alone mode, as well as PC-hosted mode. The PRO MATE II device programmer is CE compliant.

The PRO MATE II device programmer has programmable VDD and VPP supplies, which allow it to verify programmed memory at VDD min and VDD max for maximum reliability. It has an LCD display for instructions and error messages, keys to enter commands and a modular detachable socket assembly to support various package types. In stand-alone mode, the PRO MATE II device programmer can read, verify, or program PICmicro devices. It can also set code protection in this mode.

13.10 PICSTART Plus Entry Level Development Programmer

The PICSTART Plus development programmer is an easy-to-use, low cost, prototype programmer. It connects to the PC via a COM (RS-232) port. MPLAB Integrated Development Environment software makes using the programmer simple and efficient.

The PICSTART Plus development programmer supports all PICmicro devices with up to 40 pins. Larger pin count devices, such as the PIC16C92X and PIC17C76X, may be supported with an adapter socket. The PICSTART Plus development programmer is CE compliant.

13.11 PICDEM 1 Low Cost PICmicro Demonstration Board

The PICDEM 1 demonstration board is a simple board which demonstrates the capabilities of several of Microchip's microcontrollers. The microcontrollers supported are: PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44, All necessary hardware and software is included to run basic demo programs. The user can program the sample microcontrollers provided with the PICDEM 1 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer, and easily test firmware. The user can also connect the PICDEM 1 demonstration board to the MPLAB ICE incircuit emulator and download the firmware to the emulator for testing. A prototype area is available for the user to build some additional hardware and connect it to the microcontroller socket(s). Some of the features include an RS-232 interface, a potentiometer for simulated analog input, push button switches and eight LEDs connected to PORTB.

13.12 PICDEM 2 Low Cost PIC16CXX Demonstration Board

The PICDEM 2 demonstration board is a simple demonstration board that supports the PIC16C62, PIC16C64, PIC16C65, PIC16C73 and PIC16C74 microcontrollers. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM 2 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer, and easily test firmware. The MPLAB ICE in-circuit emulator may also be used with the PICDEM 2 demonstration board to test firmware. A prototype area has been provided to the user for adding additional hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push button switches, a potentiometer for simulated analog input, a serial EEPROM to demonstrate usage of the I²C[™] bus and separate headers for connection to an LCD module and a keypad.

13.13 PICDEM 3 Low Cost PIC16CXXX Demonstration Board

The PICDEM 3 demonstration board is a simple demonstration board that supports the PIC16C923 and PIC16C924 in the PLCC package. It will also support future 44-pin PLCC microcontrollers with an LCD Module. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM 3 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer with an adapter socket, and easily test firmware. The MPLAB ICE in-circuit emulator may also be used with the PICDEM 3 demonstration board to test firmware. A prototype area has been provided to the user for adding hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push button switches, a potentiometer for simulated analog input, a thermistor and separate headers for connection to an external LCD module and a keypad. Also provided on the PICDEM 3 demonstration board is a LCD panel, with 4 commons and 12 segments, that is capable of displaying time, temperature and day of the week. The PICDEM 3 demonstration board provides an additional RS-232 interface and Windows software for showing the demultiplexed LCD signals on a PC. A simple serial interface allows the user to construct a hardware demultiplexer for the LCD signals.

13.14 PICDEM 17 Demonstration Board

The PICDEM 17 demonstration board is an evaluation board that demonstrates the capabilities of several Microchip microcontrollers, including PIC17C752, PIC17C756A, PIC17C762 and PIC17C766. All necessary hardware is included to run basic demo programs, which are supplied on a 3.5-inch disk. A programmed sample is included and the user may erase it and program it with the other sample programs using the PRO MATE II device programmer, or the PICSTART Plus development programmer, and easily debug and test the sample code. In addition, the PICDEM 17 demonstration board supports downloading of programs to and executing out of external FLASH memory on board. The PICDEM 17 demonstration board is also usable with the MPLAB ICE in-circuit emulator, or the PICMASTER emulator and all of the sample programs can be run and modified using either emulator. Additionally, a generous prototype area is available for user hardware.

13.15 KEELOQ Evaluation and Programming Tools

KEELOQ evaluation and programming tools support Microchip's HCS Secure Data Products. The HCS evaluation kit includes a LCD display to show changing codes, a decoder to decode transmissions and a programming interface to program test transmitters.

TABLE 13-1: DEVELOPMENT TOOLS FROM MICROCHIP

MPLAB® Integrated Development Environment MPLAB® C17 C compiler MPLAB® C18 Linker MPLAB® ICE In-Circuit Emulator ICEPIC™ In-Circuit Emulator NPLAB® ICD In-Circuit Emulator Debugger Debugger Development Programmer PRO MATE® IL Development Programmer PRO MATE® IL Development Programmer PRO MATE® IL Development Programmer Development Programmer PRO MATE® IL Development Programmer			> > > > > >				> >				
MPLAB® C17 C Compiler MPLAB® C17 C Compiler MPLAB® C18 C Compiler MPLAB® C18 C Compiler MPLAB® C18 C Compiler V V V V MPLAB® C18 C Compiler MPLAB® C18 C Compiler V V V V V MPLAB® ICE In-circuit Emulator V V V V V V+ V+ ICEPIC™ In-Circuit Emulator V V V V V V+ V+ MPLAB® ICD In-Circuit Emulator V V V V V+ V+ V+ V+ MPLAB® ICD In-Circuit Emulator V V V V V+											
MPLAB® C18 C compiler MPLAB® C18 C compiler/ MPLAB® C18 C compiler/ MPLAB® c18 C compiler/ MPLAB® C18 C compiler/ MPLAB MPLAB							>				
MPASM™ Assembler/ MPLINK™ Object Linker	> > > > > 5 1		> > > > >								
MPLAB® ICE In-Circuit Emulator <			> > > >				>	`	>		
ICEPIC™ In-Circuit Emulator ✓ ✓ ✓ ✓ MPLAB® ICD In-Circuit ✓ ✓ ✓ ✓ Debugger ✓ ✓ ✓ ✓ ✓ Debugger ✓ ✓ ✓ ✓ ✓ ✓ Debugger ✓ ✓ ✓ ✓ ✓ ✓ ✓ PRO MATE® IL ✓	> > > 5 > 5 >		> >				>				
MPLAB® ICD In-Circuit * * * Debugger * * * * PICSTART® Plus Entry Level * * * * Development Programmer * * * * * PRO MATE® II * * * * * * PRO MATE® II * * * * * * * PRO MATE® II * * * * * * * * PRO MATE® II * <	<u> </u>		<u> </u>								
PICSTART® Plus Entry Level Development Programmer PRO MATE® II PRO MATE® II <t< th=""><th>× × *</th><th></th><th>> ></th><th></th><th></th><th></th><th>></th><th></th><th></th><th></th><th></th></t<>	× × *		> >				>				
PRO MATE® II / / / // Universal Device Programmer / / / // PICDEMTM 1 Demonstration / / / // PICDEMTM 2 Demonstration / / / // // PICDEMTM 3 Demonstration / / / // // // PICDEMTM 3 Demonstration / / // // // // //	> + ·		>			>	>				
PICDEM TM 1 Demonstration Board PICDEM TM 2 Demonstration Board PICDEM TM 3 Demonstration Board PICDEM TM 14 Demonstration	· +	>				>	>	>	>		
PICDEM TM 2 Demonstration Board PICDEM TM 3 Demonstration Board PICDEM TM 14A Demonstration					>						
PICDEM TM 3 Demonstration Board PICDEM TM 14A Demonstration						>	>				
PICDEM TM 14A Demonstration				>							
년 PICDEM TM 17 Demonstration B Board					>						
S KEELoo® Evaluation Kit									>		
KEELoa® Transponder Kit									>		
nicrolD TM Programmer's Kit										>	
Developer's Kit										>	
125 kHz Anticollision microlD TM Developer's Kit										>	
13.56 MHz Anticollision microlD™ Developer's Kit										>	
MCP2510 CAN Developer's Kit											>

 $\ensuremath{\textcircled{}^{\odot}}$ 2006 Microchip Technology Inc.

NOTES:

14.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †	Absolute	Maximum	Ratings †	
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Ambient temperature under bias	55 to +125°C
Storage temperature	
Voltage on any pin with respect to Vss (except VDD, MCLR. and RA4)	
Voltage on VDD with respect to Vss	
Voltage on MCLR with respect to Vss (Note 2)	
Voltage on RA4 with respect to Vss	
Total power dissipation (Note 1)	
Maximum current out of Vss pin	
Maximum current into VDD pin	
Input clamp current, Iк (VI < 0 or VI > VDD)	
Output clamp current, Iок (Vo < 0 or Vo > VDD)	
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA and PORTB	
Maximum current sourced by PORTA and PORTB	200 mA
Maximum current sunk by PORTC	200 mA
Maximum current sourced by PORTC	200 mA
Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD - \sum IOH} + \sum {(VDD -	• VOH) x IOH} + Σ (VOI x IOL)
2: Voltage spikes below Vss at the $\overline{\text{MCLR}}$ pin, inducing currents greater than 80 mA a series resistor of 50-100 Ω should be used when applying a "low" level to the $\overline{\text{MO}}$ this pin directly to Vss.	

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

PIC16F872



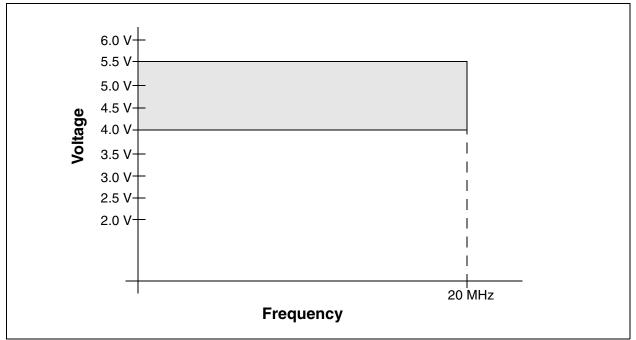
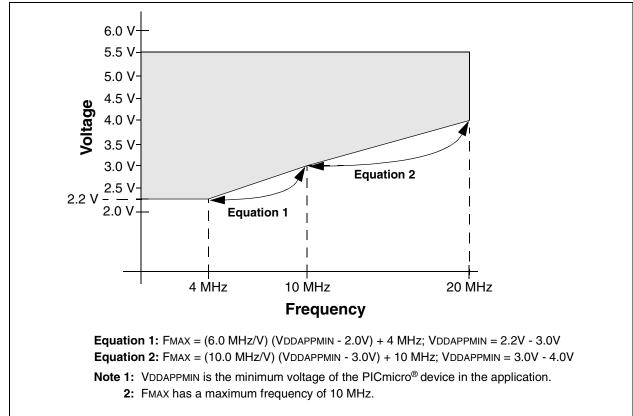


FIGURE 14-2: PIC16LF872 VOLTAGE-FREQUENCY GRAPH



14.1 DC Characteristics: PIC16F872 (Commercial, Industrial) PIC16LF872 (Commercial, Industrial)

PIC16LF	PIC16LF872 (Commercial, Industrial)		Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le Ta \le +85^{\circ}C$ for industrial $0^{\circ}C \le Ta \le +70^{\circ}C$ for commercial					
PIC16F8	872 (Comn	nercial, Industrial)		ard Ope ting terr		re -40	ions (unless otherwise stated) $0^{\circ}C \le TA \le +85^{\circ}C$ for industrial $0^{\circ}C \le TA \le +70^{\circ}C$ for commercial	
Param No.	Symbol	Characteristic/ Device	Min	Тур†	Max	Units	Conditions	
	Vdd	Supply Voltage						
D001		PIC16LF872	2.2	—	5.5	V	LP,XT,RC osc configuration (DC to 4 MHz)	
D001		PIC16F872	4.0	—	5.5	V	LP, XT, RC osc configuration	
D001A		PIC16LF872	4.5		5.5	V	HS osc configuration	
D001A		PIC16F872	VBOR		5.5	V	BOR enabled, FMAX = 14 MHz ⁽⁷⁾	
D002	Vdr	RAM Data Retention Voltage ⁽¹⁾	_	1.5	—	V		
D003	VPOR	VDD Start Voltage to ensure internal Power-on Reset signal	_	Vss	—	V	See section on Power-on Reset for details	
D004	SVDD	VDD Rise Rate to ensure internal Power-on Reset signal	0.05		_	V/ms	See section on Power-on Reset for details	
D005	VBOR	Brown-out Reset Voltage	3.7	4.0	4.35	V	BODEN bit in configuration word enabled	
	Idd	Supply Current ^(2,5)						
D010		PIC16LF872	_	0.6	2.0	mA	XT, RC osc configuration FOSC = 4 MHz, VDD = $3.0V$	
D010		PIC16F872		1.6	4	mA	RC osc configurations FOSC = 4 MHz, VDD = 5.5V	
D010A		PIC16LF872		20	35	μA	LP osc configuration FOSC = 32 kHz, VDD = 3.0V, WDT disabled	
D013		PIC16F872	_	7	15	mA	HS osc configuration, Fosc = 20 MHz, VDD = 5.5V	

Legend: Rows with standard voltage device data only are shaded for improved readability.

† Data is "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.

- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD \overline{MCLR} = VDD; WDT enabled/disabled as specified.

- **3:** The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and VSS.
- 4: For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kOhm.
- 5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.
- 6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.
- 7: When BOR is enabled, the device will operate correctly until the VBOR voltage trip point is reached.

14.1 DC Characteristics: PIC16F872 (Commercial, Industrial) PIC16LF872 (Commercial, Industrial) (Continued)

PIC16LF	PIC16LF872 (Commercial, Industrial)				$\begin{array}{llllllllllllllllllllllllllllllllllll$							
PIC16F8	872 (Comn	nercial, Industrial)		Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial $0^{\circ}C \le TA \le +70^{\circ}C$ for commercial								
Param No.	Symbol	Characteristic/ Device	Min	Тур†	Max	Units	Conditions					
D015	∆IBOR	Brown-out Reset Current ⁽⁶⁾		85	200	μA	BOR enabled, VDD = 5.0V					
	IPD	Power-down Current ^(3,5)										
D020		PIC16LF872	_	7.5	30	μA	VDD = 3.0V, WDT enabled, -40°C to +85°C					
D020		PIC16F872	_	10.5	42	μA	VDD = 4.0V, WDT enabled, -40°C to +85°C					
D021		PIC16LF872	_	0.9	5	μA	VDD = 3.0V, WDT disabled, 0°C to +70°C					
D021		PIC16F872	_	1.5	16	μA	VDD = 4.0V, WDT disabled, -40°C to +85°C					
D021A		PIC16LF872		0.9	5	μA	VDD = 3.0V, WDT disabled, -40°C to +85°C					
D021A		PIC16F872		1.5	19	μA	VDD = 4.0V, WDT disabled, -40°C to +85°C					
D023	∆IBOR	Brown-out Reset Current ⁽⁶⁾		85	200	μA	BOR enabled, VDD = 5.0V					

Legend: Rows with standard voltage device data only are shaded for improved readability.

- † Data is "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.
- **Note 1:** This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD

MCLR = VDD; WDT enabled/disabled as specified.

- **3:** The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and VSS.
- 4: For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kOhm.
- **5:** Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.
- 6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.
- 7: When BOR is enabled, the device will operate correctly until the VBOR voltage trip point is reached.

14.2 DC Characteristics: PIC16F872 (Commercial, Industrial) PIC16LF872 (Commercial, Industrial)

DC CHA	RACTE	RISTICS	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial $0^{\circ}C \le TA \le +70^{\circ}C$ for commercialOperating voltage VDD range as described in DC specification(Section 14.1)						
Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions		
	VIL	Input Low Voltage							
		I/O ports:							
D030		with TTL buffer	Vss	-	0.15VDD	V	For entire VDD range		
D030A			Vss	-	0.8V	V	$4.5V \le VDD \le 5.5V$		
D031		with Schmitt Trigger buffer	Vss	-	0.2VDD	V			
D032		MCLR, OSC1 (in RC mode)	Vss	-	0.2VDD	V			
D033		OSC1 (in XT, HS and LP modes)	Vss	-	0.3VDD	V	(Note 1)		
		Ports RC3 and RC4:							
D034		with Schmitt Trigger buffer	Vss	-	0.3VDD	V	For entire VDD range		
D034A		with SMBus	-0.5	-	0.6	V	for VDD = 4.5 to 5.5 V		
	VIH	Input High Voltage							
		I/O ports:		-					
D040		with TTL buffer	2.0	-	VDD	V	$4.5V \le VDD \le 5.5V$		
D040A			0.25Vdd + 0.8V	-	Vdd	V	For entire VDD range		
D041		with Schmitt Trigger buffer	0.8Vdd	-	VDD	V	For entire VDD range		
D042		MCLR	0.8Vdd	-	VDD	V			
D042A		OSC1 (XT, HS and LP modes)	0.7Vdd	-	Vdd	V	(Note 1)		
D043		OSC1 (in RC mode) Ports RC3 and RC4:	0.9Vdd	-	Vdd	V			
D044		with Schmitt Trigger buffer	0.7Vdd	-	VDD	v	For entire VDD range		
D044A		with SMBus	1.4	-	5.5	v	for VDD = 4.5 to $5.5V$		
D070	IPURB	PORTB Weak Pull-up Current	50	250	400	μA	VDD = 5V, VPIN = VSS, -40°C TO +85°C		
	lı∟	Input Leakage Current ^(2, 3)							
D060		I/O ports	-	-	±1	μA	$Vss \le VPIN \le VDD,$ Pin at hi-impedance		
D061		MCLR, RA4/T0CKI	-	-	±5	μA	$Vss \leq VPIN \leq VDD$		
D063		OSC1	-	-	±5	μA	Vss \leq VPIN \leq VDD, XT, HS and LP osc configuration		

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16F872 be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

14.2 DC Characteristics: PIC16F872 (Commercial, Industrial) PIC16LF872 (Commercial, Industrial) (Continued)

DC CHA	ARACTE	RISTICS	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial $0^{\circ}C \le TA \le +70^{\circ}C$ for commercialOperating voltage VDD range as described in DC specification						
Param No.	Sym	Characteristic	(Section 14.1) Min Typ† Max U		Units	Conditions			
	Vol	Output Low Voltage							
D080	VOL	I/O ports	-	-	0.6	v	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C		
D083		OSC2/CLKOUT (RC osc config)	-	-	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C		
	Vон	Output High Voltage							
D090		I/O ports ⁽³⁾	Vdd - 0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5V, -40°C to +85°C		
D092		OSC2/CLKOUT (RC osc config)	Vdd - 0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5V, -40°С to +85°С		
D150*	Vod	Open Drain High Voltage	-	-	8.5	V	RA4 pin		
D100	Cosc2	Capacitive Loading Specs on Output Pins OSC2 pin	-	-	15	pF	In XT, HS and LP modes when external clock is used to drive		
							OSC1		
D101	Cio	All I/O pins and OSC2 (RC	-	-	50	pF			
D102	Св	mode) SCL, SDA (I ² C mode)	-	-	400	pF			
D120	ED	Data EEPROM Memory Endurance	100K			E/W	25°C at 5V		
D120 D121	VDRW	VDD for read/write	VMIN	-	- 5.5	V	Using EECON to read/write		
D122	TDEW	Erase/write cycle time	-	4	8	ms			
		Program FLASH Memory							
D130	Ер	Endurance	1000	-	-	E/W	25°C at 5V		
D131	VPR	VDD for read	VMIN	-	5.5	V	Vmin = min operating voltage		
D132A		VDD for erase/write	VMIN	-	5.5	V	Using EECON to read/write, VMIN = min. operating voltage		
D133	TPEW	Erase/Write cycle time	-	4	8	ms			

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16F872 be driven with external clock in RC mode.

The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 Negative surrent is defined as surrent expressed by the pin.

3: Negative current is defined as current sourced by the pin.

PIC16F87	2 (Extend	ed)	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +125^{\circ}C$						
Param No.	Symbol	Characteristic/ Device	Min	Тур†	Max	Units	Conditions		
	Vdd	Supply Voltage							
D001			4.0	—	5.5	V	LP, XT, RC osc configuration		
D001A			4.5		5.5	V	HS osc configuration		
D001A			VBOR		5.5	V	BOR enabled, FMAX = 14 MHz ⁽⁷⁾		
D002	Vdr	RAM Data Retention Voltage ⁽¹⁾	—	1.5	—	V			
D003	VPOR	VDD Start Voltage to ensure internal Power-on Reset signal	—	Vss		V	See section on Power-on Reset for details		
D004	SVDD	VDD Rise Rate to ensure internal Power-on Reset signal	0.05	_		V/ms	See section on Power-on Reset for details		
D005	VBOR	Brown-out Reset Voltage	3.7	4.0	4.35	V	BODEN bit in configuration word enabled		
	IDD	Supply Current ^(2,5)							
D010			_	1.6	4	mA	RC osc configurations Fosc = 4 MHz, VDD = 5.5V		
D013			_	7	15	mA	HS osc configuration, Fosc = 20 MHz, VDD = 5.5V		
D015	ΔIBOR	Brown-out Reset Current ⁽⁶⁾	—	85	200	μA	BOR enabled, VDD = 5.0V		
	IPD	Power-down Current ^(3,5)							
D020A				10.5	60	μA	VDD = 4.0V, WDT enabled		
D021B				1.5	30	μA	VDD = 4.0V, WDT disabled		
D023	Δ IBOR	Brown-out Reset Current ⁽⁶⁾	—	85	200	μA	BOR enabled, VDD = 5.0V		

14.3 DC Characteristics: PIC16F872 (Extended)

† Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

- 2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:
 - OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD \overline{MCLR} = VDD; WDT enabled/disabled as specified.
- **3:** The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
- 4: For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kOhm.
- **5:** Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.
- 6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.
- 7: When BOR is enabled, the device will operate correctly until the VBOR voltage trip point is reached.

14.4 DC Characteristics: PIC16F872 (Extended)

DC CHA	DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}C \le TA \le +125^{\circ}C$ Operating voltage VDD range as described in DC specification (Section 14.1)						
Param No.	Sym	Characteristic Min Typ† Max Un		Units	its Conditions					
	VIL	Input Low Voltage								
		I/O ports:								
D030		with TTL buffer	Vss	-	0.15VDD	V	For entire VDD range			
D030A			Vss	-	0.8V	V	$4.5V \le VDD \le 5.5V$			
D031		with Schmitt Trigger buffer	Vss	-	0.2VDD	V				
D032		MCLR, OSC1 (in RC mode)	Vss	-	0.2Vdd	V				
D033		OSC1 (in XT, HS and LP modes)	Vss	-	0.3VDD	V	(Note1)			
		Ports RC3 and RC4:								
D034		with Schmitt Trigger buffer	Vss	-	0.3VDD	V	For entire VDD range			
D034A		with SMBus	-0.5	-	0.6	V	for VDD = 4.5 to 5.5V			
	Viн	Input High Voltage								
		I/O ports:		-						
D040		with TTL buffer	2.0	-	Vdd	V	$4.5V \le VDD \le 5.5V$			
D040A			0.25Vdd + 0.8V	-	Vdd	V	For entire VDD range			
D041		with Schmitt Trigger buffer	0.8VDD	-	Vdd	V	For entire VDD range			
D042		MCLR	0.8VDD	-	Vdd	V				
D042A		OSC1 (XT, HS and LP modes)	0.7Vdd	-	Vdd	V	(Note1)			
D043		OSC1 (in RC mode)	0.9Vdd	-	Vdd	V				
		Ports RC3 and RC4:								
D044		with Schmitt Trigger buffer	0.7Vdd	-	Vdd	V	For entire VDD range			
D044A		with SMBus	1.4	-	5.5	V	for VDD = 4.5 to 5.5V			
D070A	IPURB	PORTB Weak Pull-up Current	50	300	500	μA	VDD = 5V, $VPIN = VSS$,			
	lı∟	Input Leakage Current ^(2, 3)								
D060		I/O ports	-	-	±1	μA	$Vss \leq VPIN \leq VDD$,			
							Pin at hi-impedance			
D061		MCLR, RA4/T0CKI	-	-	±5	μA	$Vss \le VPIN \le VDD$			
D063		OSC1	-	-	±5	μA	Vss \leq VPIN \leq VDD, XT, HS and LP osc configuration			

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16F872 be driven with external clock in RC mode.

The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 Negative surrent is defined as surrent sourced by the pin.

3: Negative current is defined as current sourced by the pin.

14.4	DC Characteristics:	PIC16F872	(Extended)	(Continued)
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DC CHA	DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}C \le TA \le +125^{\circ}C$ Operating voltage VDD range as described in DC specification (Section 14.1)							
Param No. Sym		Characteristic	Min	Тур†	Мах	Units	Conditions				
	Vol	Output Low Voltage									
D080A		I/O Ports			0.6	V	IOL =2.5 mA, VDD = 4.5V				
D083A		OSC2/CLKOUT (RC osc config)			0.6	V	IOL = 1.2 mA, VDD = 4.5V				
	Vон	Output High Voltage									
D090A		I/O ports ⁽³⁾	Vdd - 0.7	-	-	V	IOH = -2.5 mA, VDD = 4.5V				
D092A		OSC2/CLKOUT (RC osc config)	Vdd - 0.7	-	-	V	IOH = -1.0 mA, VDD = 4.5V				
D150*	Vod	Open Drain High Voltage	-	-	8.5	V	RA4 pin				
		Capacitive Loading Specs on Output Pins									
D100	Cosc2	OSC2 pin	-	-	15	pF	In XT, HS and LP modes when external clock is used to drive OSC1				
D101	Сю	All I/O pins and OSC2 (RC mode)	-	-	50	pF					
D102	Св	SCL, SDA (I ² C mode)	-	-	400	pF					
		Data EEPROM Memory									
D120	ED	Endurance	100K	-	-	E/W	25°C at 5V				
D121	Vdrw	VDD for read/write	Vmin	-	5.5	V	Using EECON to read/write VMIN = min. operating voltage				
D122	TDEW	Erase/write cycle time	-	4	8	ms					
		Program FLASH Memory									
D130	Eр	Endurance	1000	-	-	E/W	25°C at 5V				
D131	Vpr	VDD for read	VMIN	-	5.5	V	VMIN = min. operating voltage				
D132A		VDD for erase/write	Vmin	-	5.5	V	Using EECON to read/write, VMIN = min. operating voltage				
D133	TPEW	Erase/Write cycle time	-	4	8	ms					

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16F872 be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

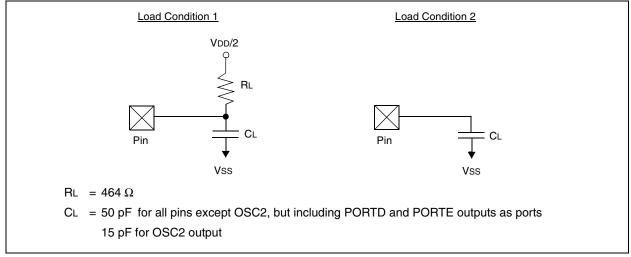
3: Negative current is defined as current sourced by the pin.

14.5 Timing Parameter Symbology

The timing parameter symbols have been created following one of the following formats:

1. TppS2p	pS	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	Т	Time
Lowerca	ase letters (pp) and their meanings:		
рр			
сс	CCP1	osc	OSC1
ck	CLKOUT	rd	RD
CS	CS	rw	RD or WR
di	SDI	SC	SCK
do	SDO	SS	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Upperca	ase letters and their meanings:		
S			
F	Fall	Р	Period
н	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
Tcc:st (I ² C specifications only)		
CC	· · ·		
HD	Hold	SU	Setup
ST			-
DAT	DATA input hold	STO	STOP condition
STA	START condition		

FIGURE 14-3: LOAD CONDITIONS



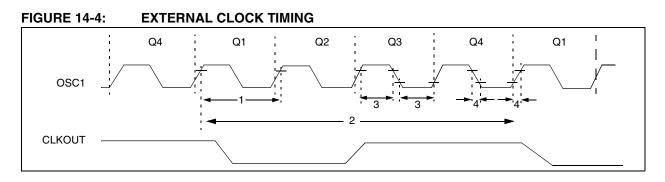


TABLE 14-1: EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	Fosc	External CLKIN Frequency	DC		4	MHz	XT and RC osc mode
		(Note 1)	DC	_	4	MHz	HS osc mode (-04)
			DC	_	20	MHz	HS osc mode (-20)
			DC	_	200	kHz	LP osc mode
		Oscillator Frequency	DC		4	MHz	RC osc mode
		(Note 1)	0.1	_	4	MHz	XT osc mode
			4	_	20	MHz	HS osc mode
			5	_	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250		—	ns	XT and RC osc mode
		(Note 1)	250	—		ns	HS osc mode (-04)
			50	—		ns	HS osc mode (-20)
			5	—		μs	LP osc mode
		Oscillator Period	250	_		ns	RC osc mode
		(Note 1)	250	—	10,000	ns	XT osc mode
			250	—	250	ns	HS osc mode (-04)
			50	_	250	ns	HS osc mode (-20)
			5	_		μs	LP osc mode
2	Тсү	Instruction Cycle Time (Note 1)	200	Тсү	DC	ns	Tcy = 4/Fosc
3	TosL,	External Clock in (OSC1) High or	100			ns	XT oscillator
	TosH	Low Time	2.5	—	_	μs	LP oscillator
			15	—	—	ns	HS oscillator
4	TosR,	External Clock in (OSC1) Rise or	_	_	25	ns	XT oscillator
	TosF	Fall Time	—	—	50	ns	LP oscillator
			—	—	15	ns	HS oscillator

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "Min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.



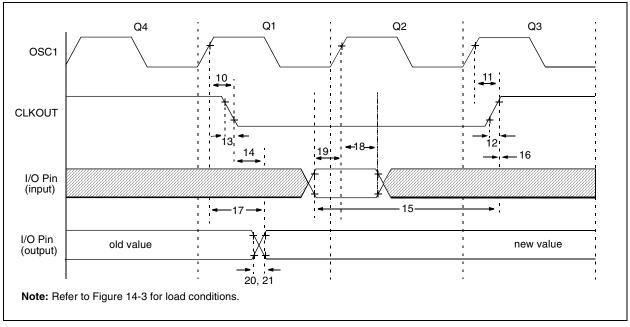


TABLE 14-2: CLKOUT AND I/O TIMING REQUIREMENTS

Param No.	Symbol	Character	Characteristic		Тур†	Мах	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓		_	75	200	ns	(Note 1)
11*	TosH2ckH	OSC1 [↑] to CLKOUT [↑]		—	75	200	ns	(Note 1)
12*	TckR	CLKOUT rise time		_	35	100	ns	(Note 1)
13*	TckF	CLKOUT fall time		_	35	100	ns	(Note 1)
14*	TckL2ioV	CLKOUT↓ to Port out valid		_	_	0.5TCY + 20	ns	(Note 1)
15*	TioV2ckH	Port in valid before CLKOUT↑		Tosc + 200	_	_	ns	(Note 1)
16*	TckH2iol	Port in hold after CLKOUT↑		0		_	ns	(Note 1)
17*	TosH2ioV	OSC1 [↑] (Q1 cycle) to Port out valid		_	100	255	ns	
18*	TosH2iol	OSC1 [↑] (Q2 cycle) to Port	Standard (F)	100	_	_	ns	
		input invalid (I/O in hold time)	Extended (LF)	200		_	ns	
19*	TioV2osH	Port input valid to OSC1 [↑] (I/O	in setup time)	0		_	ns	
20*	TIOR	Port output rise time	Standard (F)	_	10	40	ns	
			Extended (LF)	_		145	ns	
21*	TIOF	Port output fall time	Standard (F)	_	10	40	ns	
			Extended (LF)	_	_	145	ns	
22††*	TINP	INT pin high or low time		Тсү	—	_	ns	
23††*	Trbp	RB7:RB4 change INT high or	low time	Тсү	—	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

these parameters are asynchronous events not related to any internal clock edges.

Note 1: Measurements are taken in RC mode, where CLKOUT output is 4 x Tosc.



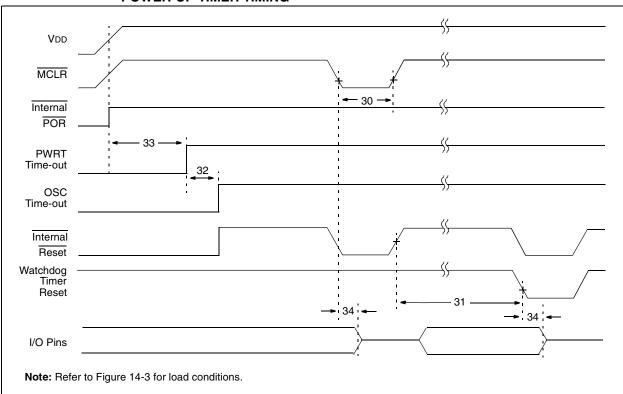


FIGURE 14-7: BROWN-OUT RESET TIMING

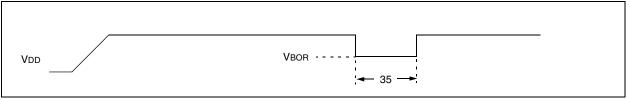


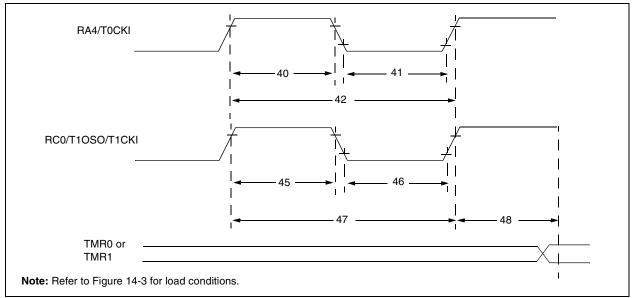
TABLE 14-3:RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER,
AND BROWN-OUT RESET REQUIREMENTS

Parameter No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions
30	TMCL	MCLR Pulse Width (Low)	2	—		μs	VDD = 5V, -40°C to +85°C
31*	TWDT Watchdog Timer Time-out Period 7 18 33 (No Prescaler) 7 18 33		33	ms	VDD = 5V, -40°C to +85°C		
32	Tost	Oscillation Start-up Timer Period	_	1024 Tosc	_	_	Tosc = OSC1 period
33*	TPWRT	Power up Timer Period	28	72	132	ms	$VDD = 5V$, $-40^{\circ}C$ to $+85^{\circ}C$
34	Tıoz	I/O Hi-Impedance from MCLR Low or Watchdog Timer Reset	_	_	2.1	μs	
35	TBOR	Brown-out Reset Pulse Width	100	—	_	μs	$VDD \le VBOR (D005)$

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS **FIGURE 14-8:**



Param No.	Symbol		Characteristic		Min	Тур†	Max	Units	Conditions	
40*	Tt0H	T0CKI High Pulse Width		No Prescaler	0.5TCY + 20	—	—	ns	Must also meet	
				With Prescaler	10	—	_	ns	parameter 42	
41*	Tt0L	T0CKI Low Pulse	Width	No Prescaler	0.5TCY + 20	—	—	ns	Must also meet	
				With Prescaler	10	—	_	ns	parameter 42	
42*	Tt0P	T0CKI Period		No Prescaler	Tcy + 40	—	_	ns		
				With Prescaler	Greater of: 20 or <u>Tcy + 40</u> N	_	—	ns	N = prescale value (2, 4,, 256)	
45*	Tt1H	T1CKI High Time	Synchronous, Pro	escaler = 1	0.5TCY + 20	—	_	ns	Must also meet	
			Synchronous,	Standard(F)	15	—	—	ns	parameter 47	
			Prescaler = 2,4,8	Extended(LF)	25	—	—	ns		
			Asynchronous	Standard(F)	30	—	—	ns		
				Extended(LF)	50	—	—	ns		
46*	Tt1L	T1CKI Low Time	Synchronous, Pro	escaler = 1	0.5TCY + 20	—	—	ns	Must also meet	
			Synchronous,	Standard(F)	15	—		ns	parameter 47	
			Prescaler = 2,4,8	Extended(LF)	25	—		ns		
			Asynchronous	Standard(F)	30	—		ns	-	
				Extended(LF)	50	—		ns		
47*	Tt1P	T1CKI Input Period	Synchronous	Standard(F)	Greater of: 30 OR <u>Tcy + 40</u> N	_	—	ns	N = prescale value (1, 2, 4, 8)	
				Extended(LF)	Greater of: 50 OR <u>TCY + 40</u> N				N = prescale value (1, 2, 4, 8)	
			Asynchronous	Standard(F)	60	—		ns		
				Extended(LF)	100	—	_	ns		
	Ft1	Timer1 Oscillator I (oscillator enabled	by setting bit T1C	DC	_	200	kHz			
48	TCKEZtmr1	Delay from Extern	al Clock Edge to T	imer Increment	2Tosc	_	7Tosc	—		

* These parameters are characterized but not tested.
 † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.



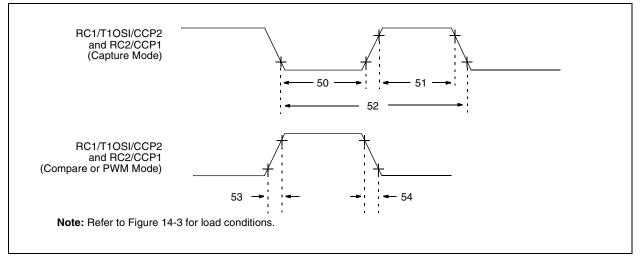


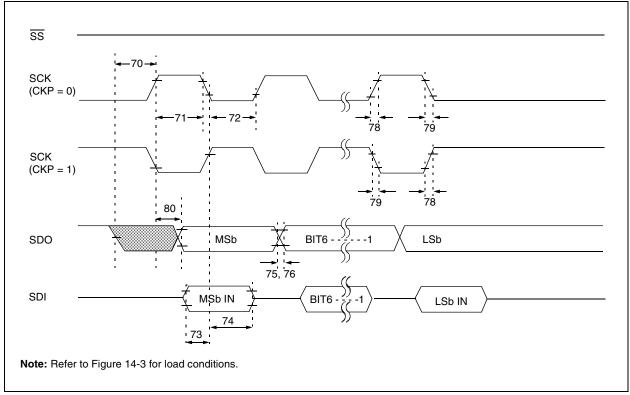
TABLE 14-5: CAPTURE/COMPARE/PWM REQUIREMENTS

Param No.	Sym	(Min	Тур†	Max	Units	Conditions		
50*	TccL	CCP1 Input Low Time	No Prescaler		0.5TCY + 20	—		ns	
			With Prescaler	Standard(F)	10	—	_	ns	
			Will Flescale	Extended(LF)	20		—	ns	
51*	ТссН	CCP1 Input High Time	No Prescaler		0.5TCY + 20		_	ns	
			With Prescaler		10		—	ns	
			Will Flescale	Extended(LF)	20		—	ns	
52*	TccP	CCP1 Input Period			<u>3Tcy + 40</u> N	_		ns	N = prescale value (1,4 or 16)
53*	TccR	CCP1 Output Rise Time	CCP1 Output Rise Time		—	10	25	ns	
					—	25	50	ns	
54*	TccF	CCP1 Output Fall Time	CCP1 Output Fall Time		—	10	25	ns	
				Extended(LF)	_	25	45	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.





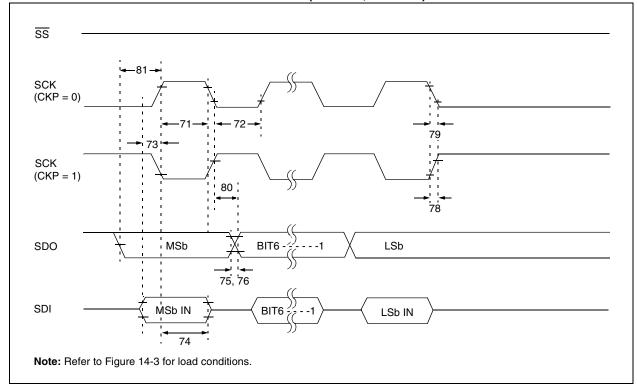
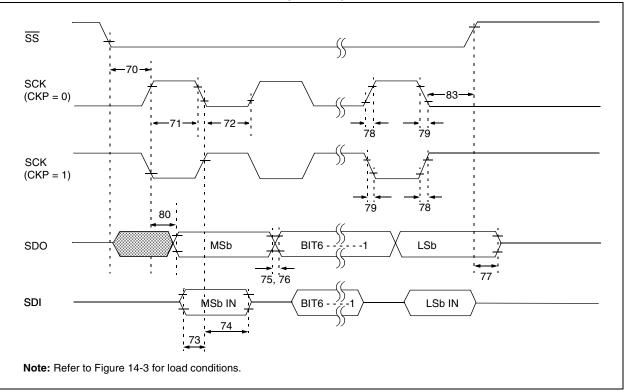
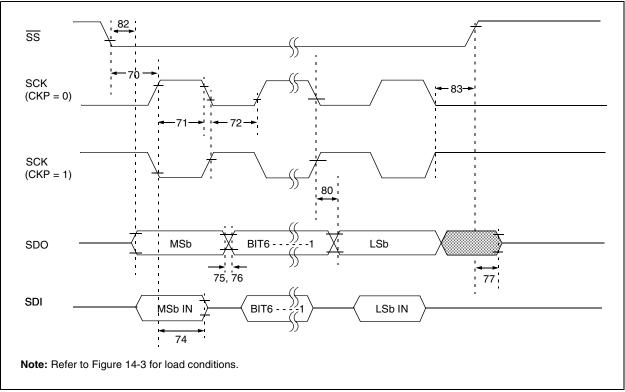


FIGURE 14-11: SPI MASTER MODE TIMING (CKE = 1, SMP = 1)









Param No.	Symbol	Characteristic	Min	Тур†	Мах	Units	Conditions	
70*	TssL2scH, TssL2scL	$\overline{SS}\downarrow$ to SCK \downarrow or SCK \uparrow Input	SS↓ to SCK↓ or SCK↑ Input			—	ns	
71*	TscH	SCK Input High Time (Slave mode)		TCY + 20		_	ns	
72*	TscL	SCK Input Low Time (Slave mode)		TCY + 20	_	-	ns	
73*	TdiV2scH, TdiV2scL	Setup Time of SDI Data Input to SCK	Setup Time of SDI Data Input to SCK Edge			—	ns	
74*	TscH2diL, TscL2diL	Hold Time of SDI Data Input to SCK E	100	_	—	ns		
75*	TdoR	SDO Data Output Rise Time	SDO Data Output Rise Time Standard(F) Extended(LF)		10 25	25 50	ns ns	
76*	TdoF	SDO Data Output Fall Time	•	—	10	25	ns	
77*	TssH2doZ	SS [↑] to SDO Output Hi-Impedance		10	_	50	ns	
78*	TscR	SCK Output Rise Time (Master mode)	Standard(F) Extended(LF)		10 25	25 50	ns ns	
79*	TscF	SCK Output Fall Time (Master mode)	•	_	10	25	ns	
80*	TscH2doV, TscL2doV	SDO Data Output Valid after SCK Standard(F) Edge Extended(LF)				50 145	ns	
81*	TdoV2scH, TdoV2scL	SDO Data Output Setup to SCK Edge	Тсү	_	—	ns		
82*	TssL2doV	SDO Data Output Valid after $\overline{SS}\downarrow$ Edg	_	—	50	ns		
83*	TscH2ssH, TscL2ssH	SS [↑] after SCK Edge	1.5TCY + 40		—	ns		

TABLE 14-6: SPI MODE REQUIREMENTS

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

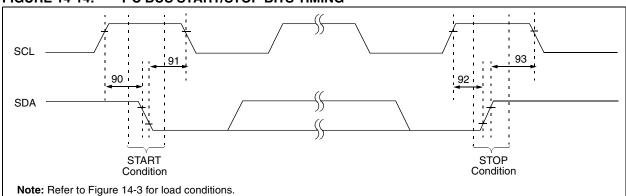


FIGURE 14-14: I²C BUS START/STOP BITS TIMING

TABLE 14-7: I²C BUS START/STOP BITS REQUIREMENTS

Parameter No.	Symbol	Characteristic		Min	Тур	Max	Units	Conditions
90	TSU:STA	START condition	100 kHz mode	4700	_	_	ns	Only relevant for Repeated
		Setup time	400 kHz mode	600	—	—		START condition
91	THD:STA	START condition	100 kHz mode	4000	—	_	ns	After this period, the first clock
		Hold time	400 kHz mode	600	_	_		pulse is generated
92	Tsu:sto	STOP condition	100 kHz mode	4700	_	_	ns	
		Setup time	400 kHz mode	600	_	_		
93	THD:STO	STOP condition	100 kHz mode	4000			ns	
		Hold time	400 kHz mode	600	_	_		



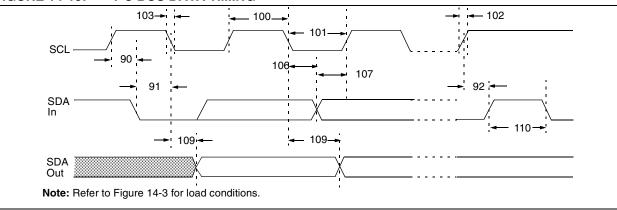


TABLE 14-8:I²C BUS DATA REQUIREMENTS

Param No.	Sym	Characte	eristic	Min	Max	Units	Conditions
100	Тнідн	Clock High Time	100 kHz mode	4.0	—	μs	Device must operate at a mini- mum of 1.5 MHz
			400 kHz mode	0.6	_	μs	Device must operate at a mini- mum of 10 MHz
			SSP Module	1.5TCY			
101	TLOW	Clock Low Time	100 kHz mode	4.7	_	μs	Device must operate at a mini- mum of 1.5 MHz
			400 kHz mode	1.3	_	μs	Device must operate at a mini- mum of 10 MHz
			SSP Module	1.5TCY	_		
102	TR	SDA and SCL Rise	100 kHz mode	—	1000	ns	
		Time	400 kHz mode	20 + 0.1CB	300	ns	CB is specified to be from 10 to 400 pF
103	TF	SDA and SCL Fall	100 kHz mode	—	300	ns	
		Time	400 kHz mode	20 + 0.1CB	300	ns	CB is specified to be from 10 to 400 pF
90	TSU:STA	START Condition	100 kHz mode	4.7		μs	Only relevant for Repeated
		Setup Time	400 kHz mode	0.6		μs	START condition
91	THD:STA	START Condition Hold	100 kHz mode	4.0		μs	After this period, the first clock
		Time	400 kHz mode	0.6	—	μs	pulse is generated
106	THD:DAT	Data Input Hold Time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	μs	
107	TSU:DAT	Data Input Setup Time	100 kHz mode	250	—	ns	(Note 2)
			400 kHz mode	100	—	ns	
92	TSU:STO	STOP Condition	100 kHz mode	4.7	—	μs	
		Setup Time	400 kHz mode	0.6	—	μs	
109	ΤΑΑ	Output Valid From	100 kHz mode	—	3500	ns	(Note 1)
		Clock	400 kHz mode			ns	
110	TBUF	Bus Free Time	100 kHz mode	4.7		μs	Time the bus must be free before
			400 kHz mode	1.3	—	μs	a new transmission can start
	Св	Bus Capacitive Loading	·	—	400	pF	

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

2: A fast mode (400 kHz) I²C bus device can be used in a standard mode (100 kHz) I²C bus system, but the requirement that TSU:DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line:

TR max.+ TSU:DAT = 1000 + 250 = 1250 ns (according to the standard mode I²C bus specification) before the SCL line is released.

TABLE 14-9:A/D CONVERTER CHARACTERISTICS:
PIC16F872 (COMMERCIAL, INDUSTRIAL, EXTENDED)
PIC16LF872 (COMMERCIAL, INDUSTRIAL)

Param No.	Sym	Characteristic		Min	Тур†	Мах	Units	Conditions
A01	NR	Resolution	_		10-bits	bit	$\begin{array}{l} VREF=VDD=5.12V,\\ VSS\leqVAIN\leqVREF \end{array}$	
A03	EIL	Integral Linearity Error	_	—	< ± 1	LSb	$\begin{array}{l} VREF=VDD=5.12V,\\ VSS\leqVAIN\leqVREF \end{array}$	
A04	Edl	Differential Linearity Er	_	—	< ± 1	LSb	$\begin{array}{l} VREF=VDD=5.12V,\\ VSS\leqVAIN\leqVREF \end{array}$	
A06	EOFF	Offset Error	_	—	< ± 2	LSb	$\begin{array}{l} VREF=VDD=5.12V,\\ VSS\leqVAIN\leqVREF \end{array}$	
A07	Egn	Gain Error		_	—	< ± 1	LSb	$\begin{array}{l} VREF=VDD=5.12V,\\ VSS\leqVAIN\leqVREF \end{array}$
A10	—	Monotonicity		—	guaranteed ⁽³⁾	—	_	$VSS \le VAIN \le VREF$
A20	VREF	Reference Voltage (VREF+ - VREF-)		2.0	_	Vdd + 0.3	V	Absolute minimum electrical spec. to ensure 10-bit accuracy.
A21	VREF+	Reference Voltage Hig	h	AVDD - 2.5V		AVDD + 0.3V	V	
A22	VREF-	Reference Voltage Lov	I	AVss - 0.3V		VREF+ - 2.0V	V	
A25	VAIN	Analog Input Voltage		Vss - 0.3V	—	VREF + 0.3V	V	
A30	ZAIN	Recommended Impedance of Analog Voltage Source		—		10.0	kΩ	
A40	IAD	A/D Conversion	Standard	—	220	—	μA	Average current consumption
		Current (VDD)	Extended	—	90	—	μA	when A/D is on (Note 1) .
A50	IREF	VREF Input Current (No	ote 2)	10	_	1000	μA	During VAIN acquisition, based on differential of VHOLD to VAIN to charge CHOLD, see Section 10.1.
				—	—	10	μA	During A/D conversion cycle.

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: When A/D is off, it will not consume any current other than minor leakage current.

The power-down current spec includes any such leakage from the A/D module.

2: VREF current is from RA3 pin or VDD pin, whichever is selected as reference input.

3: The A/D conversion result never decreases with an increase in the input voltage, and has no missing codes.



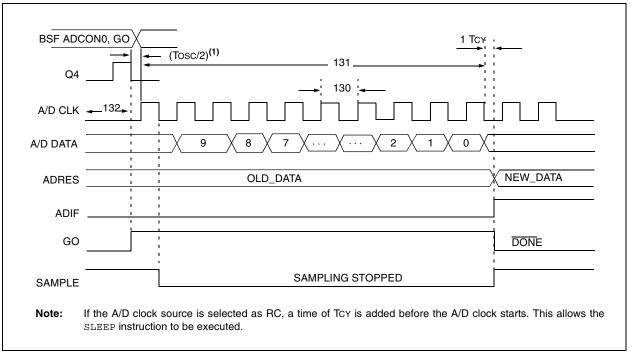


TABLE 14-10: A/D CONVERSION REQUIREMENTS

Param No.	Sym	Charae	Min	Тур†	Max	Units	Conditions	
130	TAD	A/D Clock Period	Standard(F)	1.6			μs	Tosc based, VREF ≥ 3.0V
			Extended(LF)	3.0	—		μs	Tosc based, VREF ≥ 2.0V
			Standard(F)	2.0	4.0	6.0	μs	A/D RC mode
			Extended(LF)	3.0	6.0	9.0	μs	A/D RC mode
131	TCNV	Conversion Time (no (Note 1)		—	12	TAD		
132	TACQ	Acquisition Time		(Note 2)	40		μs	
				10*		_	μs	The minimum time is the amplifier settling time. This may be used if the "new" input volt- age has not changed by more than 1 LSb (i.e., 20.0 mV @ 5.12V) from the last sampled voltage (as stated on CHOLD).
134	TGO	Q4 to A/D Clock Star	t	_	Tosc/2 §	_	_	If the A/D clock source is selected as RC, a time of Tcy is added before the A/D clock starts. This allows the SLEEP instruction to be executed.

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

Note 1: ADRES register may be read on the following TCY cycle.

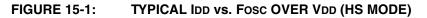
2: See Section 10.1 for min. conditions.

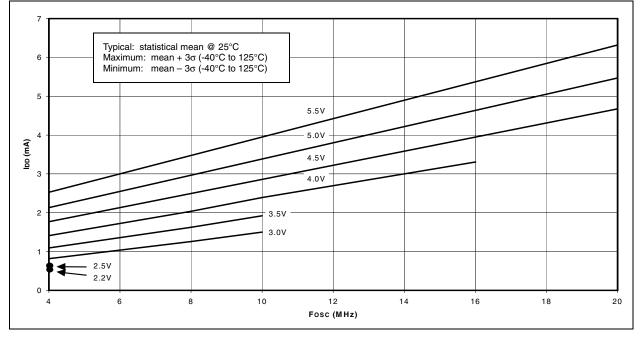
NOTES:

15.0 DC AND AC CHARACTERISTICS GRAPHS AND TABLES

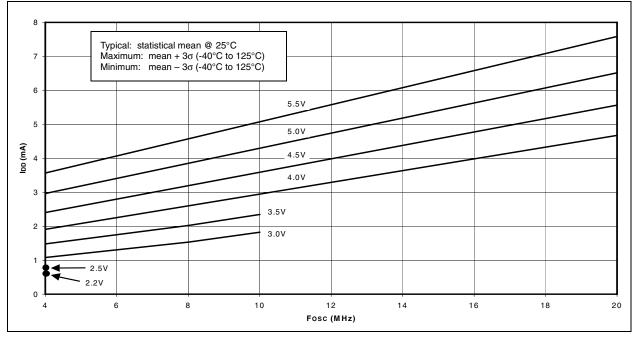
Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore, outside the warranted range.

"Typical" represents the mean of the distribution at 25°C. "Maximum" or "minimum" represents (mean + 3σ) or (mean - 3σ) respectively, where σ is a standard deviation, over the whole temperature range.









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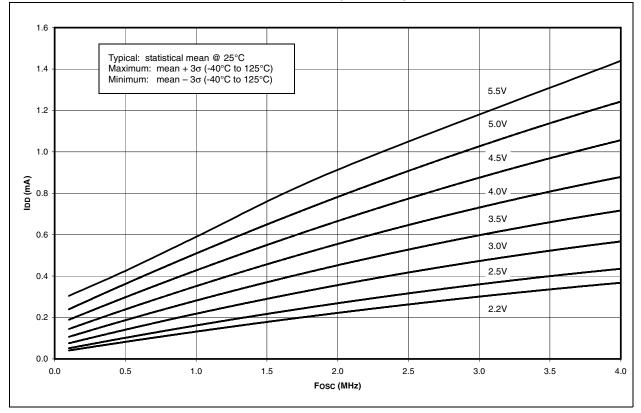
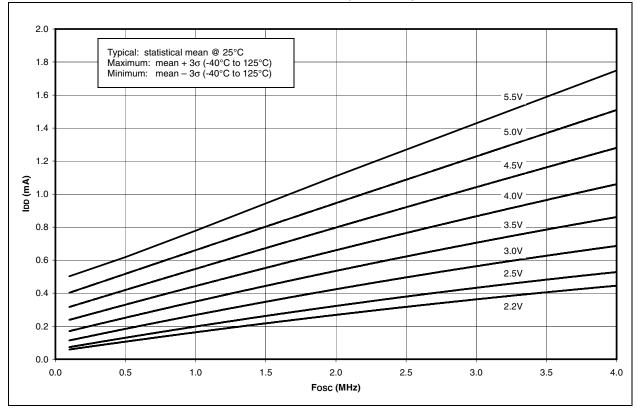
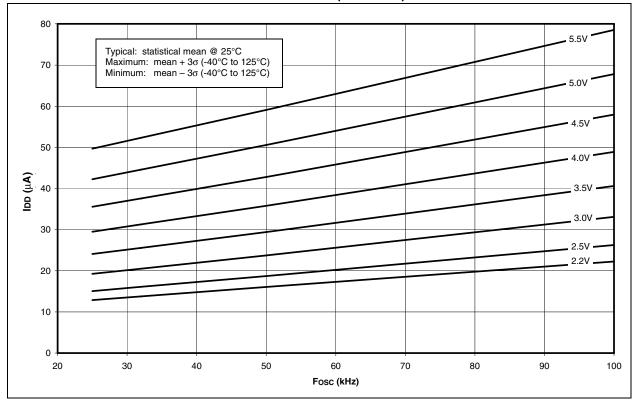


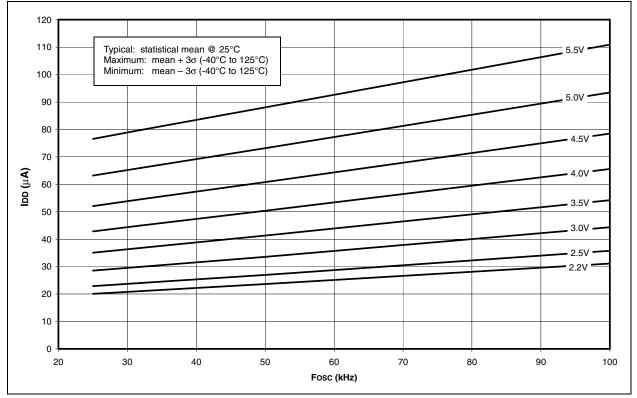
FIGURE 15-4: MAXIMUM IDD vs. Fosc OVER VDD (XT MODE)



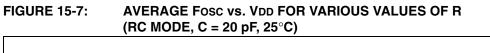








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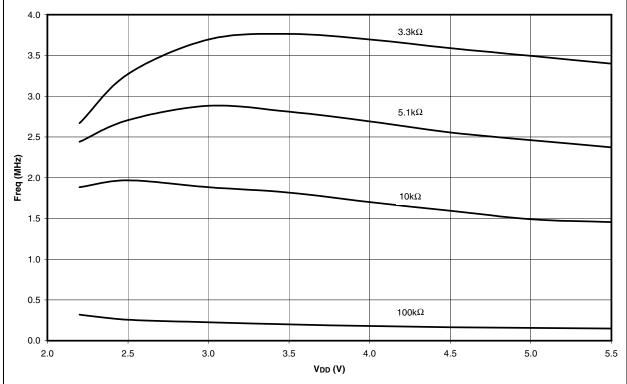
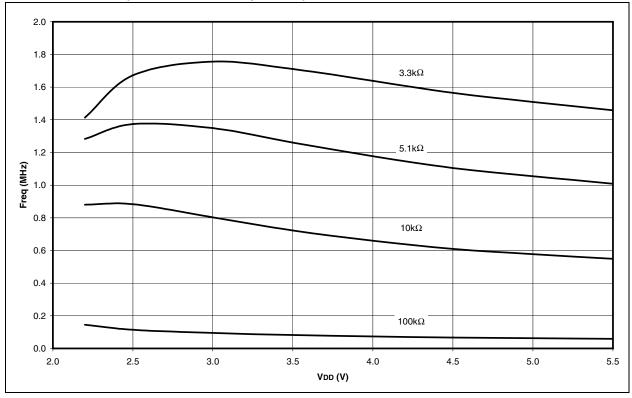
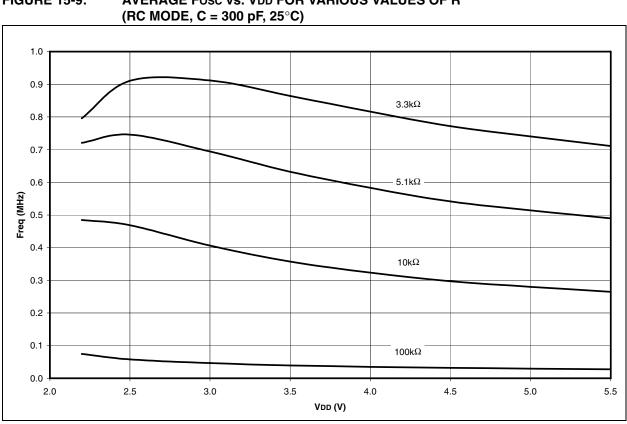


FIGURE 15-8: AVERAGE FOSC vs. VDD FOR VARIOUS VALUES OF R (RC MODE, C = 100 pF, 25° C)

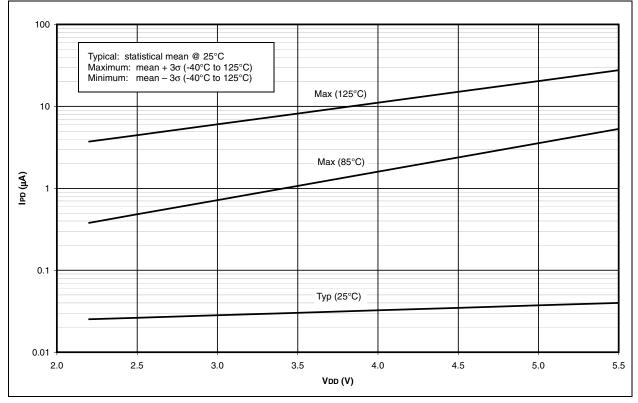


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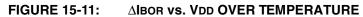


AVERAGE FOSC vs. VDD FOR VARIOUS VALUES OF R **FIGURE 15-9:**





PIC16F872



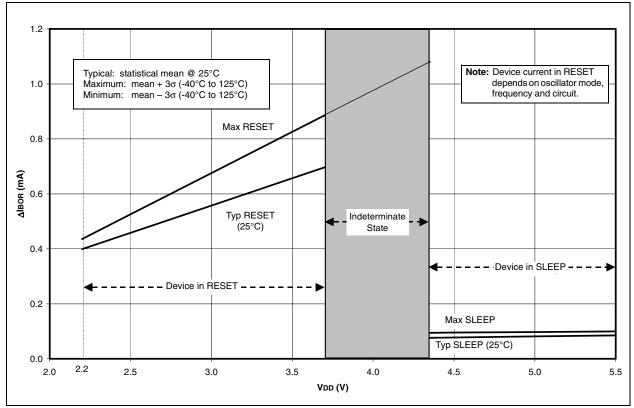
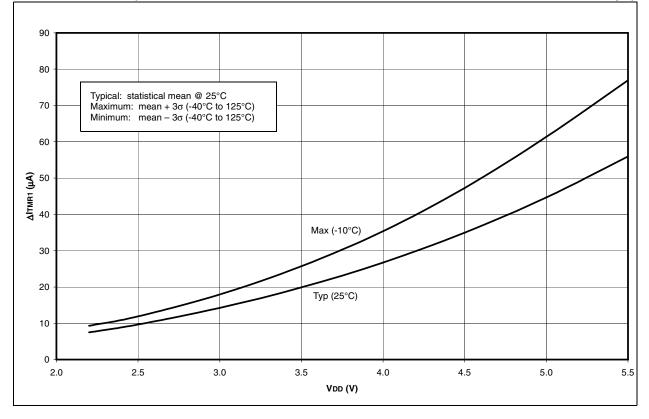


FIGURE 15-12: TYPICAL AND MAXIMUM ∆ITMR1 vs. VDD OVER TEMPERATURE (-10°C TO +70°C, TIMER1 WITH OSCILLATOR, XTAL=32 kHZ, C1 AND C2=50 pF)



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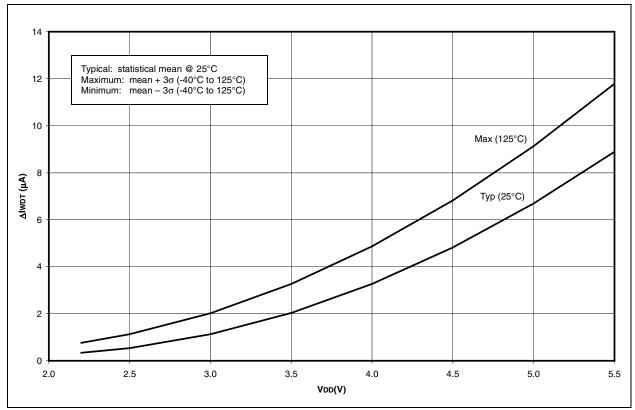
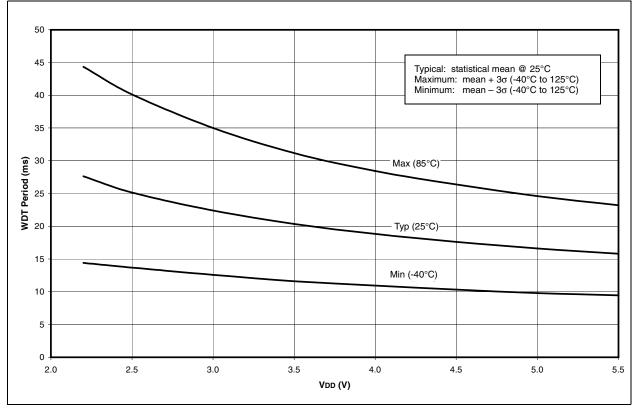
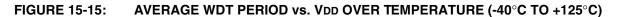


FIGURE 15-13: TYPICAL AND MAXIMUM AlwDT vs. VDD OVER TEMPERATURE







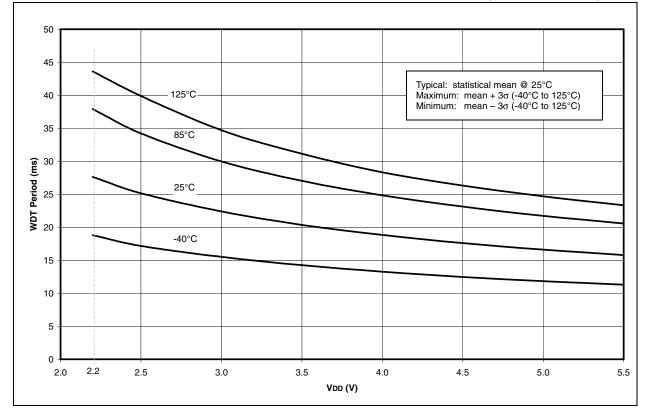
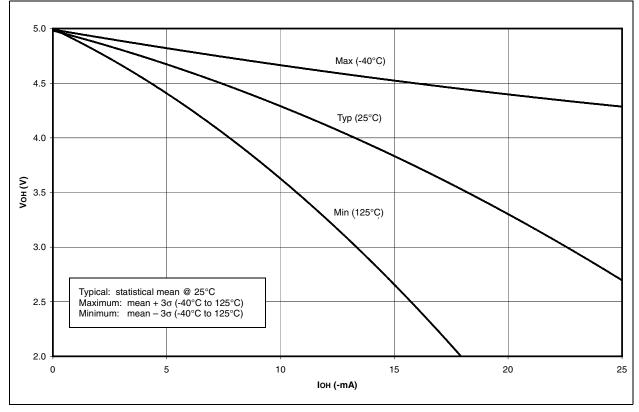


FIGURE 15-16: TYPICAL, MINIMUM AND MAXIMUM VOH vs. IOH (VDD=5V, -40°C TO +125°C)



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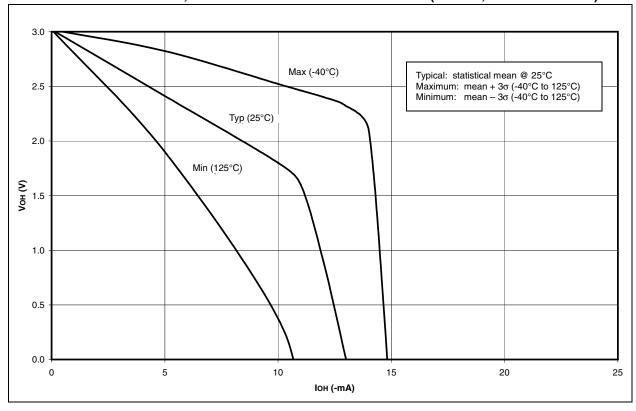
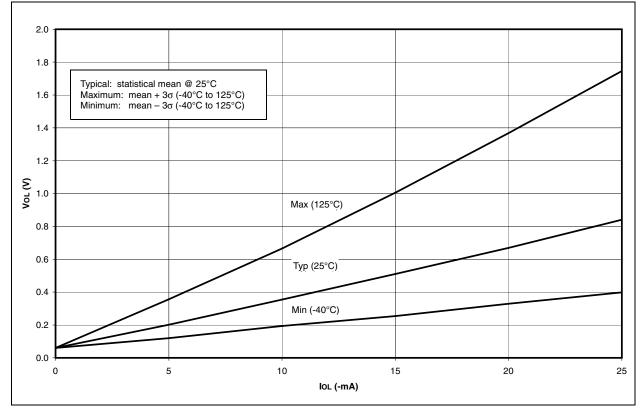


FIGURE 15-17: TYPICAL, MINIMUM AND MAXIMUM VOH vs. IOH (VDD=3V, -40°C TO +125°C)





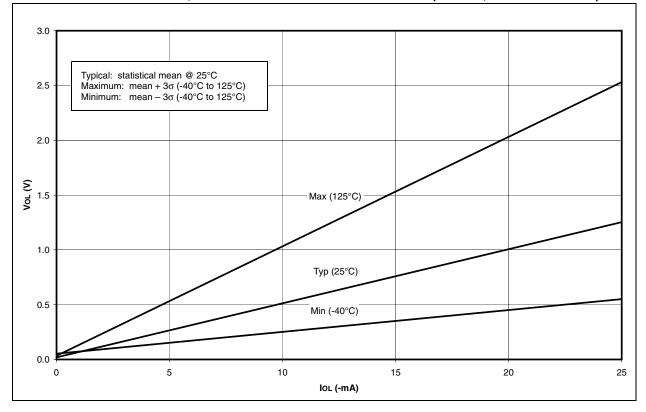
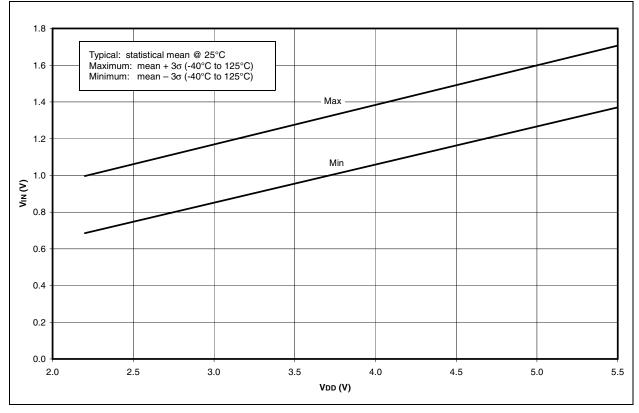




FIGURE 15-20: MINIMUM AND MAXIMUM VIN vs. VDD, (TTL INPUT, -40°C TO +125°C)



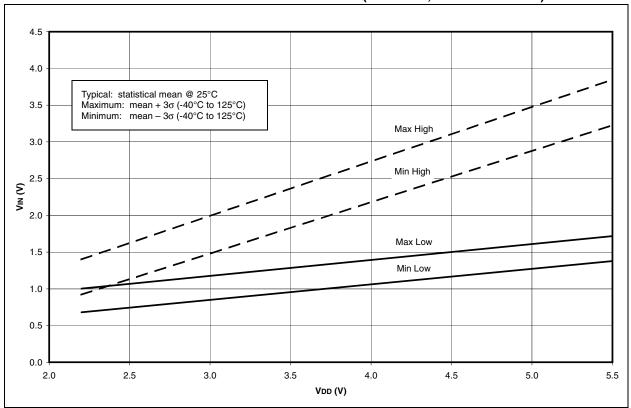
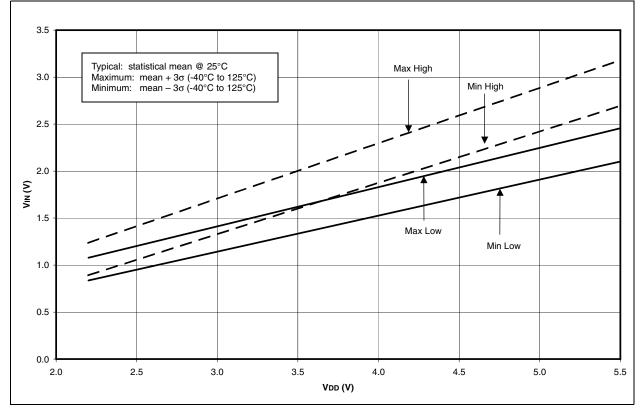


FIGURE 15-21: MINIMUM AND MAXIMUM VIN vs. VDD (ST INPUT, -40°C TO +125°C)





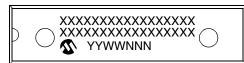
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NOTES:

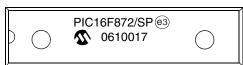
16.0 PACKAGING INFORMATION

16.1 Package Marking Information

28-Lead SPDIP



Example



28-Lead SOIC



Example



28-Lead SSOP

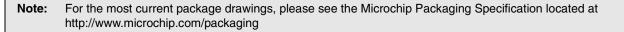
Example

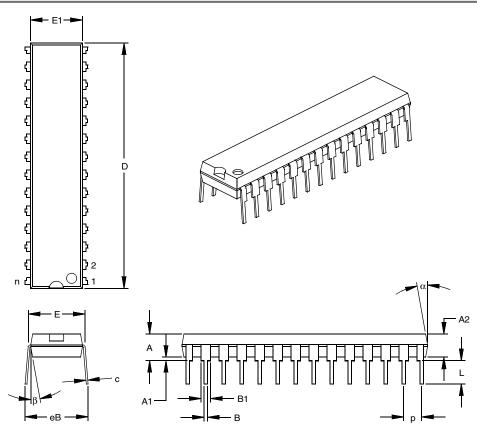


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○ 🍄 0610017	

Legen	d: XXX Y YY WW NNN e3 *	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
Note:	be carrie	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for customer-specific information.

28-Lead Skinny Plastic Dual In-line (SP) – 300 mil Body (PDIP)





	Units		INCHES*		Ν	IILLIMETERS	
Dimensi	on Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	р		.100			2.54	
Top to Seating Plane	А	.140	.150	.160	3.56	3.81	4.06
Molded Package Thickness	A2	.125	.130	.135	3.18	3.30	3.43
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.300	.310	.325	7.62	7.87	8.26
Molded Package Width	E1	.275	.285	.295	6.99	7.24	7.49
Overall Length	D	1.345	1.365	1.385	34.16	34.67	35.18
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	С	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.040	.053	.065	1.02	1.33	1.65
Lower Lead Width	В	.016	.019	.022	0.41	0.48	0.56
Overall Row Spacing	§ eB	.320	.350	.430	8.13	8.89	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter

§ Significant Characteristic

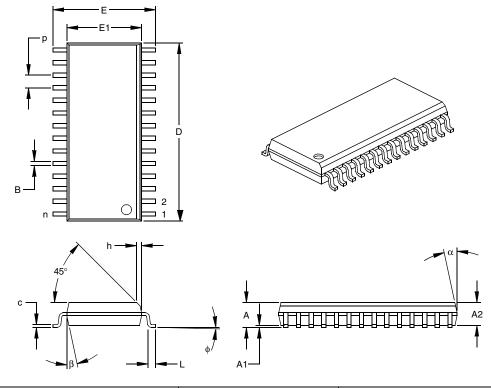
Notes:

Dimension D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: MO-095

Drawing No. C04-070

28-Lead Plastic Small Outline (SO) - Wide, 300 mil Body (SOIC)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	INCHES*		MILLIMETERS			
Dimensio	on Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	р		.050			1.27	
Overall Height	А	.093	.099	.104	2.36	2.50	2.64
Molded Package Thickness	A2	.088	.091	.094	2.24	2.31	2.39
Standoff §	A1	.004	.008	.012	0.10	0.20	0.30
Overall Width	Е	.394	.407	.420	10.01	10.34	10.67
Molded Package Width	E1	.288	.295	.299	7.32	7.49	7.59
Overall Length	D	.695	.704	.712	17.65	17.87	18.08
Chamfer Distance	h	.010	.020	.029	0.25	0.50	0.74
Foot Length	L	.016	.033	.050	0.41	0.84	1.27
Foot Angle Top	φ	0	4	8	0	4	8
Lead Thickness	С	.009	.011	.013	0.23	0.28	0.33
Lead Width	В	.014	.017	.020	0.36	0.42	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

* Controlling Parameter

§ Significant Characteristic

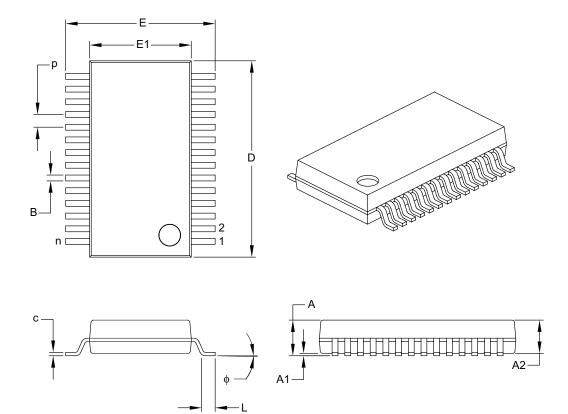
Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: MS-013

Drawing No. C04-052

28-Lead Plastic Shrink Small Outline (SS) – 209 mil Body, 5.30 mm (SSOP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		INCHES		М	ILLIMETERS*	r
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	р		.026			0.65	
Overall Height	A	-	-	.079	-	-	2.00
Molded Package Thickness	A2	.065	.069	.073	1.65	1.75	1.85
Standoff	A1	.002	-	-	0.05	-	-
Overall Width	E	.295	.307	.323	7.49	7.80	8.20
Molded Package Width	E1	.197	.209	.220	5.00	5.30	5.60
Overall Length	D	.390	.402	.413	9.90	10.20	10.50
Foot Length	L	.022	.030	.037	0.55	0.75	0.95
Lead Thickness	с	.004	-	.010	0.09	-	0.25
Foot Angle	¢	0°	4°	8°	0°	4°	8°
Lead Width	В	.009	-	.015	0.22	-	0.38

*Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

Drawing No. C04-073

Revised 1-12-06

APPENDIX A: REVISION HISTORY

Version	Date	Revision Description
A	11/99	This is a new data sheet (Pre- liminary). However, these devices are similar to the PIC16C72A devices found in the PIC16C62B/72A Data Sheet (DS35008).
В	12/01	Final version of data sheet. Includes DC and AC charac- teristics graphs and updated electrical specifications.
С	9/06	Packaging diagrams updated.

APPENDIX B: CONVERSION CONSIDERATIONS

Considerations for converting from previous versions of devices to the ones listed in this data sheet are listed in Table B-1.

TABLE B-1:	CONVERSION
	CONSIDERATIONS

Characteristic	PIC16C72A	PIC16F872
Pins	28	28
Timers	3	3
Interrupts	7	10
Communication	Basic SSP (SPI, I ² C Slave)	SSP (SPI, I ² C Master/Slave)
Frequency	20 MHz	20 MHz
A/D	8-bit, 5 channels	10-bit 5 channels
ССР	1	1
Program Memory	2K EPROM	2K FLASH
RAM	128 bytes	128 bytes
EEPROM Data	None	64 bytes
Other	_	In-Circuit Debugger, Low Voltage Programming

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THE MICROCHIP WEB SITE

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PIC16F872 PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO. Device	X /XX XXX Temperature Package Patter Range	n a)	PDIP package, normal VDD limits, QTP pattern #301.
Device	PIC16F87X ⁽¹⁾ , PIC16F87XT ⁽²⁾ ;VDD range 4.0V PIC16LF87X ⁽¹⁾ , PIC16LF87XT ⁽²⁾ ;VDD range 2	(to 5.5V .0V to 5.5V c)	package, normal VDD limits.
Temperature Range	blank = 0° C to $+70^{\circ}$ C (Commercial) I = -40° C to $+85^{\circ}$ C (Industrial) E = -40° C to $+125^{\circ}$ C (Extended)		
Package	SO = SOIC SP = Skinny Plastic DIP SS = SSOP	N	Note 1: F = CMOS FLASH LF = Low Power CMOS FLASH 2: T = in tape and reel - SOIC, PLCC, MQFP, TQFP packages only.



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